

# **Mocha Chip: A Graphical Programming System for IC Module Assembly**

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for IC Module Assembly

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## ABSTRACT

Mocha Chip is a system for designing module generators. There are two unique aspects to this system: diagrams are used to represent the structure of a module generator, and assembly primitives ensure that the generated layout obeys geometrical design rules and is properly connected.

Module generators are created using hierarchical diagrams rather than programs. The idea is to draw diagrams describing the topology of a class of modules, and to parameterize the diagrams to indicate how the individual modules differ. Parameterization is done using Lisp and special built-in cells that provide graphical representations of iteration and conditional selection. The diagrams may be considered to be a graphical programming language tailored to IC design. Diagrams can invoke either other diagrams or cells of mask geometry drawn by the user.

Describing module generators with graphics rather than text adds flexibility to the module generator. Textual languages, such as programming languages, tend to obscure the geometrical relationships. Mocha Chip separates out the module structure and represents it graphically, resulting in module generators that are easier to design and modify. Openness and ease of modification are important since users need to tailor module generators to produce specialized modules.

Layout for a module is produced using two pairwise assembly operators that take pieces of layout and combine them to form a larger pieces. The tile-packing operator aligns user-specified rectangles. The river-route-space operator uses two phases. The routing phase connects ports that do not line up exactly, and the cell spacing phase places the cells and routing as close together as rules allow.

The assembly process guarantees that no geometrical design rules will be violated and that the proper connections will be made. In other tile-based module generation systems, the user must manually check to make sure that all possible combinations of tiles will fit together properly. This is impractical for module generators that have a large number of tiles and options. The connection operator automatically ensures that the proper connections will be made and that no geometrical design rules will be violated.

## Acknowledgments

Many thanks go to John Ousterhout, whose drive and ambition serves as a model for all. I've enjoyed working with him immensely.

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# 1

# INTRODUCTION

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## 1.1. IC DESIGN

Integrated circuits (*ICs*) are electronic circuits etched onto silicon wafers using patterns of material on several different layers, called *mask layers* because a photographic mask is used to manufacture them. The design of the patterns is called *layout design*, and is usually a time-consuming manual task. The layout designer implements the circuit by choosing patterns for the mask layers, following *electrical design rules* that ensure the proper functioning of the circuit. In addition to implementing an electrically correct circuit, the pattern of mask layers must obey another set of rules, called

*geometrical design rules*, that ensure that the resulting patterns can be reliably fabricated.

Geometrical design rules specify which patterns can be reliably fabricated, and which patterns cannot be. A typical rule specifies the minimum spacing between pieces of material, to prevent accidental shorts, or the minimum width of a wire, to prevent accidental gaps. Additional rules describe the proper construction of transistors and contacts, in terms of required overlaps and separations.

Layout designers often employ programs called *module generators* to help them design their ICs. Module generators generate standard building blocks from a set of parameters, freeing the designer to concentrate on the unique aspects of the design. Like layout design, the design of a new module generator is also a time-consuming manual task.

Module generators consist of two phases: a phase called *behavioral processing* that maps the behavioral specification into a structural description showing the approximate position of components, and a phase called *layout generation* that maps the structural description into a set of mask patterns. Both phases have traditionally been implemented with textual programs. For the latter phase, this is an error-prone method, since textual languages are not well-suited to the specification of topological information. Mocha Chip addresses this phase using a more intuitive scheme: an extensible graphical programming language to specify topology and special operators to assemble layout using the geometrical design rules.

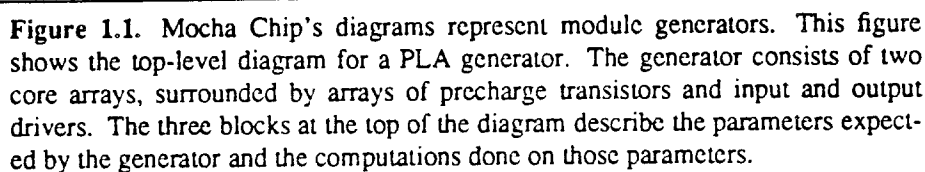
## 1.2. MOCHA CHIP OVERVIEW

There are two key ideas of this research: a graphical specification language for module generators, and interconnection operators for creating larger structures out of smaller components. This combination allows the structure of the module to be specified graphically, and ensures that the resulting module will obey geometrical design rules. The approach solves many of the problems associated with the layout-generation phase of a module generator.

*Mocha Chip* encourages a style where module generators are designed with diagrams rather than programs (Figure 1.1). Each diagram shows the organization of a class of modules, and parameters specify the differences between individual modules. The parameterization is done using Lisp and special built-in cells that provide two-dimensional analogues of iteration and conditional selection. The diagrams constitute a graphical programming language tailored to IC design.

By separating out the module structure and representing it graphically, module generators are easier to design and modify. This is important since module generators are currently designed by programmers rather than the IC designers, often resulting in generators that don't produce exactly what the IC designer needs in a given situation. With Mocha Chip, IC designers can tailor module generators to fit their particular needs, and can also design their own simple generators from scratch.

In addition to diagrams, Mocha Chip provides *pairwise assembly operators* that create layout by pairing together two smaller pieces of layout, such as basic tiles, to form larger pieces. The pairing is done in a way that ensures that no geometrical



design rules are violated. This ensures that all modules created will obey the geometrical rules, and frees the module generator's designer from those considerations. The designer is still free to hand-tune cells so that particular ones fit together tightly, and the system will ensure that all combinations of cells will fit together without geometrical design rule violations. Ensuring the design-rule correctness of all modules generated was, in the past, a very difficult task. Mocha Chip eliminates this time-

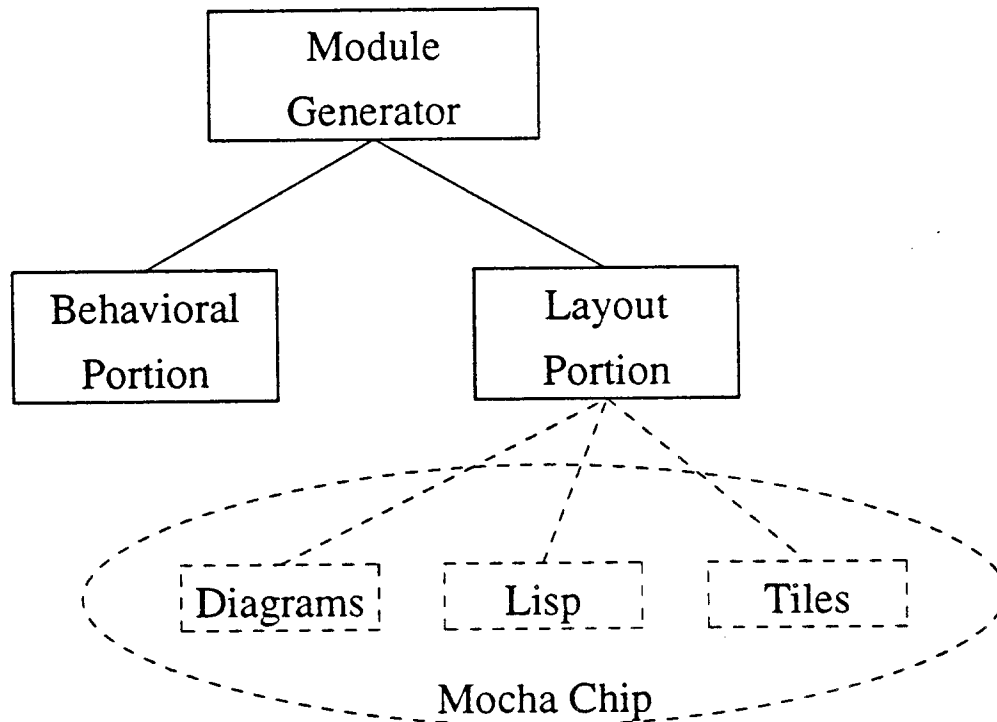
consuming phase, making it easier for module generators to be designed by IC designers.

### 1.3. COMPONENTS OF A MODULE GENERATOR

Module generators generally consist of two parts (Figure 1.2): a part that maps a specification of the module's behavior into structural information (called *behavioral processing*), and a part that maps the structural information into actual mask geometries (called *layout generation*). The first part is problem-specific and involves manipulations of symbolic, algebraic information rather than spatial information. It is best handled by a general-purpose programming language. The second part, however, involves spatial operations that are common to all module generators. It is in this area that Mocha Chip seeks to improve the design process. Traditional techniques use a programming language for this part, while Mocha Chip makes use of graphics.

An example will be used to illustrate the distinction between the two parts. The example chosen is a Programmable Logic Array (PLA) generator. A PLA is a combinatorial circuit that takes a set of boolean input variables and produces as output a function of those variables. The input to a PLA generator is a set of equations (Figure 1.3a) which specify the behavior of the PLA. The output of the generator is layout (Figure 1.3c) that implements the function using a PLA.

The behavioral-processing part of the PLA generator takes the input equations and decides on a structure for the module. PLAs implement a two-level *and-or* structure, so the generator takes the equations and produces such a structure. The details of



**Figure 1.2.** A module generator typically is composed of two parts: one that creates a structural description from a specification of the desired behavior, and one that creates mask layout from the structural description. Mocha Chip makes the design of the second part easier, breaking it down into three parts: diagrams, which represent the structure of a class of modules; Lisp code, which specifies how the individual instances differ; and tiles of mask layout, which form the basic building blocks of the module.

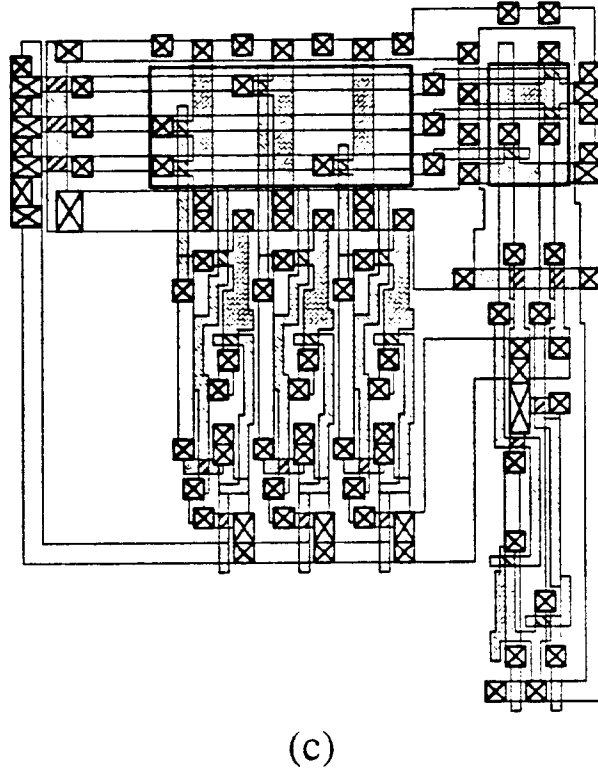
this structure are not important for this discussion; the important idea is that the new structure is close to the structure of the final layout. For example, if we represent the structure as a table, as in Figure 1.3b, each position in the table might correspond to a particular cell or combination of cells in the final layout. The final layout will probably also contain many cells of a housekeeping nature — ones that aren't a direct consequence of the input specification but are rather part of the electrical design of the structure. This mapping of behavior to structure is problem-specific, and is best handled with a general-purpose programming language.

out1 = in1 and in3;  
out2 = in2 or in1;

(a)

|   |   |   |   |   |
|---|---|---|---|---|
| - | 1 | - | 0 | 1 |
| 1 | - | - | 0 | 1 |
| 1 | - | 1 | 1 | 0 |

(b)



**Figure 1.3.** The equations in Figure 1.3a specify the desired behavior, and are translated into the table shown in Figure 1.3b. The table represents the structure of a module, and is a close match to the actual layout in Figure 1.3c. The layout consists of two small core areas (outlined by thick lines) which are programmed according to the table, and the surrounding buffers, precharge transistors, and power busses, which are provided automatically by the generator.

After deciding on the structure, the module generator produces layout. In the past, the popular methods of producing layout from a structural description were to use a general-purpose programming language or to use *tiles* (small cells) of mask layout combined with a programming language. In Mocha Chip, the layout-generation phase is implemented with three items: tiles of mask layout that form the basic components

to be assembled, diagrams showing the structure of the modules to be generated, and Lisp code which parameterizes the diagrams.

This method eliminates many of the problems of past approaches. The *tiles* of mask layout are the basic building blocks of the module, and are drawn graphically by the module generator designer. The pairwise assembly operators built into the system automate much of the error-prone task of assembling the tiles. The diagrams, called *assembly diagrams*, specify graphically the overall structure of the class of modules to be generated, and are clearer and more visually expressive than textual programs. The diagrams are parameterized by *Lisp code* that specifies how the individual modules differ. Calls to arbitrary user-defined Lisp functions may be used, giving a convenient way to implement the behavioral-processing phase.

#### 1.4. THESIS ORGANIZATION

The next chapter describes the graphical language used by Mocha Chip and how it is evaluated, or executed, to produce an instantiated module. As mentioned previously, the graphical language makes modules generators easier to design and modify, and is Mocha Chip's main contribution.

Chapter 3 reviews previous module generator design techniques, discussing their pitfalls and how each new technique improves upon the previous techniques. I'll compare Mocha Chip with these techniques and show why it is an improvement.

Chapter 4 describes how the system is organized and implemented. The system is implemented in three parts: a front end built into the Magic[1] IC layout system, an



evaluation system written in Lisp[2], and a layout assembly system also built into Magic.

Chapter 5 describes the two interconnection operators and their implementation. The packing operator, a simple operator that does not guarantee design-rule correctness, is described, as is the river-route-space operator, which does guarantee design rule correctness. Both operators are useful in specific situations, but it appears that pitch-matching needs to be added in order for the river-route-space operator to have general applicability.

Chapter 6 reports on an example PLA generator built with Mocha Chip. This chapter demonstrates that non-trivial module generators can be built using the graphical constructs present in Mocha Chip. The chapter concludes by comparing the generator with similar generators built without Mocha Chip. The comparisons are based on the number of lines of code written by the generator designer, the number of diagrams drawn, and the number of tiles drawn.

Chapter 7 presents some ideas for future work. The ideas fall into three categories: usability improvements, to make the system faster and easier to use; interconnection operators, to increase the flexibility of the layout process; and language improvements, to extend the class of modules that can be easily described with Mocha Chip.

Chapter 8 presents some thoughts on the pitch-matching problem. Pitch-matching fits well into the Mocha Chip framework, since Mocha Chip was designed with it in mind. However, due to time limitations the pitch-matcher wasn't

implemented. This chapter gives some ideas on how it could be done.

Finally, Chapter 9 presents concluding remarks about the system, both advantages and disadvantages. The main disadvantages are that Mocha Chip runs more slowly than some other systems, and that pitch-matching seems to be required in many situations. The main advantage is that Mocha Chip's graphical diagrams work well for regular modules such as PLAs, ROMs, and datapaths, although they are less useful for more irregular modules. The example PLA generator compares favorably with existing PLA generators, proving that Mocha Chip's extensible graphical programming language is sufficient to specify real-world module generators. In addition, the idea of using assembly operators provides a means of assuring design-rule correctness; this is something that previous module generator systems have had problems with.

## 1.5. REFERENCES

1. J. K. Ousterhout, G. T. Hamachi, R. N. Mayo, W. S. Scott and G. S. Taylor, The Magic VLSI Layout System, *IEEE Design & Test of Computers*, February, 1985.
2. G. L. Steele, Jr., *Common Lisp, The Language*, Digital Press, 1984.



## GENERATOR SPECIFICATION

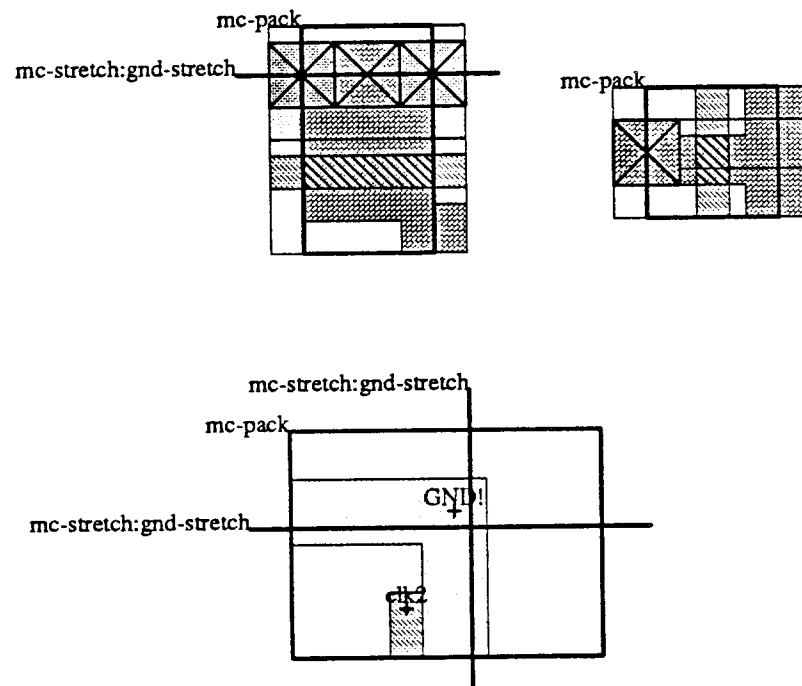
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### 2.1. INTRODUCTION

A module generator is specified in Mocha Chip with three parts: tiles of layout that are the basic building blocks of the module, assembly diagrams that show the overall structure of the class of modules to be generated, and Lisp code that parameterizes the diagrams and tiles to indicate how the individual modules differ. This Lisp code may include calls to user-defined Lisp functions, giving a convenient way to incorporate the behavioral-processing part of the module generator.

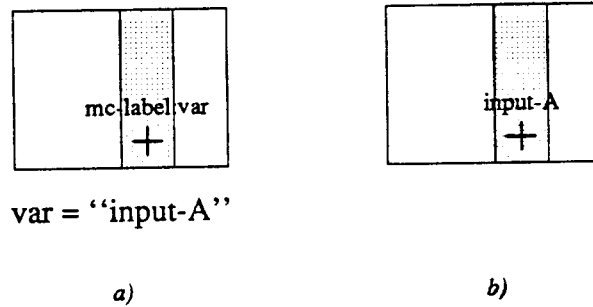
This chapter will present each of the three parts in detail. It will begin with tiles, then present Lisp parameterization, and conclude with a discussion of assembly diagrams.

## 2.2. TILES

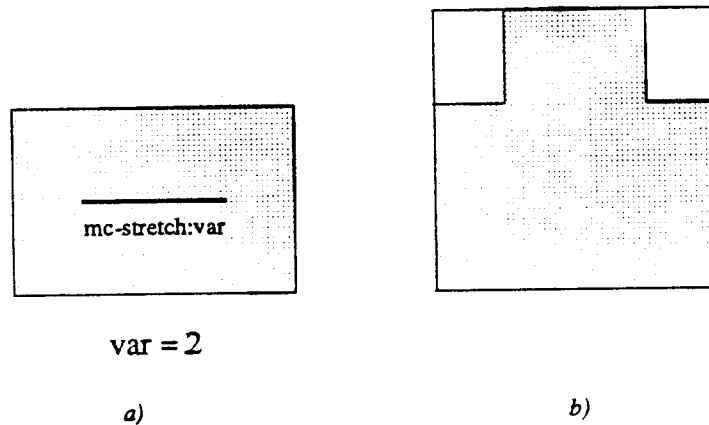


**Figure 2.1.** This figure shows three tiles from a PLA generator built with Mocha Chip. Tiles form the basic building blocks out of which modules are built. The tiles consist of mask layout as well as annotations to control the assembly process. Annotations are labels beginning with the characters "mc-".

Tiles (Figure 2.1) are small pieces of mask layout created using an interactive graphical editor, such as Magic[1]. The tiles form the building blocks that will be assembled according to the instructions contained in the assembly diagrams. A typical tile would contain structures such as an input buffer, a RAM cell, or a basic element in a shift register. Each tile is treated as an indivisible entity out of which larger



**Figure 2.2.** Labels in tiles can be parameterized. In this case, the tile references the parameter "var", which contains the string "input-A". The tile could be used with other values of "var", resulting in different labels for different instances of the tile.

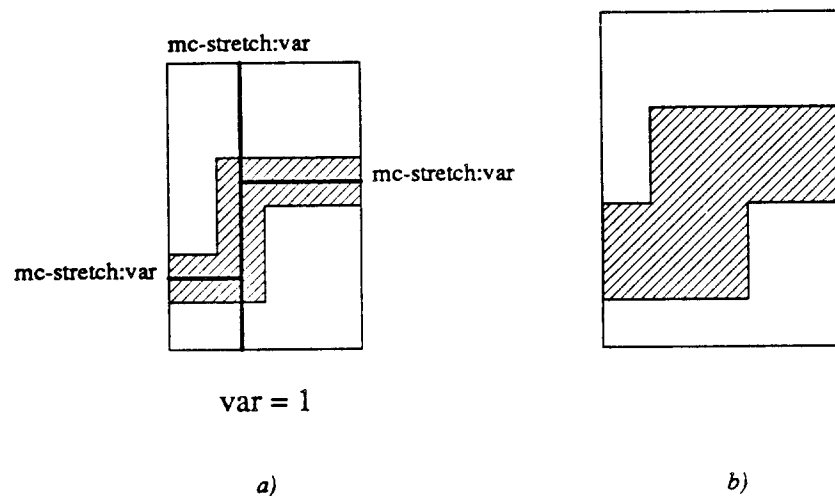


**Figure 2.3.** This example shows a horizontal stretch line that references the parameter "var", which has a value of 2. Part *a* shows the tile before the stretch, and part *b* shows the tile after the stretch. Horizontal lines cause material to move upwards, while vertical lines cause material to be moved to the right. In practice, a sequence of lines usually spans the width of the tile in order to avoid skewing.

structures are built. As a result, most tiles tend to be small. There is no built-in limitation, however, as to the size of tiles.

Three types of annotations are permitted in tiles: packing rectangles, parameterized labels, and parameterized stretch lines. *Packing rectangles* are user-specified boxes used by one of the pairwise assembly operators, as will be discussed later. They take the form of a rectangular label denoted "mc-pack" (Figure 2.1). *Parameterized*

*labels* are labels of the form "mc-label:*text*". The text after the colon names a parameter that contains the text to be used as the label (Figure 2.2). Tiles can be invoked with different values for this parameter, resulting in several different versions of the same tile, each containing a different label. One example of how this can be used is to label the inputs to a structure, where each input consists of the same tile but the labels on the input terminals differ.



**Figure 2.4.** Stretch lines normally extend across the width and height of the tile, in order to avoid dislocations. In this example, three stretch lines are used to increase the width of three segments of a wire.

Parameterized *stretch lines* allow tiles to be stretched. They are used to widen power and ground lines and contacts in order to follow electrical design rules, and to resize transistors in order to adjust the performance of the circuit. Parameterized stretch lines are lines drawn over the tile that have the label "mc-stretch:*text*" attached. The text after the colon names a parameter that contains the amount of stretch desired (Figures 2.1a and 2.1b). If the line is horizontal, all material directly above the line is moved upwards by this amount (Figure 2.3). If the line is vertical, material directly to

the right of the line is moved to the right by this amount. Care must be taken that the lines don't skew or distort the material in undesired ways. A simple guideline, applied to horizontal lines, is to ensure that each vertical slice through the tile crosses the same number of horizontal stretch lines. A similar rule can be applied to vertical lines. Figure 2.4 shows an example of a tile with stretch lines that follow these guidelines.

The parameter mechanisms allow tiles to be parameterized, but I have not yet discussed how parameters are computed. The next section covers this aspect.

### 2.3. PARAMETERIZATION OF TILES

Lisp code[2] is used to parameterize tiles, and is also used in assembly diagrams. Lisp code consists of data items and expressions. The basic data types used in Mocha Chip are integers, strings, atoms, and lists of items. Expressions are lists that are evaluated to produce a data item as a result. In Lisp, a data item must be preceded by a quote mark, otherwise Lisp assumes that the item is an expression to be evaluated. Integers and character strings always evaluate to themselves, so quote marks are usually omitted when referring to these data types. Figure 2.5 shows some example data items and expressions. Integers are represented in the normal manner. Strings are surrounded by double quotes. Individual characters are represented by the character preceded with the "#\" characters. Atoms are unique tokens used to represent a value, such as red, green, or blue. They are similar to enumerated types in Pascal and some uses of #define in C. Atoms are normally preceded by a quote mark, since they represent values rather than expressions to be evaluated. Variables, when evaluated,

| Data Type  | Example                                    |
|------------|--|
| integer    | 492  |
| string     | "hello world"                              |
| character  | '#   |
| atom       | 'blue                                      |
| variable   | foo  |
| list       | '(234 round 98 "bear")<br>'(3 5 6 (8 9 0)) |
| expression | (multiply 3 4)<br>(concat "one" "word")    |

**Figure 2.5.** These are the Lisp data types that are commonly used in Mocha Chip. The table shows each data type along with an example of the syntax. Lists may contain any number of items, of any data type. The second list is an example of a list that contains another list. Expressions are lists where the first item is the name of a function. The remaining elements in the list form the arguments to the function. For example, the “multiply” expression evaluates to 12 and the “concat” expression evaluates to “oneword”.

| Parameter Form           | Example   |
|--------------------------|---|
| <i>(name expression)</i> | (gnd-stretch 3)<br>(gnd-stretch (+ 3 5))<br>(output-name (concat "out" (num2string output-number))) |

**Figure 2.6.** A Mocha Chip parameter is a two-element list, with the first element being the name of the parameter and the second element being an expression to compute the value of the parameter.

return the value they contain.

Mocha Chip specifies a parameter using a two-element list. The first element in the list is the parameter’s name, and the second element is an expression to be evaluated (Figure 2.6). Parameters may take on any value, such as integers, strings, or even lists. For example, the syntax for the parameter in Figure 2.2 would be:



**(var "input-A")**

while the syntax for the parameter in Figure 2.3 would be

**(var 2).**

Of course, the values could be computed rather than being constants. A similar mechanism is used with assembly diagrams to provide parameterization.

As we will see later, Mocha Chip provides a way to execute expressions that are not direct computations of parameters. These expressions can be used as a general-purpose mechanism to escape to Lisp code. For example, an expression such as:

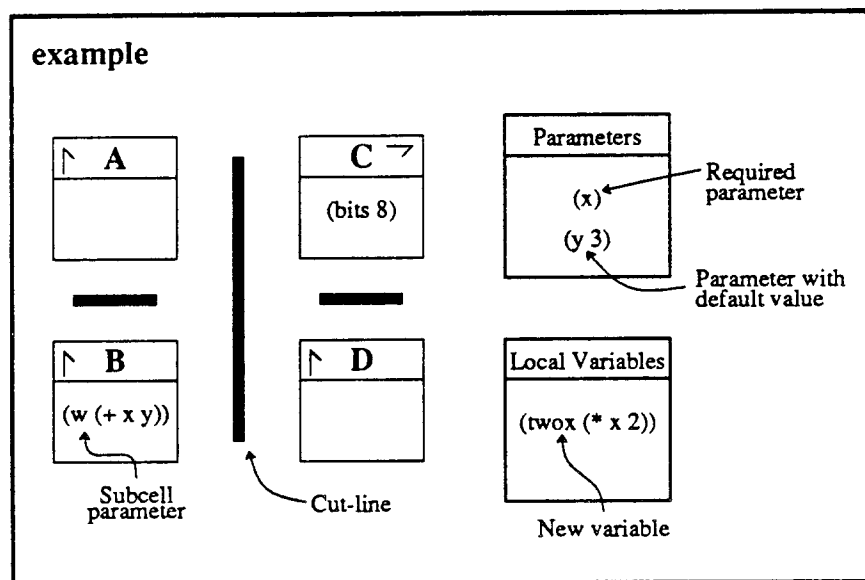
**(result (load "myfunc.l"))**

can be used to load in a file of Lisp code. These newly provided functions can then be used to compute parameters. This mechanism is typically used to write the behavioral-processing portion of the module generator.

## **2.4. ASSEMBLY DIAGRAMS**

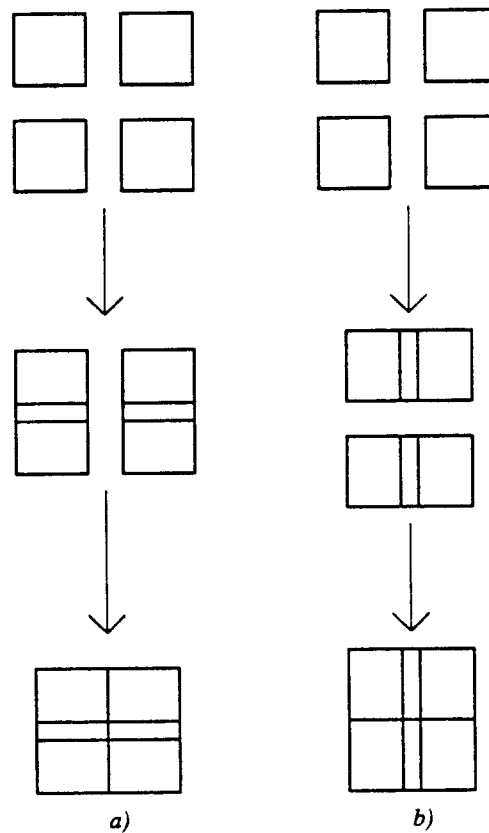
Mocha Chip uses diagrams, called *assembly diagrams*, to specify the structure of the modules to be produced. These diagrams are drawn by the designer of the module generator, and replace much of the code that is traditionally written for the structural assembly portion of a module generator. The diagrams constitute a graphical programming language tailored to IC design. They are drawn using a special-purpose interactive editor built into the Magic IC layout editor.

Assembly diagrams show the relative positions and orientations of subcells. Each subcell is either another assembly diagram or a tile. Subcells, either assembly diagrams or tiles, may take parameters in order to alter the layout.



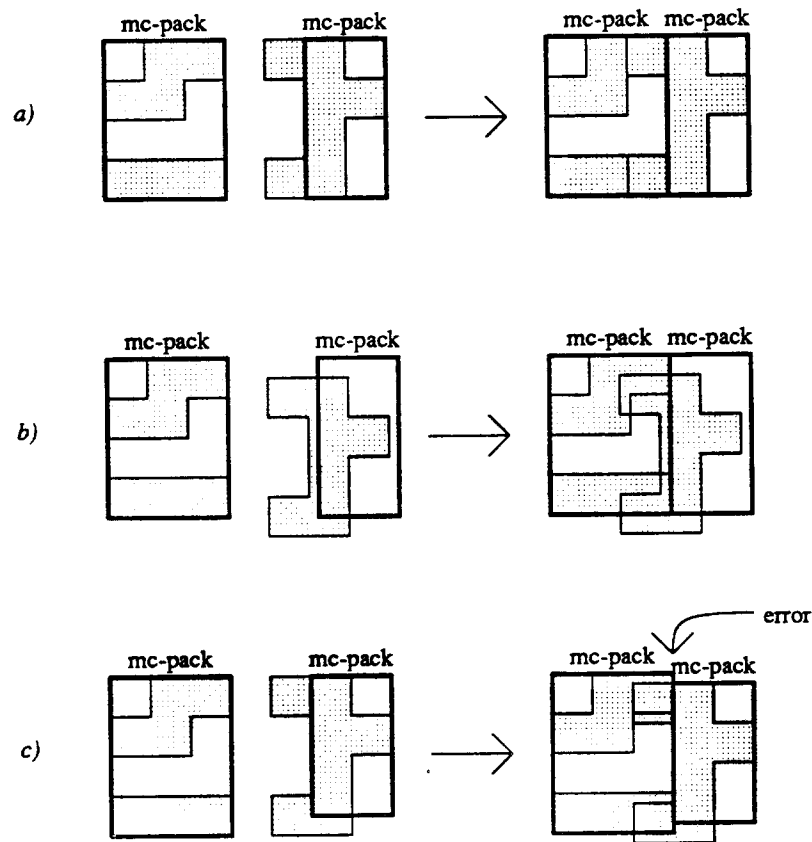
**Figure 2.7.** The four blocks on the left side of this assembly diagram are parameterized subcells, and may be either diagrams or cells of mask layout. The orientation of each block is indicated by the small arrow. Cut-lines describe the relative positions of the cells, and are used in constructing the module. The two blocks on the right contain parameters and local variables, and their location is of no consequence. The diagram is named "example", as indicated in the upper-left corner.

Figure 2.7 shows a simple assembly diagram that contains four subcells. The small arrows show the orientation of the cells. The bold *cut-lines* specify which cells (or groups of cells) are to be positioned relative to which other cells (or groups of cells). For example, cut-lines in Figure 2.7 specify that cell A is to be positioned above cell B, and that the A-B pair is to be positioned to the left of the C-D pair. Mocha Chip produces these lines automatically, but the user can draw them directly if desired.



**Figure 2.8.** The assembly order chosen can change the end result. With the river-route-space operator, cells are joined as tightly as design rules allow. Part *a* shows the case where the vertical joins were performed first, as specified in Figure 2.7. In this case the horizontal joins were able to overlap cells, but they precluded a tight join in the vertical direction, possibly because of design rules. Part *b* shows a similar case with different cut lines that caused the vertical joins to be performed first.

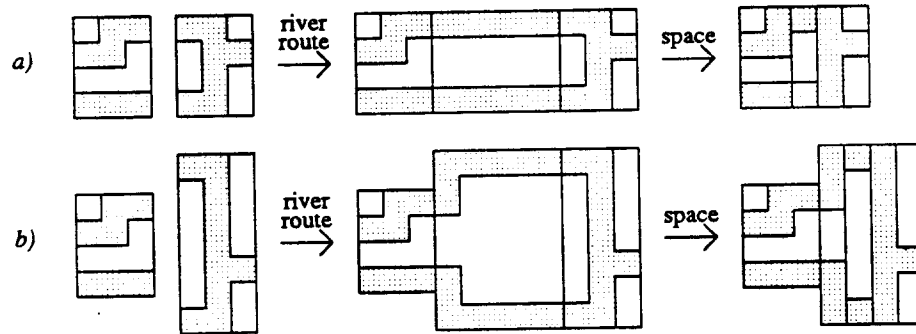
The lines also specify a partial ordering for the assembly process. In the current example, both the **A-B** join and the **C-D** join must be performed before the **AB-CD** join. Depending upon the assembly operator used, a different collection of cut-lines may produce different results (Figure 2.8). For example, if the diagram were redrawn with the long line horizontal, this would specify that the **A-C** join and the **B-D** join should be performed before the final **AC-BD** join. The result might be different than in the first case. It is the responsibility of the diagram designer to ensure that the lines



**Figure 2.9.** The packing operator assembles tiles by abutting their user-specified packing rectangles, denoted by the "mc-pack" label (part *a*). The operator ignores design rules and connectivity constraints, as shown in part *b*. This gives added flexibility, but may result in errors. The sides of the packing rectangles to be abutted must be of the same length, or an error is reported (part *c*).

chosen will work correctly with the assembly operator chosen.

Assembly operators are chosen by tagging each cut-line with the name of the operator. Currently three tags are recognized: **pack**, **river**, and **default**. The pack operator (Figure 2.9) combines tiles by packing together their user-specified packing rectangles, ignoring connectivity and design-rule violations. Tiles are usually designed so that they pack together correctly irrespective of the assembly order. If an error occurs due to incorrect packing rectangles, it is likely that the end result is dependent



**Figure 2.10.** The river operator joins tiles together in two phases: river routing and spacing. The river routing phase ensures that the proper connectivity is created, while the spacing phase compacts the result according to geometrical design rules. The operator will eliminate routing entirely if the terminals align properly and design rules allow connection by overlap or abutment.

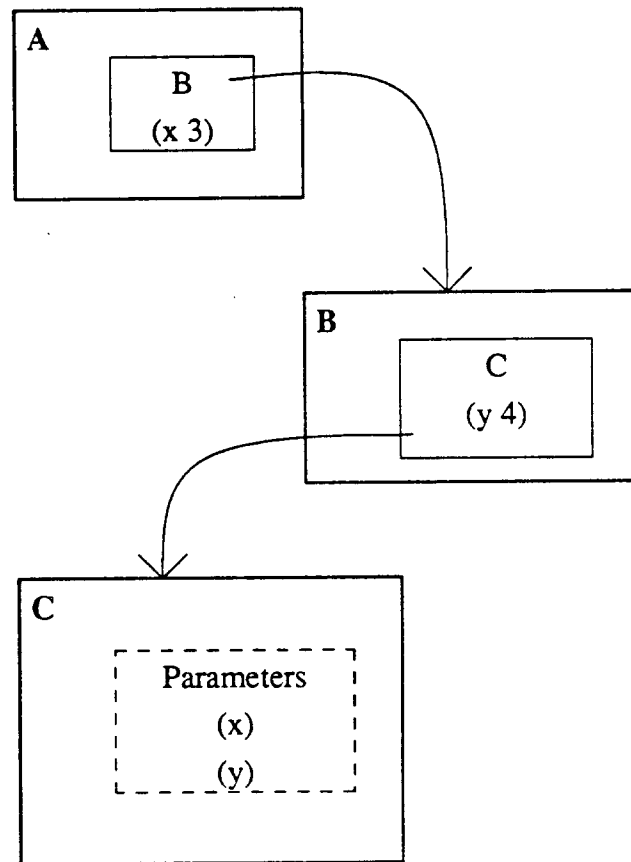
on the assembly order since the system makes a "best guess" at the alignment and proceeds. The location of the error in the layout is tagged with a special marker that is easy to find. The river operator joins tiles by river routing and spacing, ensuring that design rules are met (Figure 2.10). If spacing rules allow, the operator may eliminate the routing and make the entire join using abutment or overlap. This operator is dependent upon the assembly order, since it attempts to squeeze out as much space as possible during each join. It is the responsibility of the diagram designer to choose an order that produces the desired result. The default tag instructs Mocha Chip to inspect a global variable in order to pick an assembly operator. This variable will contain either the tag **pack** or the tag **river**. Using the default tag makes it possible to delay the choice of an assembly operator until after the diagrams are designed. For example, a module generator could be built with many of the cut-lines tagged with **default**. The user of the generator could set the default variable to either **pack** or **river** in order to experiment with different layouts of the module.

## 2.5. PARAMETERIZATION OF DIAGRAMS

Assembly diagrams also take parameters, to control the layout of the module. The parameters and variables are put into the diagrams by pointing to a block or subcell in the diagram and invoking a text editor. These parameters could be as complex as a truth table, in the case of a PLA generator, or as simple as the size for an inverter. Assembly diagrams can also compute local variables and pass new values down to subcells.

Figure 2.7 shows how parameters are declared, local variables computed, and new values passed to subcells. The “Parameters” block specifies two parameters:  $x$  and  $y$ . The  $x$  parameter has no default value, so it must be defined at some higher level. The  $y$  parameter has a default value of 3, which is used if  $y$  is not defined when the diagram is invoked.

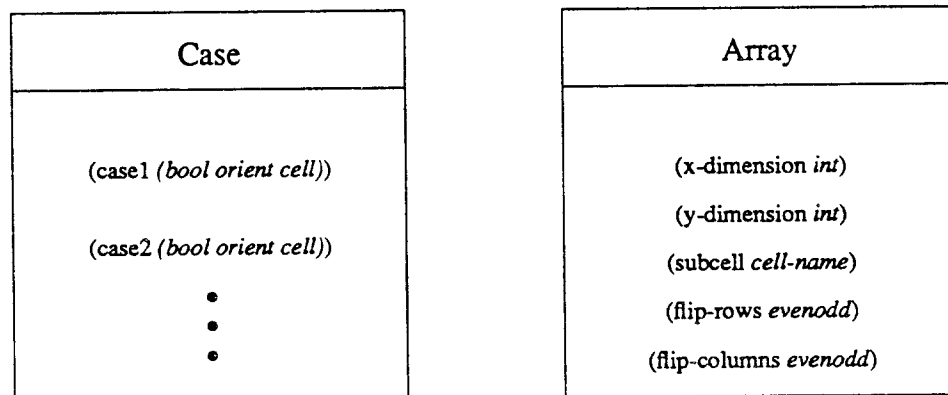
Subcells may also access parameters and variables defined at higher levels of the hierarchy, using Lisp’s dynamic scoping rules. When a diagram is evaluated, the parameters block is evaluated first, followed by the variables block and then the parameters for each individual subcell. The parameters block simply checks to make sure that the parameters are currently defined at some higher level in the hierarchy or have values supplied by defaults. If defaults are used, a new nested scope is created that contains those values. A new scope is then created for the variables block, which is evaluated. Lastly, each subcell in the diagram is then evaluated one at a time, in a scope that includes its parameters.



**Figure 2.11.** In this example, diagram A invokes diagram B with the parameter *x* set to the value 3. This binding holds over the entire area of the invocation of B, and includes an invocation of C. When C is finally invoked, both *x* and *y* are defined. This satisfies the parameters block in diagram C, which checks that both *x* and *y* are defined. If default values were supplied in the parameters block, they would be used if the parameter was undefined.

Figure 2.11 illustrates the scoping rules. When a parameter is declared for a subcell, that parameter value holds for all subcells used further down in the hierarchy unless superceded by a new binding for the parameter. A diagram's parameters do not have to be defined by the direct caller, since they may be inherited from some higher level. This can be considered a form of topological scoping, in that the scope of a parameter is an area rather than a temporal calling sequence. The scoping rules map directly into Lisp's dynamic scoping rules.

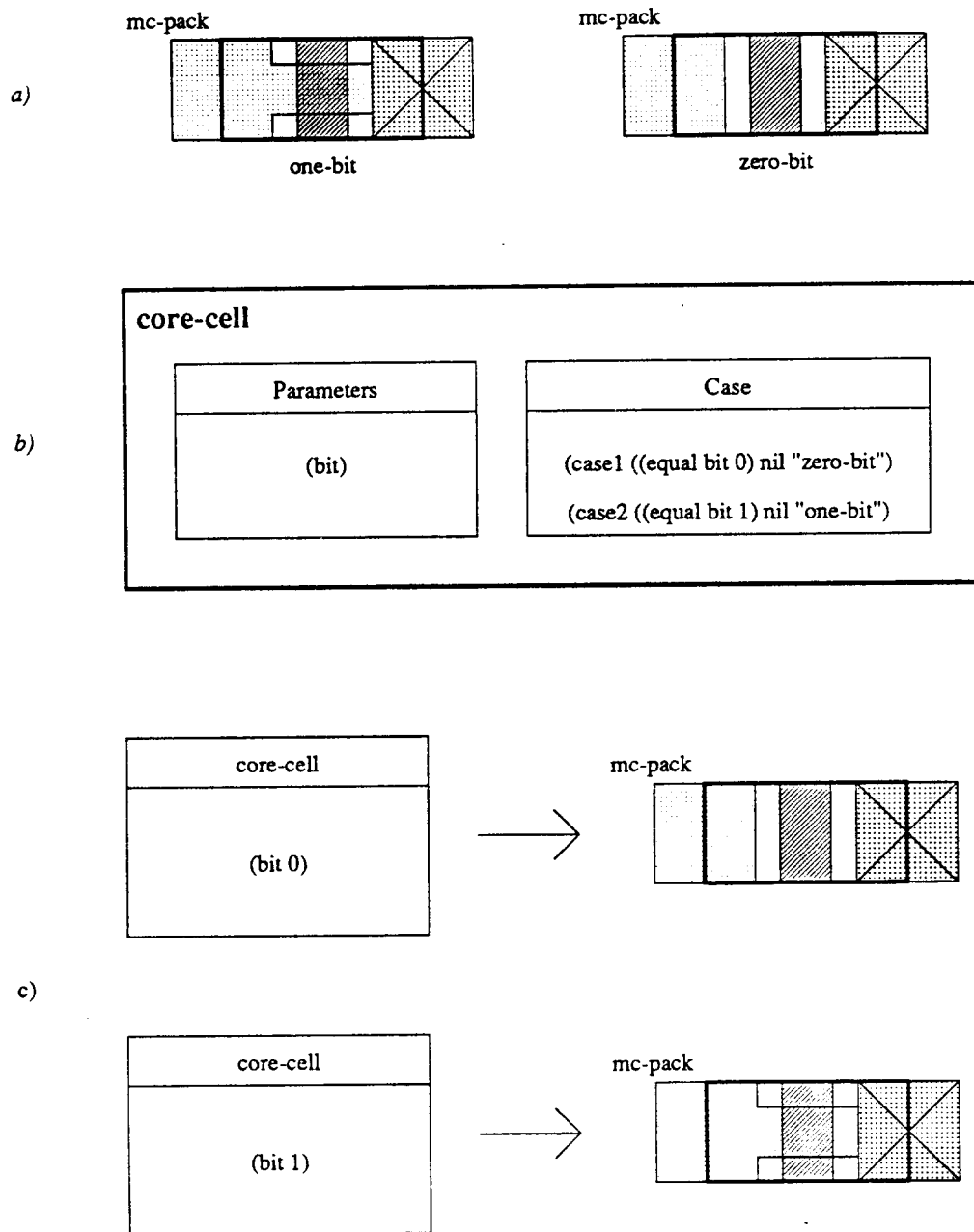
Mocha Chip provides simple graphical programming constructs that make use of these parameters, in the form of two special cells: *case* and *array*. The case cell provides a form of conditional selection, and the array cell provides a form of two-dimensional iteration. These two building blocks can be combined to form more complex control constructs, in the same way that programmers combine loops and conditionals.



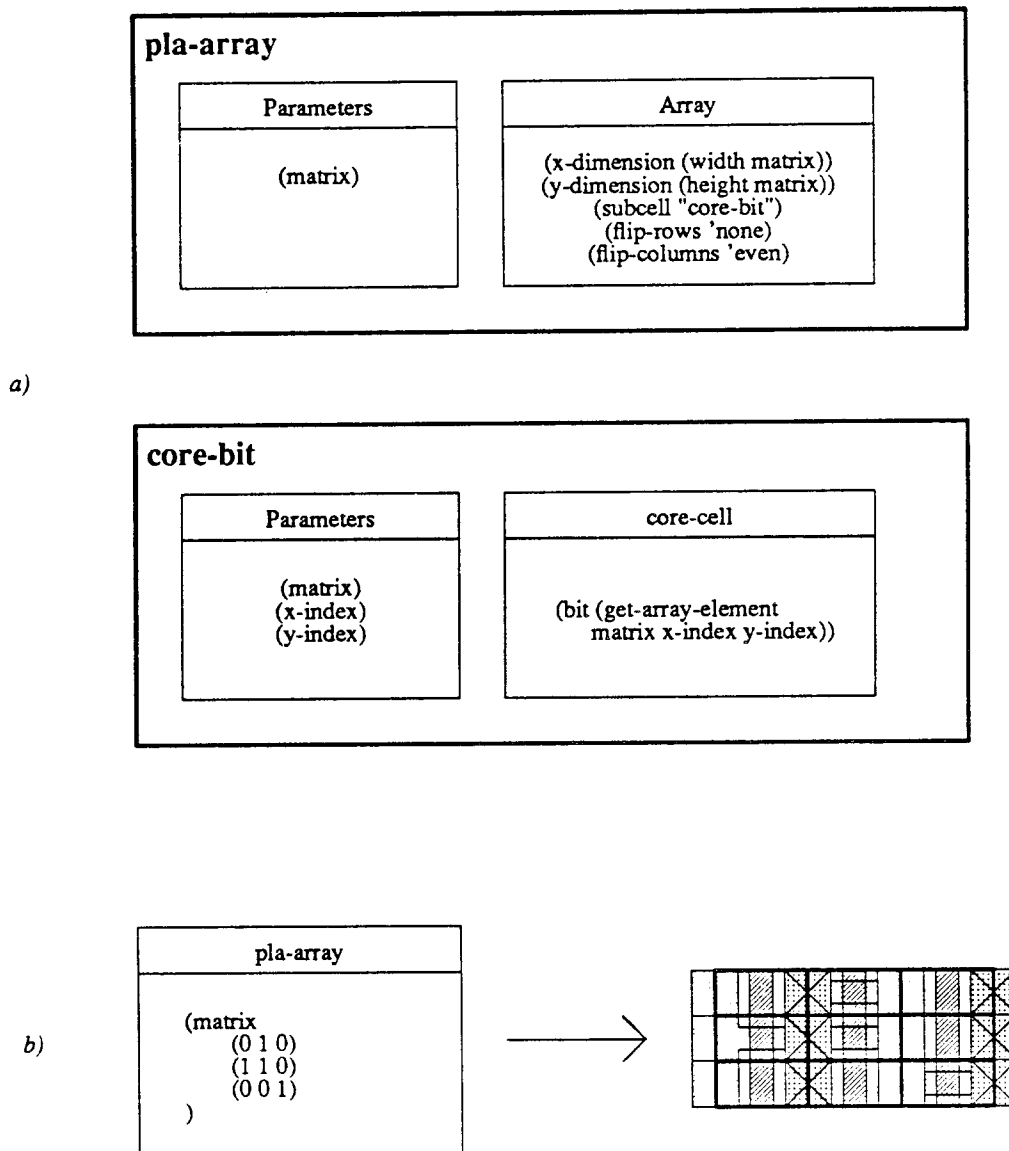
**Figure 2.12.** The case cell provides a form of conditional selection, and the array cell provides a form of two-dimensional iteration. These two cells can be combined in much the same way that a programmer combines loops and conditionals. The operation of the cells is controlled by parameters. The expected types of the parameters are shown in this figure with italics.

The case cell (Figure 2.12) takes a sequence of parameters, each containing three items: a Boolean expression, a cell, and an orientation. The case cell finds the first true boolean expression and uses the corresponding cell in the specified orientation. If no true expression is found, then an error is signaled. As an example, Figure 2.13 shows how a case cell can be used to choose between two tiles of layout. The example is a simplified version of part of a PLA generator.





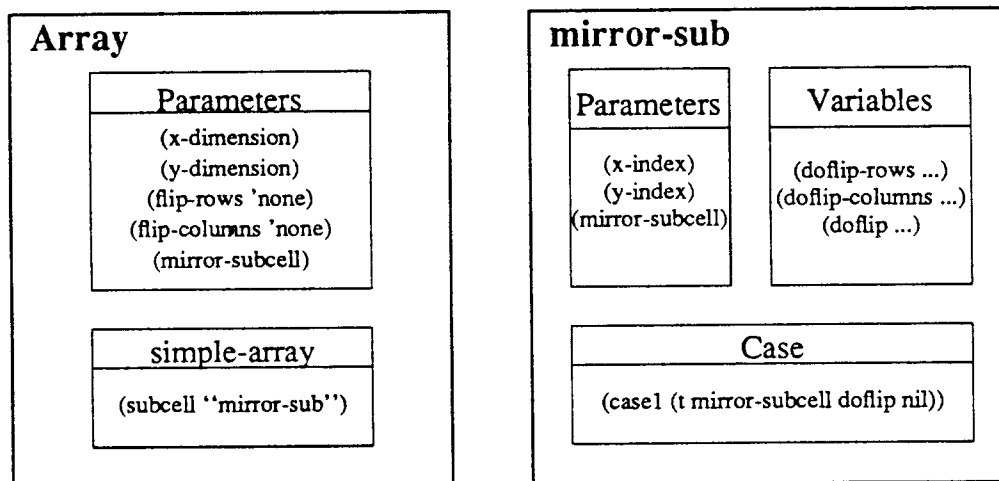
**Figure 2.13.** Part *a* of this figure shows two tiles from a PLA generator. Part of the job of the generator is to choose between these tiles at each location in an array. Part *b* shows a new assembly diagram, called *core-cell*, that takes a parameter called *bit* and uses the one-bit tile if the parameter is a 1, and the zero-bit tile if the parameter is a 0. This gives us a new parameterized cell, called *core-cell*, that chooses between the tiles. Part *c* of this figure shows the *core-cell* invoked with different parameter values.



**Figure 2.14.** The array cell creates a two-dimensional array, invoking either a tile or an assembly diagram at each point. In this example, the diagram `pla-array` takes a parameter called `matrix` and creates an array of the diagram `core-bit`. This diagram uses its own indices to reference a position in the matrix, and passes this value to `core-cell` to select a tile.

The array cell (Figure 2.12) takes parameters that specify its dimensions, the subcell to invoke at each position, and the orientation of the rows and columns. The subcell may be either a cell of mask geometry or another diagram that contains subcells

— including, perhaps, array and case cells. Subcells may determine their structure using the current x and y index (provided to them by the array cell) as well as additional parameters defined by the caller of the array cell. The orientation of rows and columns are controlled by two flags, each of which takes on one of four values: **none**, **even**, **odd**, **all**. The flag allows even or odd rows (or columns) to be flipped upside-down (or sideways). Figure 2.14 gives an example of an array cell.



**Figure 2.15.** Two diagrams can implement our array cell using only a simpler array cell and a case cell. To do this, a diagram called **array** is drawn, and the appropriate parameters are declared. The simpler **array** cell is used to provide iteration, and the case cell is used to select the orientation of the cell at each position in the array. The actual computation of orientation is done using Lisp code in the variables block. The code has been eliminated from this figure due to lack of space, but it is easy to see how it would work. For example, the code for **doflip-rows** needs only to inspect the current y coordinate **y-index** and the parameter **flip-rows** to see if there is a match. A similar computation is done for the columns. The two are combined to form an overall orientation that is stored in **doflip**. The Case cell selects among the alternatives, but in this instance the alternatives are chosen by using variables instead of multiple branches with constant expressions.

The case and array cells are general-purpose control constructs, and can be combined to build new control constructs in the same way that loops and conditionals may be combined. This can be demonstrated by synthesizing the flipping capability of the array cell using only the case cell and a non-flipping version of the array cell. Figure 2.15 shows how this could be done using two assembly diagrams containing the case cell and a hypothetical simple-array cell. The flipping capability in Mocha Chip's array cell ability is only an optimization to speed up the assembly process.

## 2.6. SUMMARY

Mocha Chip's assembly diagrams provide a means of graphically representing the structure of a module. The diagrams replace the code that is traditionally written for this purpose. The parameter scoping mechanism is similar to dynamic scoping in Lisp, and can best be thought of as a form of topological scoping. The case and array cells provide what may be thought of as two-dimensional control constructs. These cells may be composed to form new constructs, in the same way that programmers combine loops and conditionals. The end result is that parameterized diagrams may be composed to form more complex diagrams that generate the modules we see in VLSI chips.

## 2.7. REFERENCES

1. J. K. Ousterhout, G. T. Hamachi, R. N. Mayo, W. S. Scott and G. S. Taylor, The Magic VLSI Layout System, *IEEE Design & Test of Computers*, February, 1985.
2. G. L. Steele, Jr., *Common Lisp, The Language*, Digital Press, 1984.

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## **3** RELATED WORK

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### **3.1. INTRODUCTION**

In the past, several techniques have been developed for the design of module generators. The ideal system would provide visually intuitive mechanisms for expressing geometrical relationships, and allow for flexible parameterization of the structures. Graphics works well for describing geometrical relationships, but is hard to parameterize. Textual programming languages express parameterization well, but make the structure hard to visualize. This interplay of text and graphics is at the heart of the development of module-generator systems. The following sections survey the

development of the field in a roughly chronological order.

### 3.2. PROGRAMMING

Initial module generator systems were based upon general-purpose programming languages, such as DPL[1] (written in Lisp) and Chisel[2] (written in C). These systems provided library routines for generating low-level primitives such as rectangles of material. A typical line in a module generator built using one of these systems looks like:

```
rect(x, y, 3, 5, METAL1);
```

This places a metal rectangle of width 3 and height 5 at the coordinates specified by  $x$  and  $y$ . Since these are calls in a general programming language, the full power of the language can be used to compute the layout of the module. Layout generation then becomes a programming task. For example, constructs such as loops and procedures (Figure 3.2) could be combined to produce the structure shown in Figure 3.1.

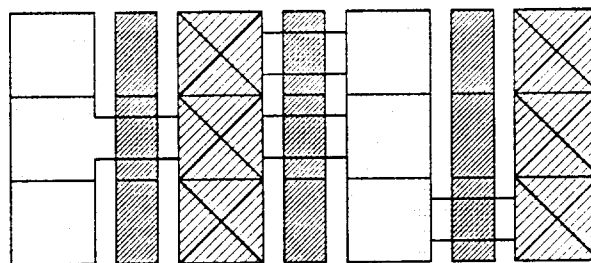


Figure 3.1. Some layout produced by part of a simple PLA generator.

While the programming approach provides the ultimate in flexibility, it is difficult to use in practice. Computing the location of rectangles involves many simple, but

```

procedure pla_array(matrix)
{
  for i = 0 to width_of(matrix)
  {
    for j = 0 to height_of(matrix)
    {
      if (odd(i))
        core_bit_odd(i * 8, j * 4, matrix[i, j]);
      else
        core_bit_even(i * 8, j * 4, matrix[i, j]);
    }
  }
}

procedure core_bit_odd(x, y, bit)
{
  rect(x, y, 4, 4, M1_CONTACT);
  rect(x + 5, y, 2, 4, POLY);
  rect(x + 8, y, 4, 4, N_DIFF);
  if (bit == 1)
    rect(x + 4, y + 1, 4, 2, N_DIFF);
}

procedure core_bit_even(x, y, bit)
{
  rect(x, y, 4, 4, N_DIFF);
  rect(x + 5, y, 2, 4, POLY);
  rect(x + 8, y, 4, 4, M1_CONTACT);
  if (bit == 1)
    rect(x + 4, y + 1, 4, 2, N_DIFF);
}

```

**Figure 3.2.** Some code to produce the layout in Figure 3.1. In a system like this, all the features of a general-purpose programming language can be applied to layout generation. The disadvantage is that the code is textual and makes it hard to visualize the geometry.

error-prone, computations, since it is hard to visualize the layout by looking at the text. These module generators are debugged by editing the program, compiling it, and plotting the output. Many iterations are required in order to debug a module generator. In addition, most module generators have many options which exacerbate the problem. Erroneous output is often produced when a module generator built using this technique is supplied with combinations of input parameters that have not been previously tested. More information about the programming technique and its limitations may be found



in Chapter 6 of Steve Trimberger's book[3] and Chapter 8 of Steve Rubin's book[4].

One approach to improving the programming technique is to automate some of the placement of geometry. This is done by handling connections and design rules automatically. The programmer specifies the relative positions of the rectangles and what is to be connected. The system then picks absolute coordinates for the rectangles creating a design-rule correct layout. The best know examples of this technique are *i*[5] and *allende*[6]. In *i*, symbols (transistors, contacts, etc.) are placed relative to other features, such as other symbols or wires. Wires are attached to terminals (called connectors) on the symbols. It is possible to specify relative distances, such as the placement of one symbol 3 units above another. The design style is similar to symbolic layout[7, 8], but is programmed rather than being drawn. In *Allende* (Figure 3.3), the user abuts cells to form new ones, but the abutment specifies connections and relative positions, not absolute coordinates. Coordinates are determined by solving a set of constraints between rectangles that capture the designer's specification. The basic cells are either provided externally to the system or built out of primitive components such as transistors and rectangles.

These approaches help, but they still suffer from the problem that text is an awkward way to specify geometry. Additional problems are also created. Solving the constraints takes more time than more direct approaches. For example, *Allende* takes 9.5 minutes to produce a 16-bit ALU when running on a VAX 11/750. The designs produced are not always as small as hand designs, since the systems give up some flexibility in order to guarantee the correctness of the constraints. On the whole, though,

```

procedure pla_array(matrix)
{
  begincell('pla_array');
  for i = 0 to width_of(matrix)
  {
    begincell(' ');
    for j = 0 to height_of(matrix)
    {
      if (odd(i))
        place(FLIPPED0);
      if (matrix[i, j] == 1)
        extcell('onebit');
      else
        extcell('zerobit');
      if (j != height_of(matrix)) place(ABOVE);
    }
    endcell(' ');
    if (i != width_of(matrix)) place(RIGHT);
  }
  endcell(' ');
}

```

**Figure 3.3.** This figure presents Allende code that is equivalent to the previous example. Allende generates a set of constraints on rectangles that, when solved, will implement this specification.

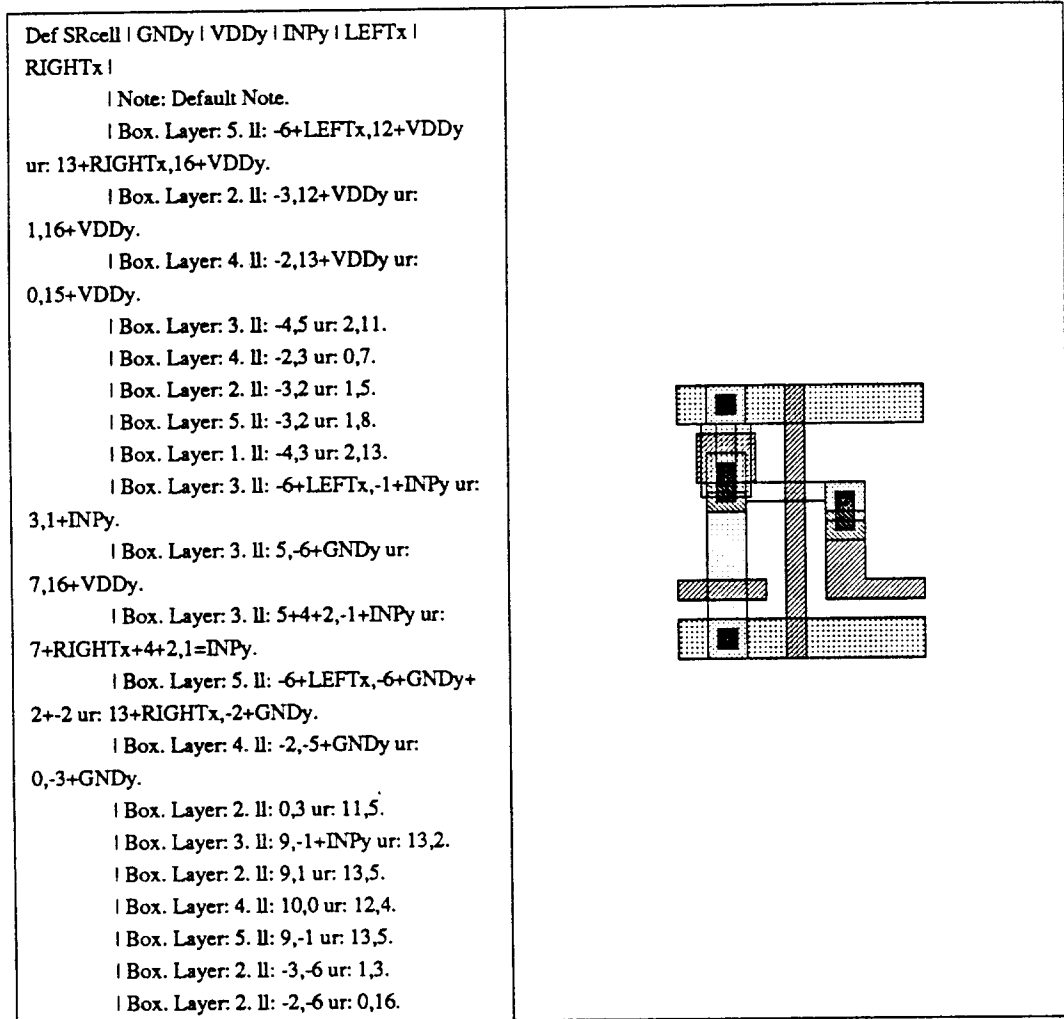
constraint-based layout seems to be an improvement over the direct programming of actual coordinates, in that design-rule errors are eliminated.

### 3.3. GRAPHICAL SYSTEMS

Graphical systems such as Caesar[9], Chipmonk[10], and Magic[11] were first developed as an intuitive means of specifying non-parameterized geometry. The layout is simply drawn rather than programmed. This provides a better user interface, since what the designer sees on the screen is identical to the conceptual image in the designer's head. The problem, of course, is that these graphics systems don't provide programmability. Without programmability, we cannot create module generators and all layout must be drawn manually.

Some graphical systems have features to partially compensate for their lack of programmability. In some systems, such as Chipmonk[10] and Electric[4], wires are attached to other pieces of material and move around when the attached pieces move, to maintain connectivity. Symbolic layout systems such as Mulga[7] and Vivid[8] take this one step further, providing a graphical version of the design style we encountered with constraint-generating programming languages. In the symbolic layout style, circuit elements and wires are drawn in their relative positions and the system solves constraints to determine the absolute coordinates.

Two systems, SAM[12] and Daedalus[13], combine a graphical display with a textual programming language. In SAM, the two displays are simply two views of a single data structure (Figure 3.4). This greatly aids the writing of programs for layout generation, providing something that is best thought of as instant plotting with the ability to make small graphical changes. The user can edit either of the views, and the corresponding changes appear in the other view. The graphical display only shows one instance of the module to be generated, in effect instantiating the program with a fixed set of parameters. When the graphical layout corresponding to parameterized text is edited, there is ambiguity in how the text should be updated, since several parameterized texts can generate a single graphical layout. The users of these systems must use and understand two different but linked representations. While this works well for the layout of low-level cells, it does not greatly aid the higher-level parameterization of a module generator.



**Figure 3.4.** In SAM, the display shows two windows. On the left is parameterized text, and on the right is an instance of the cell. Either window may be modified, and the other is updated. The two windows are in fact two views of a single internal data structure. This diagram is copied from a paper on SAM[12].

### 3.4. TILING

Tiling attempts to combine the good features of a programming language with the visual power of a graphical editor[14]. With tiling, a graphical editor is used to prepare pieces of geometry called tiles. The tiles can contain any amount of geometry, but usually contain components similar in size to input buffers, gates, and registers. The tiles are assembled by a program, providing a parameterized way of assembling the

```

procedure pla_array(matrix)
{
  width = WIDTH_OF("onebit");
  height = HEIGHT_OF("onebit");
  for i = 0 to width_of(matrix)
  {
    if (odd(i))
      orient = SIDEWAYS;
    else
      orient = NORMAL;
    for j = 0 to height_of(matrix)
    {
      if (matrix[i, j] == 0)
        name = "zerobit";
      else
        name = "onebit";
      place_tile(i * width, j * height, name, orient);
    }
  }
}

```

**Figure 3.5.** In the tiling approach, a graphical editor is used to prepare tiles of layout, which are then assembled using a program. The program in this figure places tiles at absolute coordinates. More advanced systems placed tiles by aligning their corners or by packing them together using user-specified packing rectangles.

building blocks (Figure 3.5).

This approach eliminates the difficulties encountered when placing individual rectangles with a program, instead replacing it with the similar, but smaller, problem of placing tiles of geometry. Errors can occur between tiles, but are less frequent than when individual rectangles are placed.

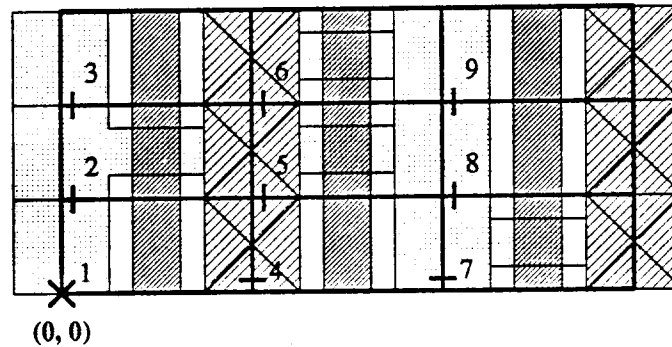
Several schemes were developed for placing the tiles. The earliest scheme placed tiles at absolute positions (Figure 3.5). Correct alignment was difficult with this scheme. A more popular method placed tiles by aligning their user-specified packing rectangles. For example, the code could specify that a tile was to be placed above some previously placed tile. The system would then compute a location for the new tile that caused its packing rectangle to exactly abut the packing rectangle of the

previously placed tile.

TPACK[14], my Master's Project, developed a more powerful scheme. In TPACK, tiles are aligned by their corners. This is more general, since special empty *spacing* tiles can be defined whose corners are used to control the alignment of other tiles (Figure 3.6). This allows placement of a new tile at an arbitrary offset from some previously placed tile, something that is not possible with the packing rectangle approach. However, there is a price paid for this additional flexibility. The information about which corners are used for alignment is contained in the program code. This means that the tile designer must either look at the program code when designing spacing tiles, or read documentation that describes the code's behavior. With the packing-rectangle approach, there is no variation in the assembly method, resulting in a simpler interface for the tile designer. My experience over the past few years indicates that the additional flexibility provided by TPACK is not worth the added complexity for the tile designer.

### 3.5. REGULAR-STRUCTURE GENERATOR

Bamji's Regular-Structure Generator[15] attempts to solve the problem of assembling tiles. Bamji defines an interface, which is a legal relative position for two tiles. The set of interfaces is defined by the user by placing examples in a diagram and numbering them (Figure 3.7). The system ensures that when tiles are placed only pre-specified interfaces are used. This allows the user to verify the interfaces in advance, in turn ensuring that the resulting layout only contains verified interfaces.

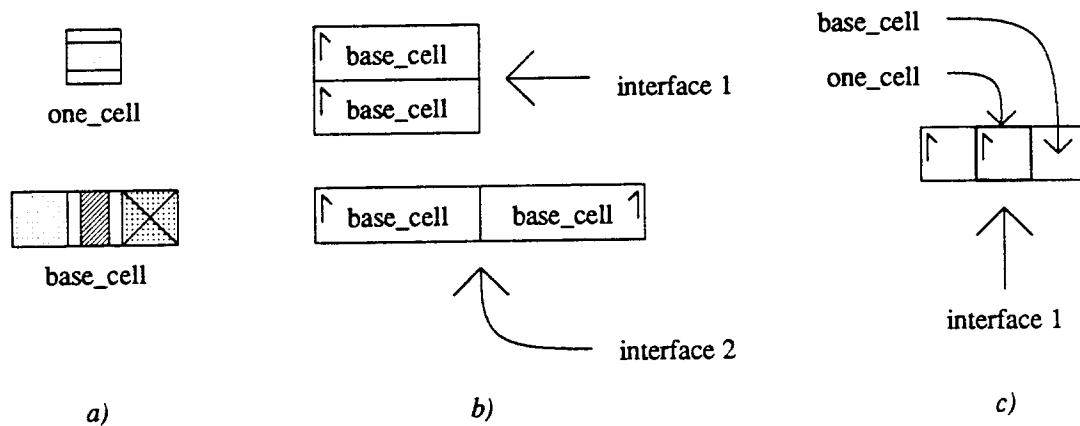


```

procedure pla_array(matrix)
{
  for i = 0 to width_of(matrix) {
    if (odd(i)) {
      zero_tile = "zerobit-flipped";
      one_tile = "onebit-flipped";
    } else {
      zero_tile = "zerobit";
      one_tile = "onebit";
    }
    for j = 0 to height_of(matrix) {
      if (matrix[i, j] == 0)
        new_tile = zero_tile;
      else
        new_tile = one_tile;
      if (i == 0 AND j == 0) /* Place first tile at (0, 0). */
        last_tile = place_tile(new_tile, ORIGIN);
      if (j == 0) /* Start new column to right of previous column. */
        last_tile = place_tile(new_tile,
          align(lower_left(new_tile), lower_right(prev_column)));
      else /* Place new tile above previous one. */
        last_tile = place_tile(name,
          align(lower_left(new_tile), upper_left(last_tile)));
      if (j == 0) prev_column = last_tile;
    }
  }
}

```

**Figure 3.6.** TPACK uses corner alignment to place tiles. Each new tile has a corner aligned with a previously placed tile, as is indicated by heavy bars in this figure. The bars are numbered sequentially in the order that the tiles were placed. Spacing tiles could be used to provide arbitrary offsets, but this is not needed for this example. The tile-packing method recognizes this, and uses packing rectangles instead of specifying corners in the code. The result is much the same, but simplifies both the code and the design of tiles, since the tile designer never needs to know which corners are used for alignment. Some flexibility is lost, however, since arbitrary offsets cannot be provided through the use of spacing tiles.



```

procedure pla_array(matrix)
{
  for i = 0 to width_of(matrix)
  {
    for j = 0 to height_of(matrix)
    {
      if (i == 0 AND j == 0)
        /* Place first tile at arbitrary location. */
        last_tile = place_tile("base_cell", nil, nil);
      if (j == 0)
        /* Start new column to right of previous column (interface #2). */
        last_tile = place_tile("base_cell", prev_column, 2);
      else
        /* Place new tile above previous one (interface #1). */
        last_tile = place_tile("base_cell", last_tile, 1);
      /* Program cell to a '1' if needed. */
      if (matrix[i, j] == 1)
        place_tile("one_cell", last_tile, 1);
      if (j == 0) prev_column = last_tile;
    }
  }
}

```

**Figure 3.7.** In the Regular-Structure Generator (RSG), tiles are drawn and example arrangements given. The arrangements define *interfaces*, which are then used by a program to specify the connectivity of the tiles. The actual positions and orientations are determined by the relative positions and orientations drawn in the example arrangements. A given pair of tile types may have more than one possible configuration, leading to multiple interfaces (as in part *b* of this figure). Interfaces are numbered and referred to in the code. RSG uses a Lisp-like language, but this example has been coded in a C-like language for consistency with the other examples in this chapter.

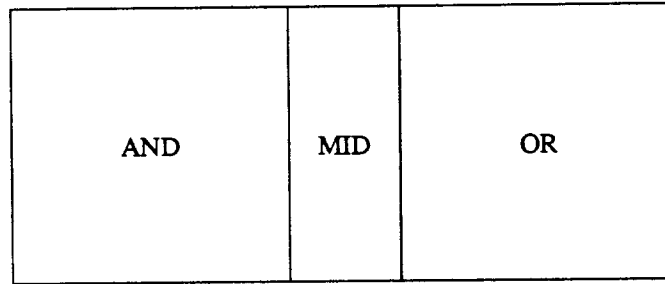


The technique does not work well for generators that have a large number of optional tiles for a certain location, as is common in practice. An interface must be defined for each possible combination of tiles, leading to an exponential rise in the number of interfaces to be defined and checked. This problem is partially, but not completely, overcome by allowing tiles to be stacked on top of each other, allowing a single tile to be “programmed” by the presence of other tiles on top.

### 3.6. ARRAY-STRUCTURE TEMPLATES

SDA's Structure Compiler uses array-structure templates[16] to specify graphically the global structure of a module. The user can draw arrays whose contents are determined by personality matrices and pieces of code (Figure 3.8). The system has no graphical representation of conditional selection, and doesn't allow arrays to be nested. These features would be needed in order to make the system complete, in the sense of allowing arbitrary structures to be built graphically and re-used as if they were primitive components.

Module assembly proceeds in three steps. In the first step, each block is processed, creating a map of symbols based upon a personality matrix and rules attached to the block. The second step executes user-supplied code that manipulates the map. In the final step, each block is assembled by translating the symbols into tiles, packing the tiles together (using user-specified packing rectangles), and joining the resulting blocks as specified by the array-structure template.



*Array properties for the AND plane:*

```
map: 1 → TN; 0 → NT; - → NN;
tiles: N → "zerobit"; T → "onebit";
orientation: flip-odd-rows; flip-odd-columns;
procedure: "pla_code.l";
```

**Figure 3.8.** SDA's Structure Compiler uses a diagram to show the overall structure of a module that consists of arrays. Our simple example would contain only one array, but this figure shows a module with three arrays to give a feel for the sort of diagrams that are drawn. Each array is tagged with *array properties* that control how a *personality matrix* is mapped into an array of tiles. In this example, a "1" symbol in the input is expanded to the two symbols "TN". After this expansion, the procedure *pla\_code.l* is invoked. This procedure may inspect the array and change symbols, add new rows and columns, and do other manipulations to produce a new array. For our simple example, no such procedure would be required. After the procedure is run, the symbols in the array are translated into tiles using the *tiles* array property, and packed together using user-specified packing rectangles. The *orientation* property controls the positioning of the tiles. The syntax of array properties has been changed for this example in order to increase readability.

### 3.7. DISCUSSION

Several techniques have been developed for the design of module generators. The key theme is the tradeoff and integration of visually-expressive graphics with parameterization. There are two main problems that concern this tradeoff: the representation of the structure of a module, and the correct placement of tiles so that they obey geometrical design rules.

Most current systems use graphics to draw tiles that are then assembled by a programming language. Only the Regular-Structure-Generator specifically addresses the

problem of correctly placing tiles. It, however, requires the legal interfaces to be drawn by the user, which can be impractical if a large number of tiles can fill a given position, resulting in an exponentially large number of interfaces. Mocha Chip takes a different approach: tiles are assembled by assembly operators rather than directly placed. The simplest of these operators, the packing-rectangle operator, provides no help with the correct placement of tiles. The river-route-space operator, however, places tiles so that they obey geometrical design rules and connectivity rules. As a result, placement is guaranteed to be correct without forcing the module generator designer to verify an exponentially large set of tile interfaces.

The other main concern is the representation of the overall structure of a module. Both array-structure templates and Mocha Chip provide a means of using graphics to specify this structure. Array-structure templates are limited to the specification of the top-level array structure of a module. Mocha Chip, however, is an extensible programming system that has graphical representations of both conditional selection and iteration. In addition, Mocha Chip diagrams can be used in other diagrams in the same way that tiles are, resulting in a system that can express hierarchical module generators using graphics. Thus, Mocha Chip diagrams are used to specify the structure of all levels of a module, not just the top-level overall structure.

Mocha Chip is an advance in both areas addressed by previous systems: the representation of the module's structure and the placement of individual tiles. A new graphical programming language is used to represent the structure of a module. The language is complete in the sense that it provides graphical representations of iteration

and conditional selection that can be combined to form new control constructs. Mocha Chip's assembly operators represent a new approach to the second problem: the placement of tiles. In Mocha Chip, the river-route-space assembly operator guarantees proper connectivity and ensures that geometrical design rules are not violated. This automatic placement of tiles frees the module generator designer from having to manually verify that all possible tile interfaces are valid. The end result is a powerful module generation system that eases the module design process.

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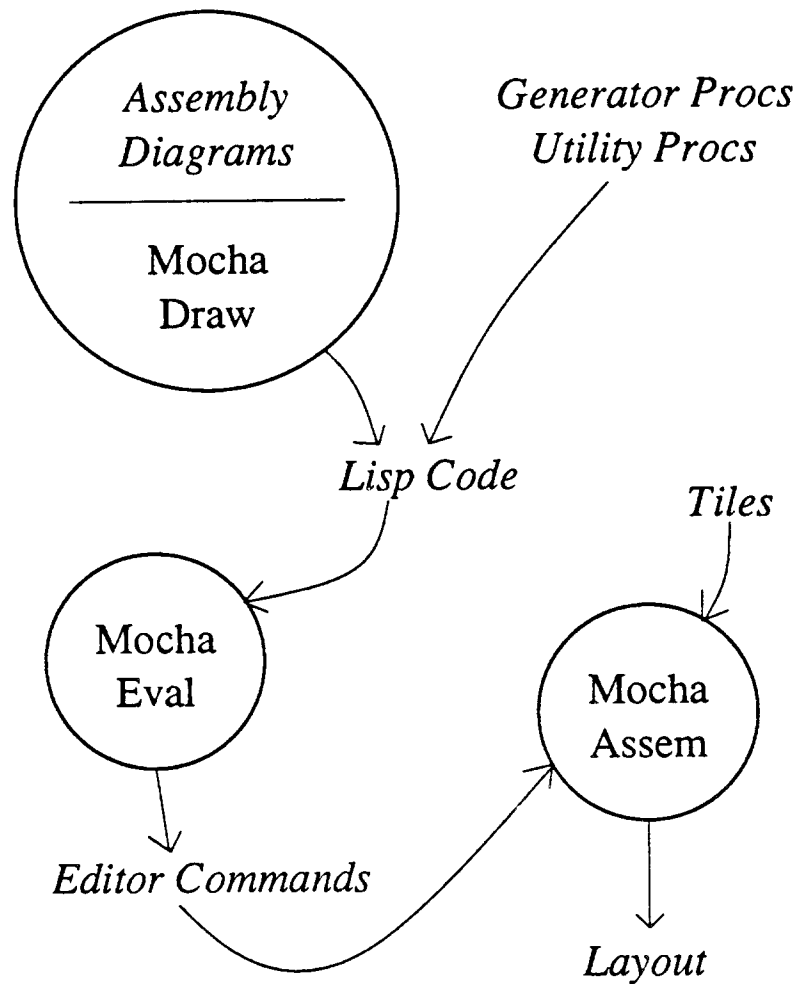
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## **4** SYSTEM OVERVIEW

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### **4.1. SYSTEM STRUCTURE**

The Mocha Chip implementation contains four components (Figure 4.1). Three of the components correspond to three issues that Mocha Chip addresses: the use of graphics to draw parameterized diagrams, the evaluation of those diagrams to produce an instantiated module, and the assembly of mask layout for that module. Graphics are handled by the Mocha Draw module, instantiation by the Mocha Eval module, and assembly by the Mocha Assem module. The fourth module, Mocha Lisp, provides a communication mechanism between C and Lisp, as will be discussed later.

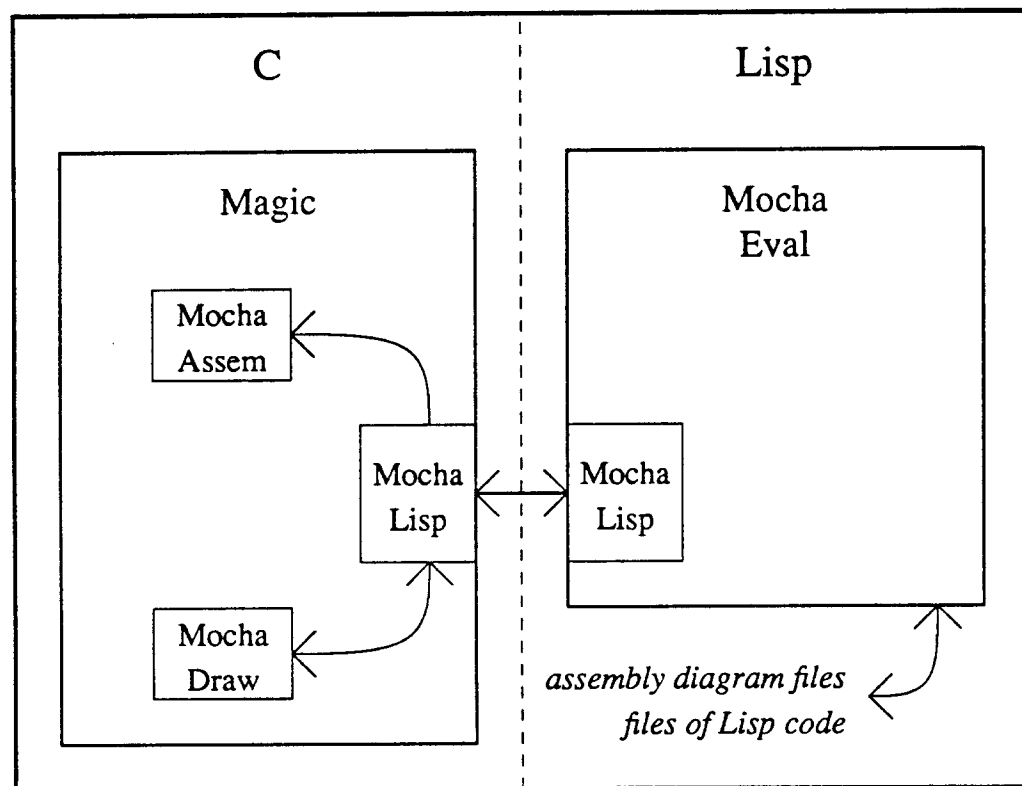


**Figure 4.1.** Mocha Chip is divided into four components. Mocha Draw handles editing of the assembly diagrams and produces Lisp code that represents them. Mocha Eval evaluates the code to produce an instance of a module, also represented as Lisp code. The instantiated Lisp code is used to produce a file of editor commands that control Mocha Assem's assembly of mask layout. Mocha Lisp, not shown in this diagram, is a module that allows C code to communicate with Lisp code, and will be discussed later.

During use, data flows from Mocha Draw into Mocha Eval and then on to Mocha Assem. Mocha Draw takes input from the user and creates assembly diagrams. These diagrams are converted into files of Lisp code. This parameterized Lisp code is combined with other Lisp code and given to Mocha Eval, which evaluates it to produce a single instance of the module. The instance is represented as a binary tree of pairwise



assembly operations, and is communicated to the Mocha Draw module via a file of special-purpose editor commands. These commands, along with a set of tiles of mask geometry, are used by the Mocha Assem module to produce the final layout.



**Figure 4.2.** Mocha Chip is written in both C and Lisp. The C portion consists of the Mocha Draw module and the Mocha Assem module, both of which are integrated into Magic. The Lisp portion consists of Mocha Eval. The Mocha Lisp module implements a special purpose RPC (remote procedure call) mechanism that allows the two parts to communicate. Part of Mocha Lisp is written in C, and part in Lisp.

Mocha Chip is integrated with the Magic VLSI layout editor [1], as shown in Figure 4.2. Mocha Draw is a special window type in Magic that draws assembly diagrams. It consists of about 12,000 lines of C code. Mocha Assem is also written in C, and makes heavy use of Magic's corner-stitched database. It consists of about 10,000 lines of code. Mocha Eval is a Lisp system, run as a subprocess to Magic. It is written in

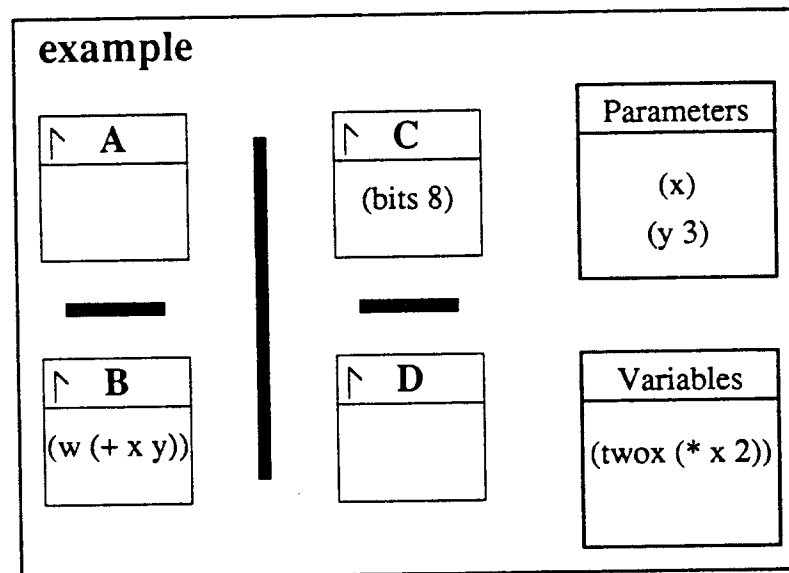
about 8,000 lines of Lisp code, and communicates with Magic via a special-purpose RPC (remote procedure call) as well as with files. The RPC mechanism is written in both C and Lisp, and is contained in the Mocha Lisp module.

Mocha Chip was written in two languages to facilitate the integration with Magic and the interpretation of code written interactively. The latter requirement comes from the fact that diagrams are drawn and parameterized interactively, and then need to be evaluated. Lisp was chosen as a common and easily understandable language for interactive interpretation of expressions. C was chosen for the rest of the system, so that Mocha Chip could make use of Magic's graphics routines and Magic's corner-stitched layout database.

Mocha Chip is an open system in the sense that the user may elect to use only part of it. I expect that users will draw assembly diagrams in order to specify modules, but it is possible to write the Lisp code directly. This provides a means of determining if the assembly diagrams are really a convenient specification. If not, I would expect to see users writing Lisp code instead of drawing assembly diagrams. It is also possible to generate the file of editor commands directly, bypassing the Lisp system entirely. This retains the use of the pairwise assembly operator, but allows for the development of different front ends for module specification.

The next sections discuss the implementation of the modules.

## 4.2. MOCHA DRAW



**Figure 4.3.** This is an example of an assembly diagram drawn with Mocha Draw. Commands are used to place the blocks and control their orientation. The editor provides a mechanism for editing the text that is contained within each block. Cut-lines may be inserted automatically, although the editor allows the user to modify them.

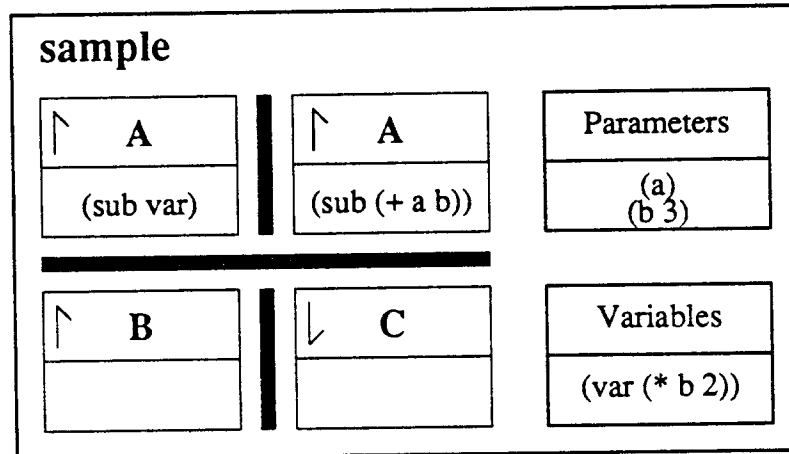
Mocha Draw is the graphical editor for drawing assembly diagrams. Figure 4.3 shows a simple assembly diagram drawn with the editor. Mocha Draw is implemented as a special window type in the Magic VLSI layout editor. There are commands to read and write assembly diagrams, to place a subcell, and to perform transformations such as rotation and mirroring. For the most part, the syntax of these commands is similar to the corresponding Magic commands for IC layout. Mocha Draw also provides special commands for editing the text inside of a cell as well as commands for dealing with cut-lines. Text is edited by selecting a cell in the diagram and opening up a new window with a text-editor containing the contents of the cell.

Mocha Draw can automatically draw cut-lines, although the user is free to put them in manually. Mocha Draw's automatic procedure is very simple. First, it attempts to find a clear path through the diagram. If such a path is found, a cut-line is drawn through that path and the procedure repeats on the areas on each side of the cut-line. If no path is found, a side of the diagram is chosen and all the cells that touch that side are moved outwards enough to open up a clear path. The procedure then repeats. Eventually the procedure will encounter a single cell, at which point it terminates.

Once a diagram is created, Mocha Draw stores the diagram as Lisp code (Figure 4.4). This Lisp code can be read back into the editor for further graphical editing of the diagram. Each graphical construct has a corresponding Lisp function. Each of these will be described.

The setup for an assembly diagram is handled by the **MochaChipCell**, **Parameters**, and **Variables** functions. **MochaChipCell** takes a cell name and an expression to evaluate. This expression is usually a call to the **Parameters** function, which contains a list of parameters to be set up and a function to evaluate in the new referencing environment. The **Variables** function has a similar effect. Figure 4.4 shows the use of these functions in a small example.

The main body of the diagram is handled by the **Invoke** function, the pairing functions **HorizontalPair** and **VerticalPair**, and the orienting functions **Clockwise**, **Sideways**, and **UpsideDown**. **Invoke** takes a cell name, an instance name, and some arguments for the cell. The result is the cell evaluated with the given arguments. This



```

(MochaChipCell "sample"
  (Parameters ( (a) (b 3) )
    (Variables ( (var (* b 2)) )
      (VerticalPair "pack"
        (HorizontalPair "pack"
          (Invoke "A" ( (sub var) ) ...)
          (Invoke "A" ( (sub (+ a b)) ) ...)
          ...)
        (HorizontalPair "pack"
          (Invoke "B" nil ...)
          (UpsideDown (Invoke "C" nil ...))
          ...)
        ...)
      ...)
    ...)
  )

```

**Figure 4.4.** Assembly diagrams are stored as Lisp procedures. The translation is a simple one — each graphical construct has a corresponding Lisp function. Each Lisp function has a place for the editor to store uninterpreted data (indicated by ...). This data suggests coordinates for the corresponding graphical object, so that diagrams retain their appearance across editing operations.

cell may be transformed using the **Clockwise**, **Sideways**, and **UpsideDown** functions. **Clockwise** rotates by a multiple of 90 degrees, while **Sideways** and **UpsideDown** provide mirroring operations. Each cut-line in the diagram corresponds to a call to either **HorizontalPair** or **VerticalPair**. The first argument to these functions is the text associated with the cut-line, and specifies which pairwise assembly operator to use.

Additional information, indicated in Figure 4.4 by ellipses, is provided by the graphical editor. This information contains suggestions about the size and placement of components on the screen. It is used to ensure that diagrams don't change in appearance across editing sessions. If the information is omitted or inconsistent, Mocha Draw provides reasonable values.

Assembly diagrams are read into Mocha Draw by executing them in a special Lisp environment. The procedures in this environment invoke procedures in Mocha Draw via a special-purpose RPC mechanism. These procedures construct and place the corresponding graphical objects to create the assembly diagram represented by the Lisp code.

### 4.3. COMMUNICATION WITH LISP

A text-based and line-oriented RPC mechanism is used to communicate between the C and Lisp portions of Mocha Chip. For a call to Lisp, C sends a line to Lisp. Lisp sends back lines containing messages to be printed, a return value, and a then a prompt. The line immediately before the prompt line is assumed to be the return value. Errors are recognized by the special prompt that Lisp prints out after an error.

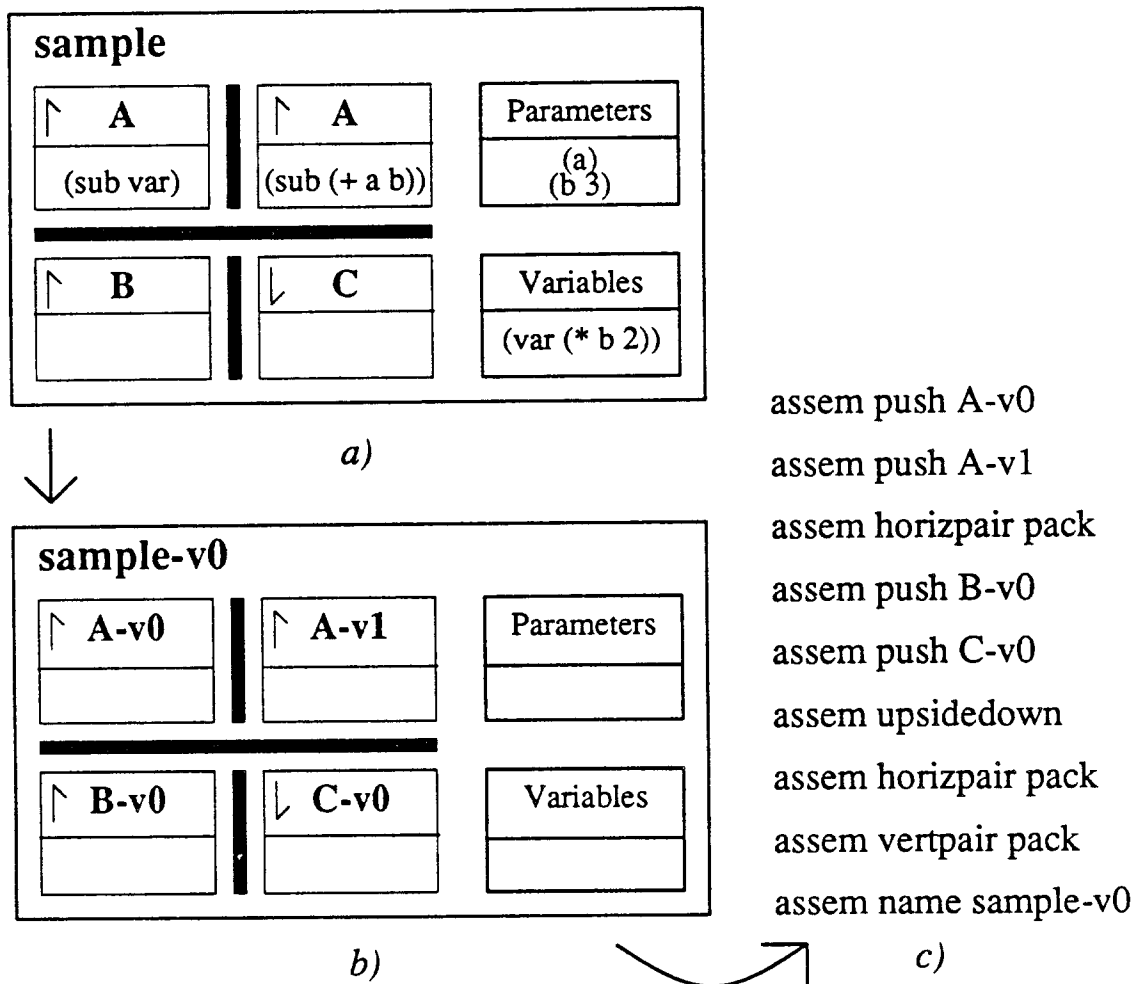
For a call to C from Lisp, Lisp prints out a special message line that is recognized by the C part of the system. The line contains a special prefix followed by the name of the function to invoke and textual arguments. C looks this up in a table and calls the appropriate routine. The return value of the routine is sent to Lisp as a text string which sets a Lisp variable. The calls may be nested, so Lisp can call C and vice-versa to any depth.

#### 4.4. MOCHA EVAL

Mocha Eval's task is to take the code produced by Mocha Draw and produce an instantiated module. This is done by executing (or in Lisp terminology, "evaluating") the code in a special Lisp execution environment. Two phases are used. The output of the first phase is a tree of diagrams. These diagrams correspond to the assembly diagrams drawn by the user (Figure 4.5a), except that parameters have been eliminated and unique names have been assigned to the resulting versions of the diagrams (Figure 4.5b). In the second phase, this tree of diagrams is translated into commands to control the assembly process (Figure 4.5c).

The Mocha Eval code is written in Common Lisp, which is readily portable. The user may, however, parameterize assembly diagrams with Lisp code that is not portable. It is important that the user avoid non-portable code if the generator is to be portable.

If a Lisp error occurs during evaluation (e. g. because of improper code specified by the user), information about the error is passed to the user along with the name of



**Figure 4.5.** Mocha Eval takes a set of parameterized diagrams and produces a file of Magic commands. This proceeds in two phases. In the first phase, parameters and variables are evaluated to produce an instantiated tree of diagrams. Next, the tree of diagrams is translated into a file of special-purpose commands.

the cell that was being evaluated when the error occurred. The user can also elect to interact directly with Lisp when an error occurs. In this mode, Magic and Mocha Lisp just act as intermediaries, passing lines back and forth between the user and the Lisp subprocess.



In the first phase, Mocha Eval starts with the name of the topmost cell of the module. The procedure with this name (corresponding to an assembly diagram) is executed, and the procedure may explicitly load in files of Lisp code containing user-specified functions. When subcells are invoked, Mocha Eval finds the corresponding file of code and loads it. The subcells are then executed, and the process recurses. The result (function return value) of the execution of a cell is another cell that has all the parameters and variables instantiated (Figure 4.4b). This new cell may contain fully instantiated subcells, also produced by the cell evaluation process.

Cells are located using Magic's search path. Each directory in the path is inspected in turn to see if it contains the desired cell. The first cell found is used. This mechanism allows for the easy modification of generators. A user can override the description of a subcell of a module generator by designing a special version of that subcell and arranging for it to appear earlier in the search path.

In the second phase, Mocha Eval executes the instantiated cells. Each function call creates a command for the assembly process. As an example, an **invoke** command is issued for each subcell reference, and a **horizpair** command is created for each **HorizontalPair** function call.

#### 4.5. MOCHA ASSEM

Mocha Assem assembles the mask layout for a module. It does this using a stack and a collection of pairwise assembly operators and orientation operators. Cells are pushed onto the stack, and the operators manipulate the items on the top of the stack.

Special purpose Magic commands control the assembly process. Figure 4.5c shows a simple file of commands.

The most interesting commands are the **horizpair** and **vertpair** commands. Conceptually, they invoke a pairwise assembly operator using the two items on the top of the stack as arguments. The operator joins these two pieces of layout together, forming a third, larger, piece. This piece is pushed onto the stack for use in the remaining commands. In actuality, Mocha Assem delays the operation; instead it creates a tree structure that indicates the joins required. This allows for future enhancements to the system that may require knowledge of the overall structure before a join can be made. The pairwise assembly operators are discussed more fully in Chapter 5.

#### 4.6. SUMMARY

Mocha Chip is divided into four parts: Mocha Draw, Mocha Eval, Mocha Assem, and Mocha Lisp. The drawing editor Mocha Draw provides a graphical interface for drawing assembly diagrams. Mocha Draw stores these diagrams in files as pieces of Lisp code. Mocha Eval executes these files of Lisp code to produce a list of commands for the Mocha Assem module. This module takes the commands and produces mask layout using pairwise assembly operators. Lisp is used for Mocha Eval, while C is used for Mocha Draw and Mocha Assem. Mocha Lisp provides an RPC-like interface between the two languages. The entire system is integrated with the Magic IC layout system.

#### 4.7. REFERENCES

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## PAIRWISE ASSEMBLY

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### 5.1. INTRODUCTION

Mocha Chip assembles layout using a pairwise assembly operator, which takes two pieces of mask layout and combines them to produce a third piece. This paradigm allows for different pairing operators. Currently two such operators exist: the tile packing operator and the river-route-space operator.

The tile packing operator joins pieces of mask geometry by abutting their user-specified packing rectangles. This operator is quick and simple, but provides little in the way of automatic assembly. The user has complete responsibility for ensuring that

the packing of the rectangles will result in a correct layout. This operator is similar to many current tile-based layout systems.

The river-route-space operator provides more in the way of automatic assistance. It combines two pieces of geometry, making sure that the terminals on the pieces are connected even if they don't line up properly. The operator also ensures that design rules are met. Thus, the combination is correct-by-construction, as far as connectivity and design rules are concerned. In the simple case of straight-across routing, the river-route-space operator produces layout similar in density to the tile-packing operator.

Future operators can provide more automatic assembly. Such operators might provide more powerful routing capabilities, or other functions such as pitch-matching.

The use of a pairwise assembly operator specified in the graphical diagram gives the user a range of control over the layout assembly process. Using the tile packing operator gives the user complete control, while use of a more powerful operator provides greater automation.

The following sections describe Mocha Chip's operators in more detail. Each operator implements a horizontal pairing. Vertical pairings are handled by rotating the cells before being given to the operator, and then rotating the result back to the original orientation.

## 5.2. THE TILE PACKING OPERATOR

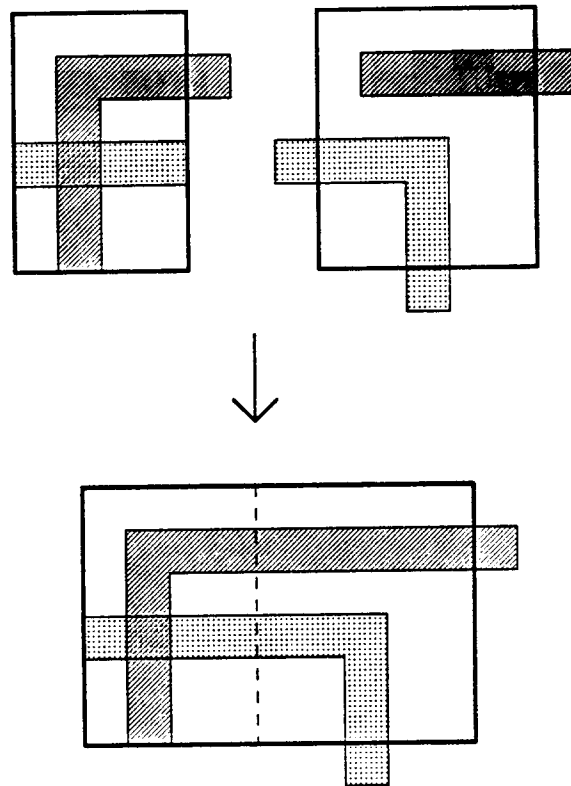


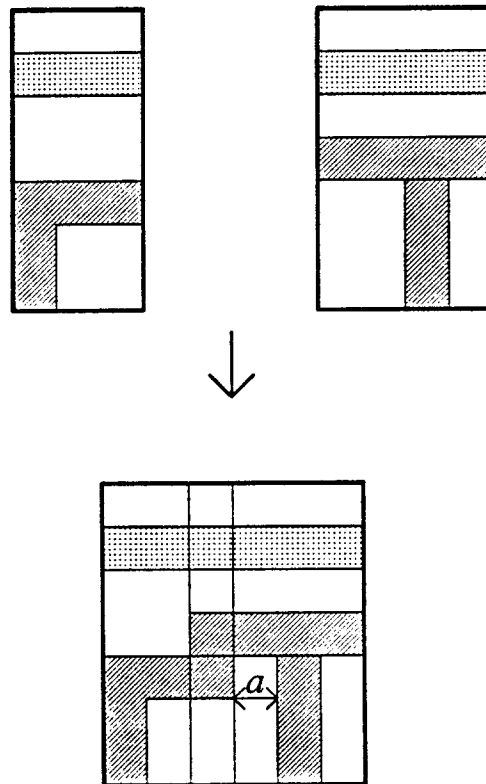
Figure 5.1. The tile packing operator abuts the packing rectangles of two pieces of geometry and produces a third, larger piece. The packing rectangle of the new piece is the union of the original packing rectangles. No design rules are checked, and no attempt is made to ensure proper connections.

The tile packing operator joins pieces of mask geometry by abutting their user-specified packing rectangles (Figure 5.1). The abutting sides of the packing rectangles must be of the same length, to ensure that their union is a rectangle. This new rectangle forms the packing rectangle for the new piece of layout. An error is reported if the packing rectangles do not abut properly.

This operator requires the designer to ensure that the resulting layout is correct. As such, it allows complete flexibility at the expense of automatic correctness by

construction.

### 5.3. THE RIVER-ROUTE-SPACE OPERATOR



**Figure 5.2.** The river-route-space operator joins two pieces of geometry together, ensuring that connections are made and that no design rules are violated. Overlapping is used if it makes the proper connections. In this figure, the letter *a* marks a separation that must be maintained, limiting the amount of overlap. In many cases, the river-route-space operator uses no more area than the packing operator.

The river-route-space operator also joins two pieces of geometry to produce a third. However, it guarantees that no design rules are violated and that the proper connections are made (Figure 5.2). It tries to conserve area, so that in cases where overlap or abutment suffices the result will be the same as that produced by the packing rectangle operator.

The interconnection scheme uses a river router followed by a compaction step. The two sides to be connected must have the same number of terminals, and each pair of terminals must be on a single layer. The river router connects these pairs of terminals together using a wide spacing for the cells. After the river-routing phase, a compactor eliminates excess space. The cells will be overlapped if design rules allow. It is possible that some of the connections will be made by overlap, in which case part of the routing is eliminated.

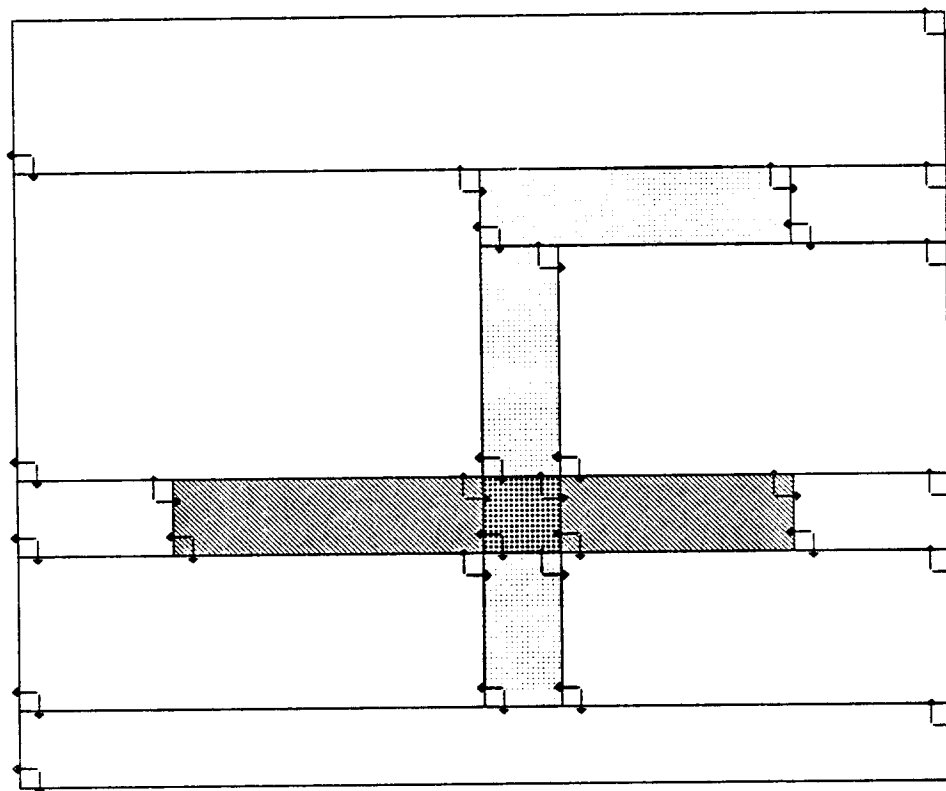
Currently, the river-route-space operator aligns the two pieces of geometry by their midpoints before doing routing. This may lead to unnecessary jogs, which could be eliminated by a different positioning. This problem has been studied by Ron Pinter[1], and his work presents alternative alignment schemes.

The next four sections describe the implementation of the river-route-space operator. Section 5.4 presents Magic's design rules, which are used for the router and spacer. A data structure called *blockage planes* is presented in this section. This data structure is used by the river-routing algorithm, presented in Section 5.5, and the spacer, presented in Section 5.6.

## 5.4. MAGIC'S DESIGN RULES

Magic stores layout for a cell in a set of *planes*, and Magic's design rules are designed to be applied to each of these planes[2]. An example of a plane is shown in Figure 5.3. Each plane stores interacting types of material. The figure shows a plane from the CMOS technology, containing polysilicon and ndiffusion. A different type of



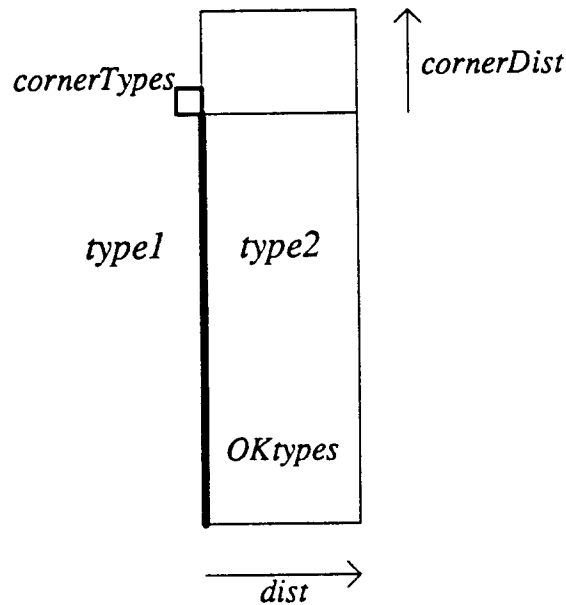


**Figure 5.3.** Magic stores related material in a *plane*, with overlapping layers being represented by a new type of material. This example, from the CMOS technology, shows ndiffusion and polysilicon. The overlap region is represented by material of type nfet. Each region is broken down into rectangles that are linked together at their corners by pointers. A cell consists of several of these planes, one for each set of related material.

material, called nfet, is used to represent the overlap region. Additional planes are used for other sets of material that do not interact with material on this plane. In CMOS there are two more such planes: one for the first layer of metal and one for the second layer.

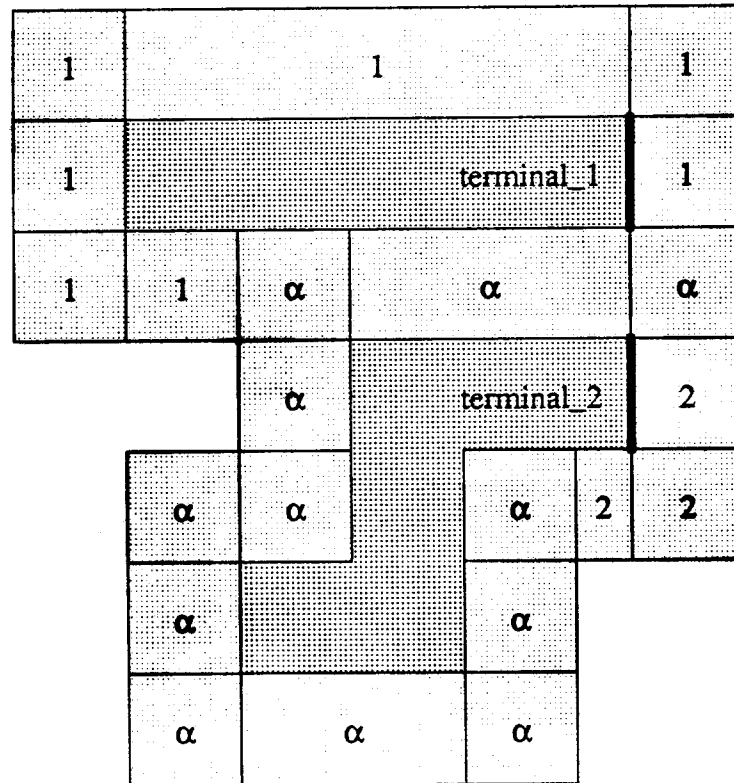
The corner-stitching data structure[3] is used to store the material in each plane. In corner-stitching, each region of material is broken into a set of nonoverlapping rectangles. The empty regions between material are also broken into a set of rectangles. Pointers at the corners of the rectangles link them together, allowing efficient searches

and updates. Magic traverses this structure, using the edges between different rectangles of material to trigger design rules that need to be checked.



**Figure 5.4.** Magic's design rules are triggered by edges in the layout, creating constraint regions that are checked for the presence of invalid material. In this figure, the rule is triggered by an edge between *type1* and *type2*. A region to the right of the edge, of width *dist*, is checked to make sure that it only contains the material listed in *OKtypes*. The region is extended upwards by the amount *cornerDist* if material *cornerTypes* appears immediately to the upper left of the edge.

Figure 5.4 shows the format of a design rule. A rule is triggered by an edge between two different types of material, labeled *type1* and *type2* in the figure. A region of width *width* to the right of the edge is checked for the presence of layers not in *OKtypes* that are in a specified plane *plane*. Any such material constitutes a design-rule violation. In addition, if the area above and just to the left of the edge contains material in *cornerTypes*, then a square region above and to the right of the edge is checked for layers not in *OKtypes*. The width of this region is *cornerDist*.



**Figure 5.5.** Blockage planes specify the legal regions for new material. In this figure, the dark shaded regions are existing material, the light shaded regions are areas where new material is disallowed, and the empty regions are areas where new material is allowed. The regions are generated by applying each of Magic's design rules and recording the constraint regions in a corner-stitched plane.

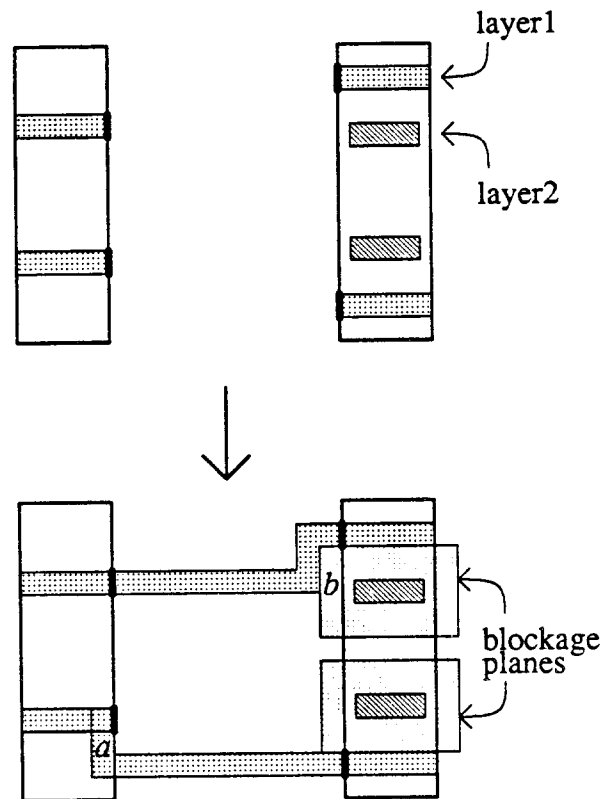
Terminals are handled specially: each pair of terminals to be connected is assigned a number. This number is also assigned to all constraint regions generated by edges of the largest rectangle that contains the terminal. Constraint regions that overlap are tagged with a special number,  $\alpha$ , indicating that they were generated by multiple terminals. Regions generated by edges that are not part of a terminal are also tagged with this special number. This tagging scheme facilitates routing to terminals.

Mocha Chip uses the design rules to compute *blockage planes*, which record regions where material is disallowed. There is one blockage plane for each type of material in the technology. Regions in the blockage planes are created by applying Magic's design rules to the material, recording the constraint regions generated. Figure 5.5 shows one blockage plane generated by two pieces of material. If the corner-

check is not triggered there are two possible ways to handle the corner region: we can either record blockage information that will prevent the corner-check from being triggered by the addition of new material later, or we can record blockage information that prevents the addition of new material in the untriggered corner region so that the rule is obeyed even if the corner-check is triggered at some future time. Mocha Chip uses the latter scheme, since experiments with several design rules indicated that the approach gave good results.

Regions in the blockage planes are tagged to indicate how they were generated, in order to facilitate routing to terminals. Each pair of terminals to be connected by the river router is assigned a unique number. For the purposes of blockage planes, a terminal is considered to be the largest rectangle that includes the label that names the terminal. Each constraint region generated by an edge of a terminal is tagged with the terminal's number. When regions from different terminals overlap, the overlap region is tagged with a special number,  $\alpha$ , to indicate that the area was generated from multiple terminals. Constraint regions from non-terminal edges are also tagged with  $\alpha$ . New material will never be allowed in these specially-tagged regions. Regions tagged with a terminal number will accept material only if it connects to the corresponding terminal. Material may be freely placed in the open areas between constraint regions, as long as the material does not create any design rule violations with recently-placed material.

## 5.5. RIVER ROUTER



**Figure 5.6.** The river router connects pairs of terminals, indicated in this figure by thick lines, using simple three-segment wires. Connections may be made to the terminal anywhere along the rectangle of material that encloses the terminal. The router starts with the bottom pair, working upwards connecting one pair at a time. Blockage planes are used to determine how close jogs can be to terminals. The lightly shaded areas in this figure show the blockage planes for layer1 that were generated from the material on layer2. At the point labeled *a*, the blockage planes showed that the jog could overlap the cell. At point *b*, however, the blockage planes showed that a separation was required in order to avoid conflicts with material within the right hand cell.

The river-route-space operator uses a simple river-routing algorithm (Figure 5.6).

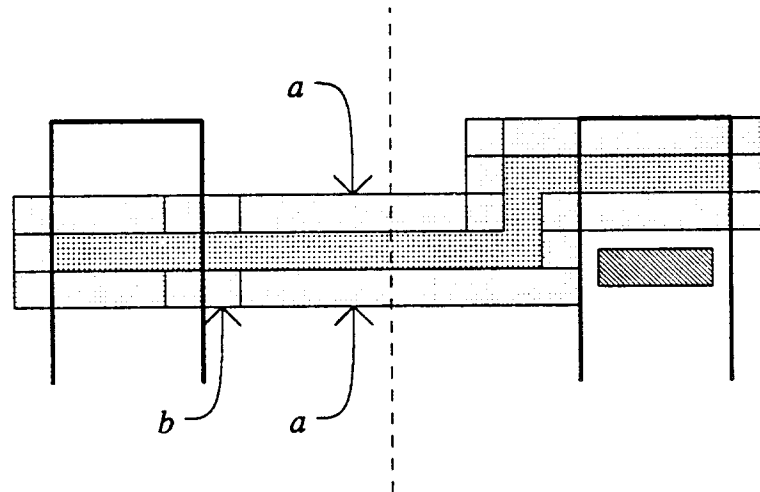
The router places the cells a large distance apart and then connects the bottom terminals on each cell. This connection is made by running a wire from the lowest terminal to the other side of the channel, jogging to the level of the second terminal, and then running directly to the terminal. This results in a wire consisting of at most three

segments. The blockage planes are incrementally updated after each segment, so that later routing will take them into account. The position of the jog is placed as close to the second terminal as possible, using the blockage planes to determine where material can be legally placed. The jog will be allowed to overlap the terminal to save space if the blockage planes allow it. After the bottom terminals are connected, the next higher pair of terminals are connected in a similar manner. The process is repeated until all the terminals are routed. An error is reported if there are unconnected terminals left over on one side.

## 5.6. SPACER

The second phase of the river-route-space operator uses a spacing algorithm to squeeze out excess space caused by the initially large cell separation. By looking at the blockage planes, which are derived from the layout and design rules, Mocha Chip can determine the amount of excess space in the center of the cell. This space is eliminated, resulting in a compact join. It is possible that the design rules will even allow the cells to overlap.

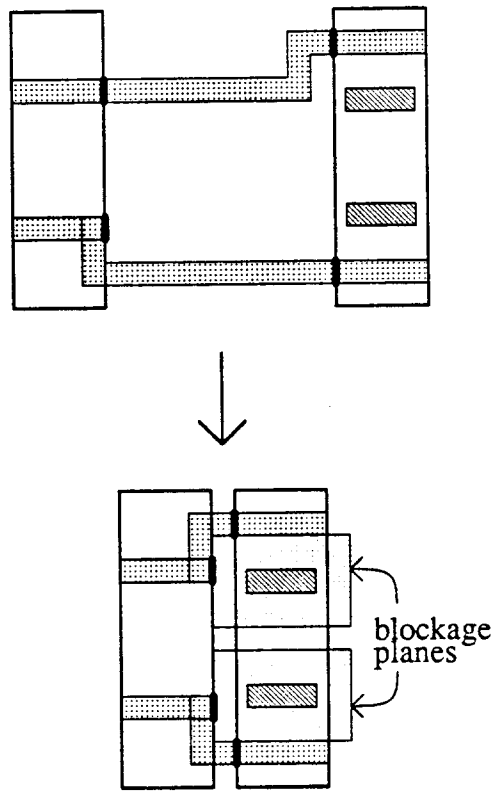
Blockage planes have an added feature that aids the spacer: certain areas are tagged as compressible. This is done as follows. The system places a vertical line in the middle of the routing region, and all constraint regions generated from horizontal edges that cross the line are tagged as compressible (Figure 5.7). If a compressible region and a non-compressible region overlap, the intersection is tagged as being non-compressible. Edges that cross the vertical line are potential candidates for



**Figure 5.7.** The lightly shaded areas represent the blockage planes produced from the material that consists of the two routing terminals and the wire between them. One segment of the wire crosses the dashed vertical line, so the constraint regions generated from it are marked as compressible (marked *a*). The regions generated by the rest of the wire and by the terminals are marked as incompressible. When these regions overlap the compressible areas (point *b*, for example), the overlap region is also marked as incompressible.

compression during the spacing phase. As a result, constraint regions generated from these edges may also be compressed, since they are generated from compressible material. Design rule interactions with the side of the area limit the amount of compressibility, so regions are tagged as non-compressible when they overlap regions generated from edges at the sides.

The spacer operates by examining the layout on one side of the channel and the non-compressible blockages on the other side (Figure 5.8). For each edge of layout, the blockage planes on the opposite side are examined to find the maximum distance the edge can move without encountering a blocked region. Blockage regions marked as compressible are ignored. The maximum movement distance is computed for all edges on each side of the channel, and the minimum of these gives the excess



**Figure 5.8.** The river router produces a correct layout, but leaves a large gap in the middle of the routing region. The spacer reduces the area of this region by using the blockage planes to determine how much excess space is in the region. This figure shows the routing region being compressed until the blockage planes touch material from the opposite side.

separation.

Once the excess separation is known, Mocha Chip uses a cookie-cut approach to eliminate the space. Each piece of material that crosses the center of the channel is found. For each piece, a chunk of material the width of the excess separation is removed. After this is done for each piece, all the material to the right of the center is moved left by the excess separation distance. The result is a compacted piece of layout that obeys geometrical design rules.



## 5.7. CONCLUSIONS

Mocha Chip uses a pairwise assembly operator to create layout. This operator joins two pieces of geometry together to form a third, larger, piece. Two such operators are incorporated in the system.

The operators give the user a range of control over the assembly process. The packing rectangle operator gives the user complete control, but provides no assurance of correctness. The river-route-space operator assures correctness by river-routing and spacing, generating and spacing layout automatically.

The river-route-space operator is able to guarantee design rule correctness, without wasting much area. The algorithm places the cells a large distance apart, routes them, and then compacts the result. By using this process, the river-route-space operator is able to produce compact connections, even overlapping cells if geometrical design rules allow.

## 5.8. REFERENCES

1. R. Y. Pinter, The Impact of Layer Assignment Methods on Layout Algorithms for Integrated Circuits, VLSI MEMO 82-130, Massachusetts Institute of Technology, December 1982.
2. G. S. Taylor and J. K. Ousterhout, Magic's Incremental Design Rule Checker, *Proceedings of the 21st Design Automation Conference*, 1984.

3. J. K. Ousterhout, Corner Stitching: A Data-Structuring Technique for VLSI Layout Tools, *IEEE Transactions on Computer-Aided Design CAD-3*, 1 (January, 1984).



## AN EXAMPLE PLA GENERATOR

---

### 6.1. INTRODUCTION

An example module generator has been built with Mocha Chip, in order to evaluate the system and to prove that it is useful for actual applications. This chapter describes the generator and compares it with a traditional generator that performs the identical function. The generators produce PLAs, which implement combinational logic in a two-level AND-OR configuration. The operation of the Mocha Chip generator, called MCPLA[1], is explained by presenting each of its parts and working through the operation of some representative pieces. The other PLA generator, called

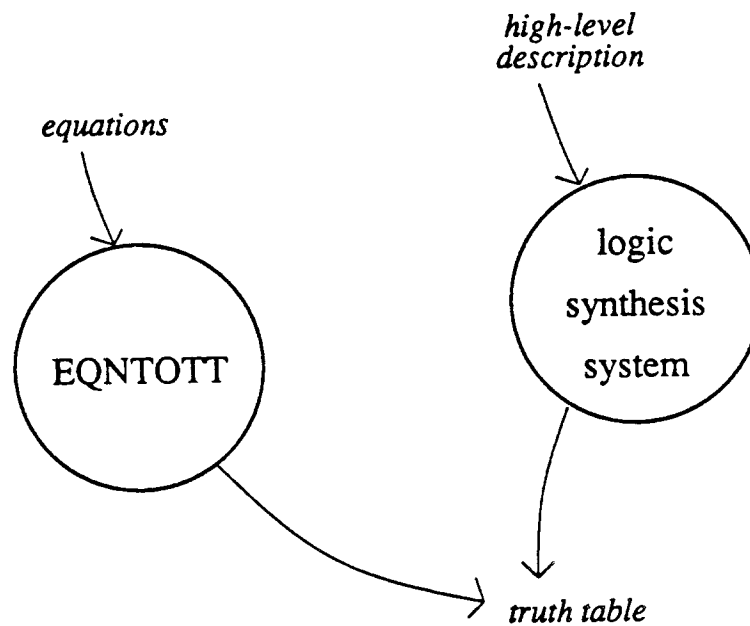


Figure 6.1. Truth tables are often created as the output of other tools. A truth table may be implemented via a two-level AND-OR circuit such as a PLA.

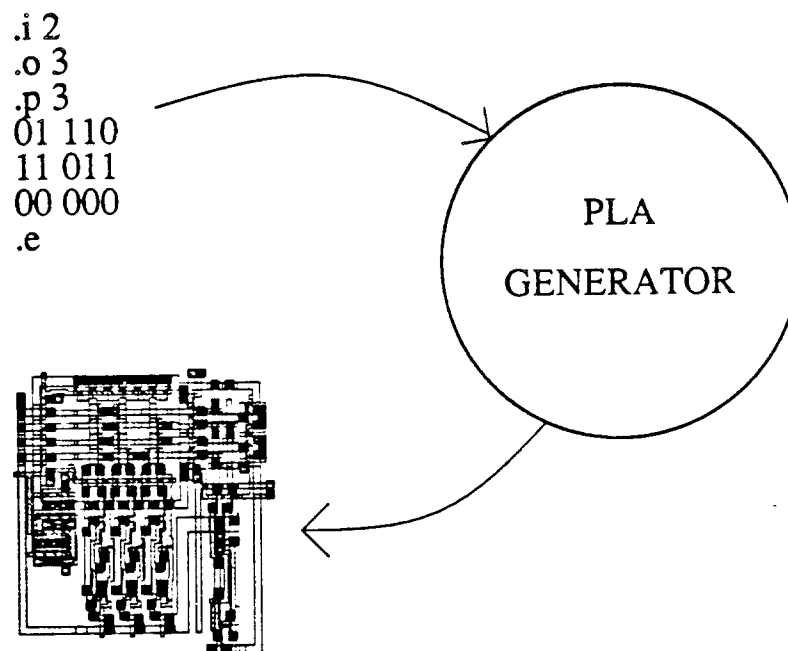
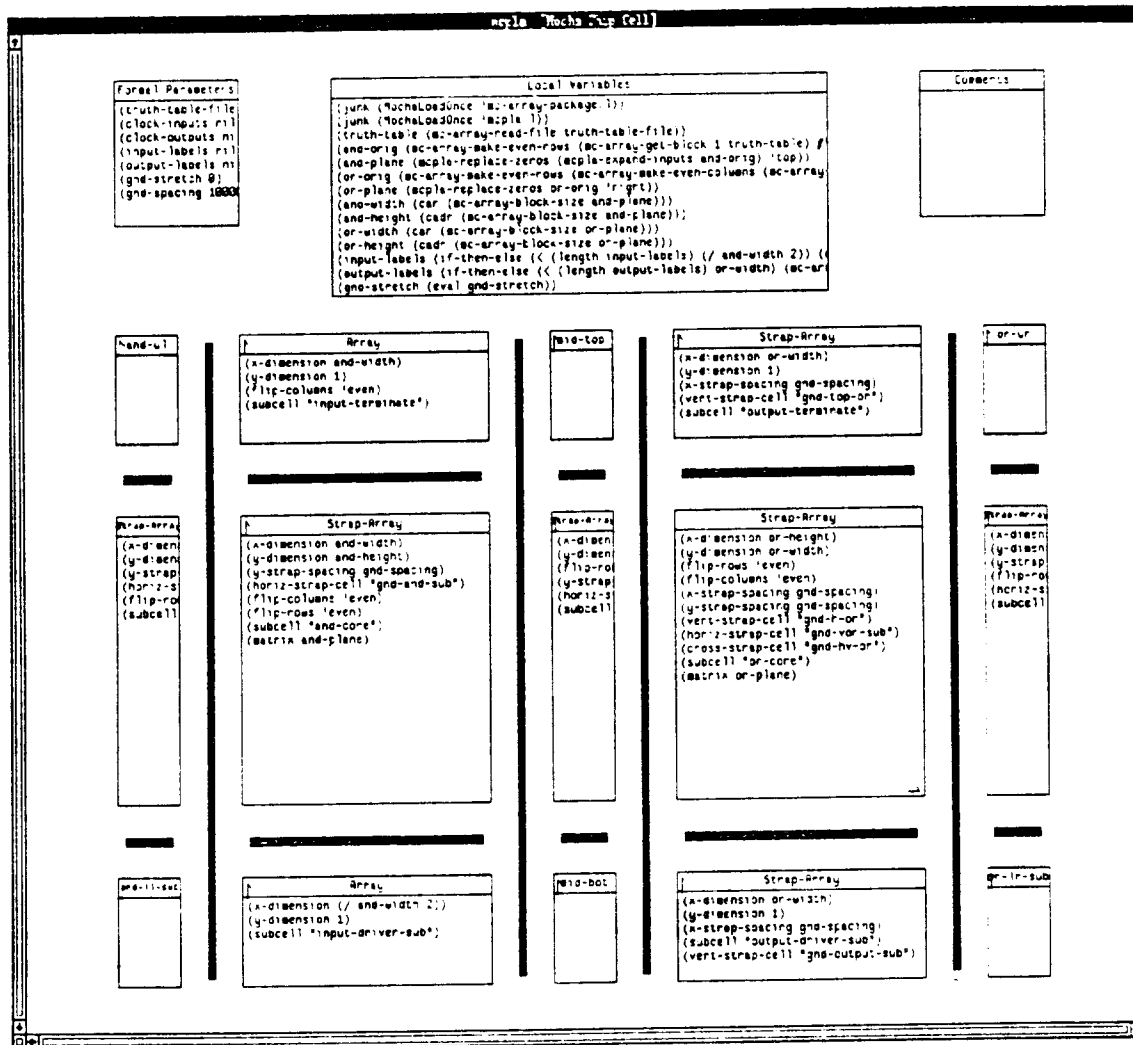


Figure 6.2. A PLA generator takes a truth table and produces layout that implements it via a two-level AND-OR structure. The truth table contains two arrays of ones, zeros, and don't-cares. In addition, the table contains lines that specify the number of inputs, outputs, and product terms.

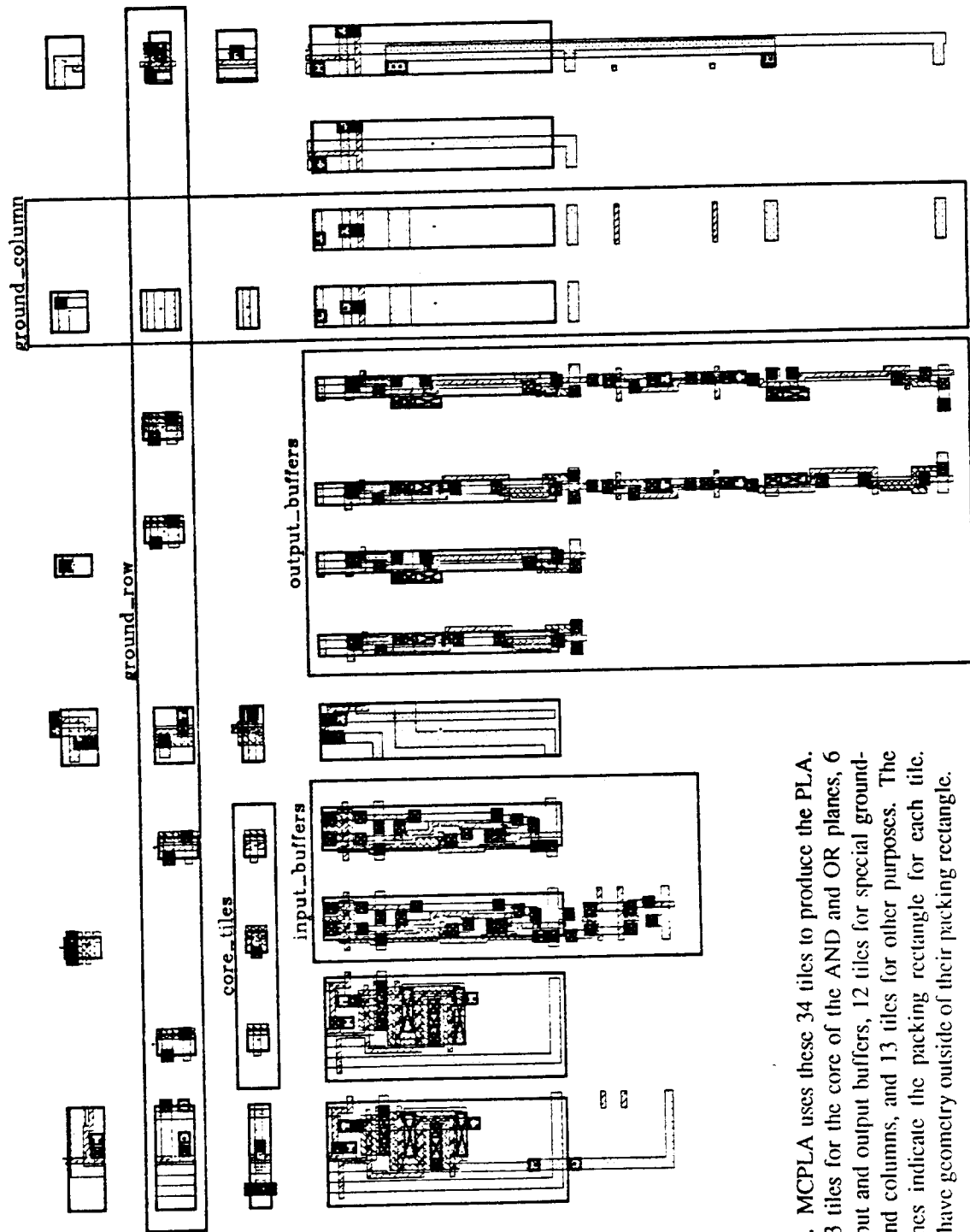
MPLA[2] (a derivative of TPLA[3]), is a tile-based generator written in the C programming language.

PLA generators start with a logic description, expressed as a modified truth-table, and produce layout that implements the logic. The truth-table is usually produced as the output of another program, such as the equation-to-truth-table converter EQNTOTT or a logic synthesis system (Figure 6.1). The task of the PLA generator is to take the truth-table description and produce layout (Figure 6.2). MCPLA and MPLA are PLA generators.

For PLAs, the logic description is in sum-of-products form (OR of ANDs), represented as a truth-table containing zeros, ones, or don't-cares. The table in Figure 6.1 shows the logic description represented as two arrays. The left array is called the AND plane, and implements the AND part of the equations to produce a set of terms. These terms are then OR'ed together according to the right array, called the OR plane. For the table in the figure, there are two input columns to the AND plane and three output columns from the OR plane. The first row specifies one term in the equations to be implemented. In particular, this row contains "01 110". The AND part of this means that we are AND'ing the complement ("0") of the first input with the true form of the second input ("1") to produce the term represented by this row. The second part of the line ("110") lists the outputs that are affected by this term. For this example, the first and second outputs contain this term as one of the terms that are OR'ed together to produce the output. As an example, the second output is the OR of the term represented by the first row with the term represented by the second row.



**Figure 6.3.** This is the main diagram of MCPLA. It declares the parameters, invokes some code, and gives the overall topological organization for the PLA. The diagram consists mainly of several arrays. Most of them invoke subdiagrams that determine which tiles are used to implement the truth table. The variables block invokes code that parses the truth table and prepares the two truth table arrays for the subdiagrams.



**Figure 6.4.** MCPLA uses these 34 tiles to produce the PLA. There are 3 tiles for the core of the AND and OR planes, 6 tiles for input and output buffers, 12 tiles for special grounding rows and columns, and 13 tiles for other purposes. The thick outlines indicate the packing rectangle for each tile. Many tiles have geometry outside of their packing rectangle.

## 6.2. COMPONENTS OF MCPLA

|                         |                          |                            |
|-------------------------|--------------------------|----------------------------|
| mc-array-allegal        | mc-array-block-size      | mc-array-extend-block      |
| mc-array-extra-props    | mc-array-get-block       | mc-array-get-block-element |
| mc-array-get-prop       | mc-array-getline         | mc-array-make-even-columns |
| mc-array-make-even-rows | mc-array-make-label-list | mc-array-prop-exists       |
| mc-array-put-prop       | mc-array-read-file       | mc-array-unique            |
| mcpla-expand-inputs     | mcpla-expandrow          | mcpla-replace-zeros        |
| mcpla-report-props      | mcpla-trim-right         | mcpla-trim-top             |

**Figure 6.5.** These Lisp procedures are used by MCPLA to parse the input file and do simple manipulations of the truth table. The procedures in the upper section of the figure are general-purpose and may be used by other generators, while those in the lower half are specific to MCPLA. The total number of lines of code comes to 195: 143 in the top section and 52 in the bottom section. Lines consisting solely of comments and non-alphanumeric characters are not counted. This code is discussed in greater detail in Section 6.3.

MCPLA consists of several Mocha Chip diagrams, tiles of mask geometry, and some Lisp code. Figures 6.3 through 6.5 show these parts. The top-level diagram (Figure 6.3) defines the overall structure of the modules generated. Several subdiagrams select tiles for each position in the arrays.

The tiles of mask geometry are shown in Figure 6.4. These tiles were manually designed using the Magic[4] layout editor. Some of them, such as the output drivers, are complex hand-crafted cells. Others, such as the core cells for the AND and OR planes, are very simple. Many of the tiles have parameterized power and ground lines, to allow additional current capacity. The input and output drivers have parameterized labels that are used to assign names to the input and output pins.

Figure 6.5 lists the Lisp procedures that are used by MCPLA. Many of these are general-purpose, but some are specific to MCPLA. The code totals 195 lines, and is discussed more fully in Section 6.3.



|   |                     |
|---|---------------------|
| 1 | (truth-table-file)  |
| 2 | (clock-inputs nil)  |
| 3 | (clock-outputs nil) |
| 4 | (input-labels nil)  |
| 5 | (output-labels nil) |
| 6 | (gnd-stretch 0)     |
| 7 | (gnd-spacing 10000) |

**Figure 6.6.** The lines found in MCPLA's parameters block. Default values are given for most parameters. There is no default value for the truth-table file.

### 6.3. HOW MCPLA WORKS

The parameter block declares the parameters used by MCPLA (Figure 6.6). The *truth-table-file* parameter is the most important — it names a file that contains the truth table to be implemented by this PLA. The other parameters specify options for the pla. *Clock-inputs*, if true, adds dynamic latches to the input lines. *Clock-outputs* performs a similar function for the outputs. The size of the power and ground busses is controlled by *gnd-stretch*, which is a Lisp expression representing a function to compute the additional size needed, in lambda. The size of the busses is a function of the peak current required by the PLA, which is in turn a function of its size. Because of this requirement, the Lisp function is evaluated in the variables block after the truth table is read in, so that the function may make use of computed quantities such as the number of inputs and outputs. *Input-labels* and *output-labels* are lists of labels for the input and output pins. If no labels are supplied, MCPLA will generate unique identifiers. Having these pins labeled can aid in simulation, circuit extraction, and routing. The *gnd-spacing* parameter controls how many rows or columns can be placed before a special ground row or column is placed. The extra rows and columns supply additional

current and, in CMOS, well contacts for the AND and OR planes of the PLA. *Gnd-spacing* has a large number as its default value, so that no special rows and columns are used in the default case.

```

1  (junk (MochaLoadOnce 'mc-array-package.l))
2  (junk (MochaLoadOnce 'mcpla.l))
3  (truth-table (mc-array-read-file truth-table-file))
4  (and-orig (mc-array-make-even-rows (mc-array-get-block 1 truth-table) #\~))
5  (and-plane (mcpla-replace-zeros (mcpla-expand-inputs and-orig) 'top))
6  (or-orig (mc-array-make-even-rows (mc-array-make-even-columns
   (mc-array-get-block 2 truth-table) #\~) #\~))
7  (or-plane (mcpla-replace-zeros or-orig 'right))
8  (and-width (car (mc-array-block-size and-plane)))
9  (and-height (cadr (mc-array-block-size and-plane)))
10 (or-width (car (mc-array-block-size or-plane)))
11 (or-height (cadr (mc-array-block-size or-plane)))
12 (input-labels (if-then-else (< (length input-labels) (/ and-width 2))
   (mc-array-make-label-list "input_" 1 (/ and-width 2)) input-labels))
13 (output-labels (if-then-else (< (length output-labels) or-width)
   (mc-array-make-label-list "output_" 1 and-width) output-labels))
14 (gnd-stretch (eval gnd-stretch))

```

**Figure 6.7.** This code is contained in MCPLA's variables block. The code loads utility functions, parses the truth table, and performs simple manipulations of the truth table. Each line consists of a variable-expression pair. The lines are executed sequentially, binding the variable to the expression's value. The code invoked by this block is discussed later.

The variables block (Figure 6.7) is executed, preparing data for the subcells in the MCPLA diagram. The first two lines load in utility functions, ignoring the return result by assigning it to the variable *junk*. The file *mc-array-package.l* contains functions of a general-purpose nature, while the file *mcpla.l* contains functions of a PLA-specific nature. Figure 6.5 lists these functions.

The third line reads in the truth table and parses it into an internal format, which is stored in the variable *truth-table*. This internal format contains two blocks which

represent the AND and the OR planes of the PLA.

Three simple manipulations of the AND truth table are performed in lines 4 and 5. First, the AND plane is fetched from the internal format, and forced to have an even number of rows, adding a row of dashes if needed (line 4). PLAs with an even number of rows are simpler to design. Line 5 takes this table and expands the input columns. Each input column corresponds to two columns of mask layout, one for the uncomplemented variable and one for its complement. Each truth table bit is expanded according to the following rules:

|   |   |    |
|---|---|----|
| - | → | 00 |
| 0 | → | 01 |
| 1 | → | 10 |

This transformed table directly corresponds to the layout to be generated. A 1 corresponds to a transistor, while a 0 corresponds to no transistor. In order to improve the performance of the PLA, it is desirable to run the input signals up through the array only as far as the last place they are used. The *mcpla-replace-zeros* procedure starts at the top of a table and changes zeros, representing no transistor but rather an extension of the input signal, to dashes, representing no transistor and no extension. This process stops when a one, representing a transistor, is found in a column. Here is an example transformation:

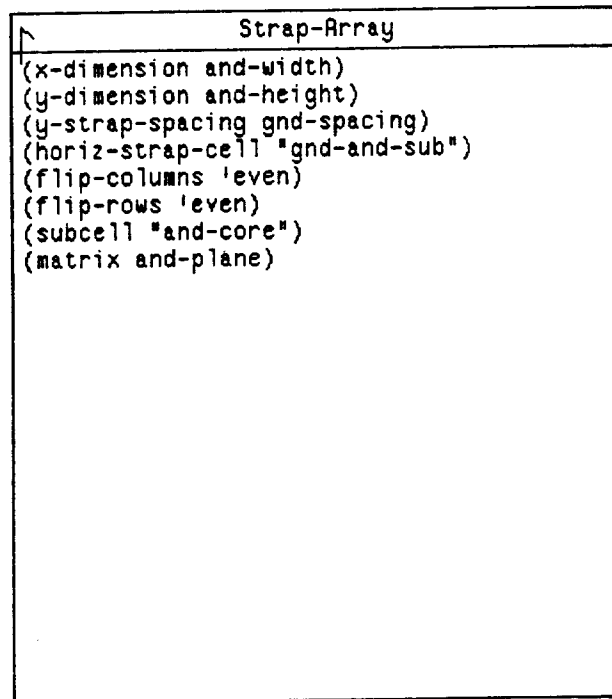
|      |   |      |
|------|---|------|
| 0010 |   | --1- |
| 0100 | → | -10- |
| 1011 |   | 1011 |
| 0010 |   | 0010 |

Similar transformations occur with the OR plane. The OR plane is forced to have an even number of rows and columns, to simplify layout. The zero-trimming function is then invoked in a manner similar to the AND plane, except that trimming starts from the right and works left. In the OR plane, product terms (the result of ANDing in the AND plane) enter from the left.

The rest of the lines set up simple variables. Lines 8 through 11 simply count the number of rows and columns in the AND and OR planes. Lines 12 and 13 prepare default labels for the inputs and outputs if they weren't specified by the user. Line 14 evaluates the ground-stretching expression to determine the amount of stretching needed for this particular PLA. This expression is free to reference the previous variables, such as `and-height`.

The comments block is not used in MCPLA. The comments block can contain expressions which are evaluated after the variables block and then attached to the corresponding Magic cell. This is used mostly for debugging purposes, but could be used, for example, to attach the truth table to the Magic cell that is generated.

The AND plane and the input drivers will be used as examples to demonstrate Mocha Chip's features in detail. The AND plane block (Figure 6.8), the large block on the left in Figure 6.3, represents an array of tiles. Each tile is selected according to the truth table bit that corresponds to its position (Figure 6.10). In addition to the tiles that implement the truth table, horizontal rows of ground wires are added every few rows. This ensures that ground is adequately distributed and, in CMOS, that the wells are properly grounded.



**Figure 6.8.** The details of the AND plane block from the left side of Figure 6.3. This block creates an array of transistors for the AND plane of the PLA. The *Strap-Array* construct is used to put in extra grounding rows.

The occasional ground rows are implemented by using the *Strap-Array* Mocha Chip cell, a user-defined cell whose implementation is shown in Figure 6.9. The cell is similar to the *Array* cell, except that it intersperses special rows and columns (Figure 6.10). *Strap-Array* is one example of how extensible Mocha Chip is: it shows how the *Array* and *Case* cells can be combined to form a new control construct. *Strap-Array* uses the built-in *Array* cell as the basic building block, but creates an array that is large enough to contain the additional rows and columns. The subcell invoked, *Strap-Array-Sub*, selects between a normal cell or ones that implement the extra rows and columns. The *x-index* and *y-index* parameters are adjusted for the subcell so that it appears as if it was called from a normal *Array*.

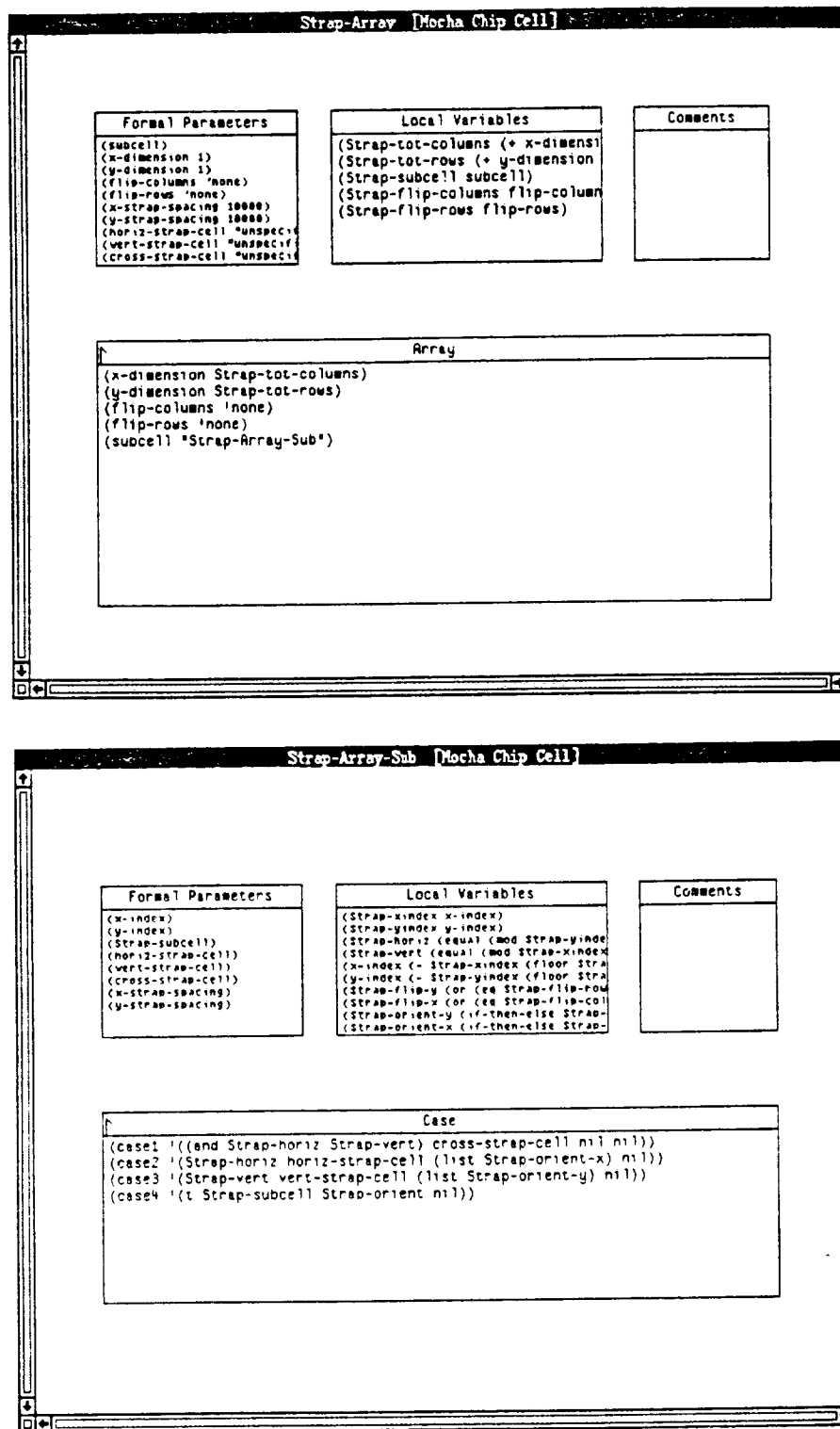
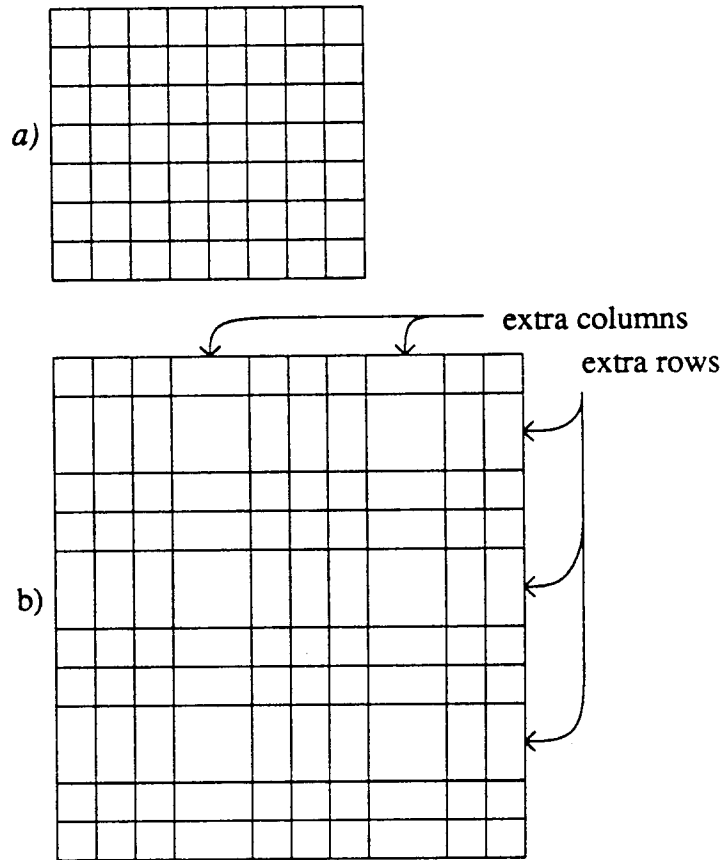


Figure 6.9. The Strap-Array and Strap-Array-Sub diagrams. These diagrams implement an array construct with interspersed ground rows and columns.



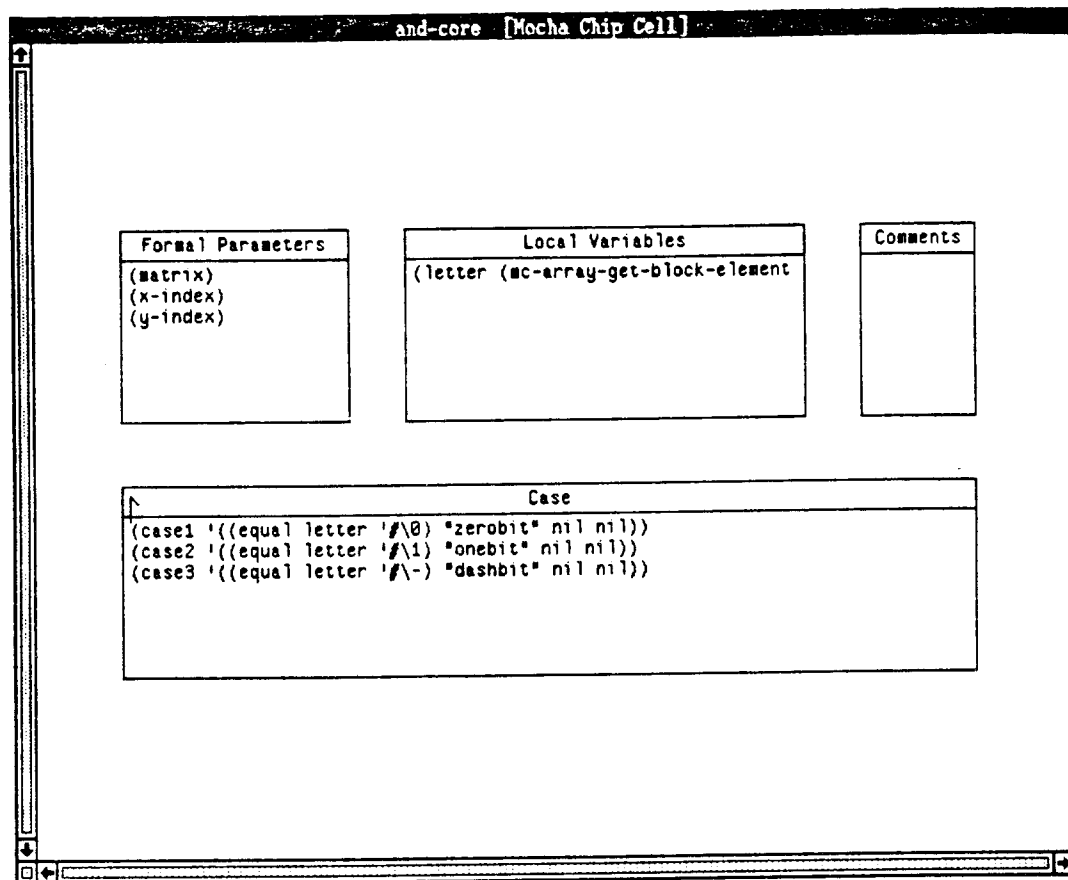
**Figure 6.10.** Strap array produces arrays just like those produced by the built-in array operator (part *a*), but with extra rows interspersed (part *b*). The array in part *b* was produced with “y-strap-spacing” set to 3 and “x-strap-spacing” set to 4. This results in an array with every 3rd row being an extra row, and every 4th column being an extra column.

In the case of the AND plane, the subcell to Strap-Array is *and-core* (Figure 6.11). This cell looks up the current truth-table bit via this line in the variables block:

```
(letter (mc-array-get-block-element x-index y-index matrix))
```

Using the variable *letter*, the Case cell chooses among alternative tiles:

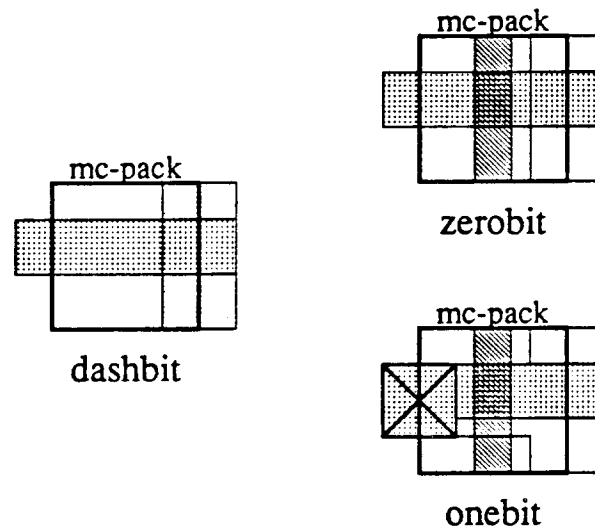
```
(case1 '((equal letter '#\0) "zerobit" nil nil))
(case2 '((equal letter '#\1) "onebit" nil nil))
(case3 '((equal letter '#\-) "dashbit" nil nil))
```



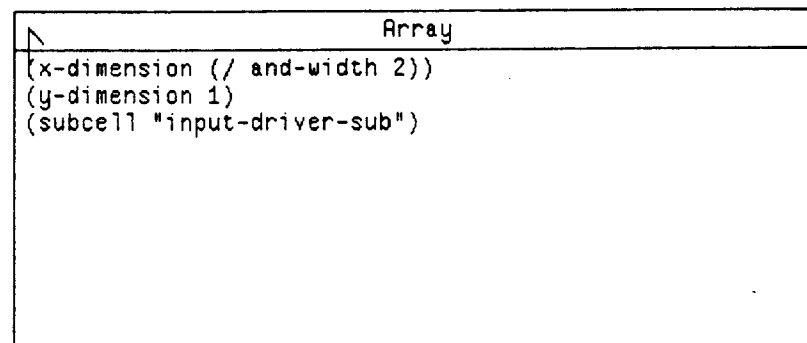
**Figure 6.11.** The diagram **and-core**, which selects a tile based upon the truth-table bit for the position. Another diagram is used in the special ground rows in the AND plane.

These three tiles, *zerobit*, *onebit*, and *dashbit* (Figure 6.12), form the core of the AND plane as well as the core of the OR plane. In the AND plane, alternating columns are flipped sideways so that the tiles may share contacts and ground busses. Each of the tiles has a packing rectangle, indicated by *mc-pack*. It is this rectangle that controls the spacing between tiles. The OR plane is built in the same manner as the AND plane, and then rotated by ninety degrees.

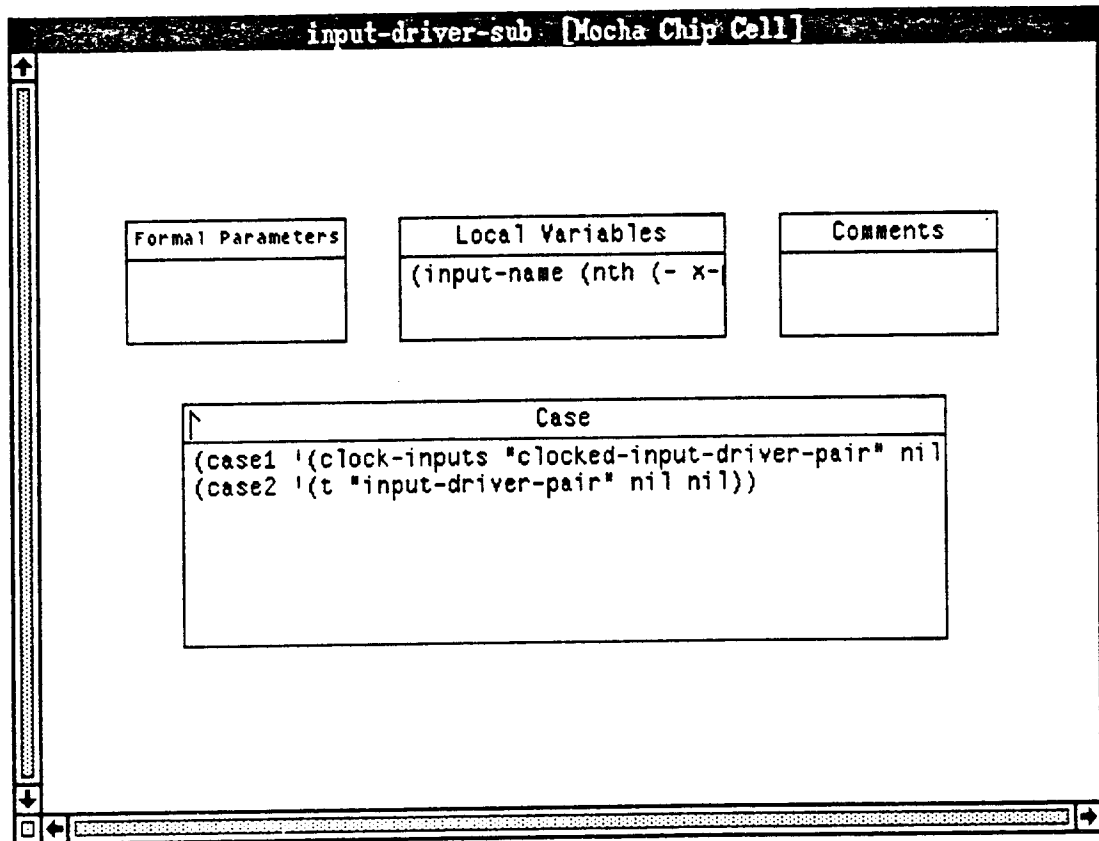




**Figure 6.12.** The tiles **zerobit**, **onebit**, and **dashbit**. These tiles form the core of the AND plane. They are also used, in a rotated orientation, in the OR plane. The **onebit** tile implements a transistor that pulls the product-term line low, while the **zerobit** tile passes the input signal through without a transistor. The **dashbit** tile is used when there is no need to pass the input signal up to later rows in the PLA.

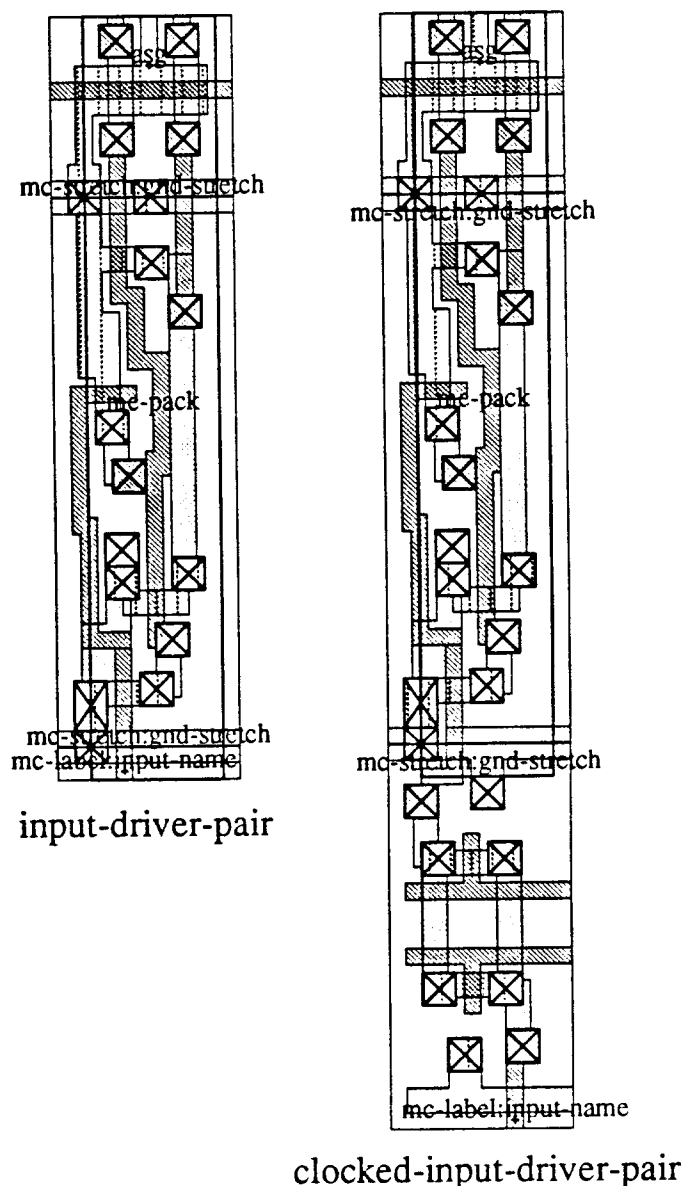


**Figure 6.13.** The **input-array** diagram creates an array half the width of the AND plane. Each input driver drives two columns of the AND plane.



**Figure 6.14.** The `input-driver-sub` diagram chooses between input driver tiles based upon the global parameter `clock-inputs`.

Below the AND plane is an array of input drivers (Figure 6.3 and 6.13). This array is half the width of the AND plane, since each driver drives two columns. The driver is a single circuit that takes one input and produces the true and complement form, each in its own column. At each position in the input driver array, the Mocha Chip cell `input-driver-sub` is invoked. This cell (Figure 6.14) inspects the global parameter `clock-inputs` and chooses one of two tiles: `input-driver-pair` or `clocked-input-driver-pair` (Figure 6.15).



**Figure 6.15.** The two tiles **input-driver-pair** and **clocked-input-driver-pair**. These are hand-crafted cells designed with the Magic layout editor.

The input driver tiles illustrate the use of tile parameters. Each tile has a number of labels of the form *mc-stretch:gnd-stretch*. These indicate that the cell must be stretched at that point by the amount specified in the corresponding variable *gnd-stretch*. In addition, a parameter of the form *mc-label:input-name* appears in each input

driver. This is a parameterized label. The value of *input-name*, declared in *input-driver-sub*, is used as a new label that is substituted for *mc-label:input-name*.

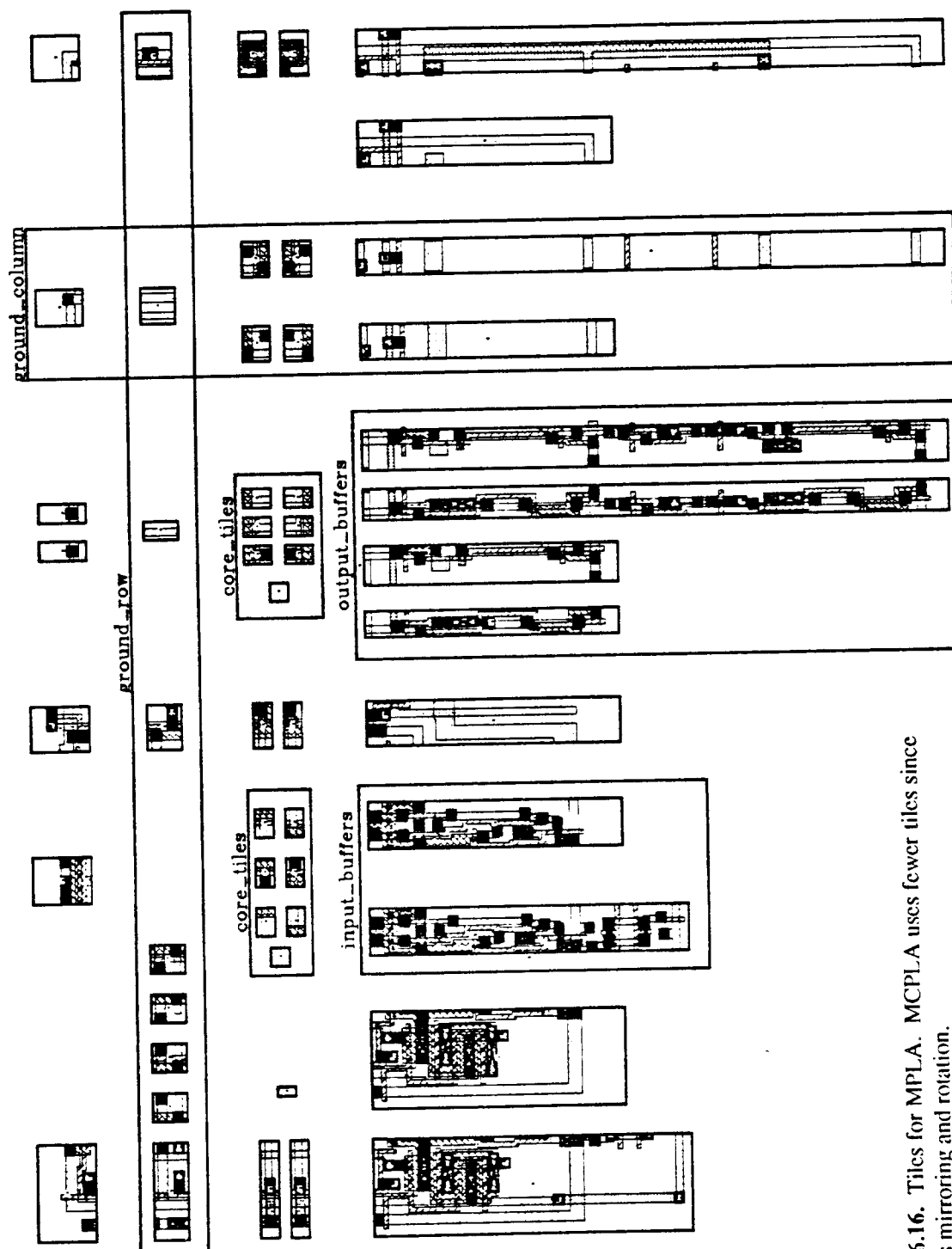
The AND plane and the input drivers give a good overview of how MCPLA is built. The other sections of MCPLA are similar in nature. Most blocks consist of arrays of sub-cells, where the subcells make a selection among several alternative tiles.

#### 6.4. MPLA

MPLA is a C program that was written to produce PLAs, and also goes by the name TPLA. MCPLA is designed to accept exactly the same options and produce the same PLAs as MPLA. The two will be compared with respect to the number of lines of code, number of diagrams drawn, and number of tiles used.

MPLA consists of C code and a set of tiles. The tiles are shown in Figure 6.16. MPLA uses the MPACK library[3] to assemble layout. The library includes procedures for aligning the corners of tiles, in order to pack them together or, with the aid of spacing tiles, to provide overlap (see Section 3.4). The library does not include rotation procedures, so separate tiles are used for the AND and OR planes. In addition to the functions that directly generate layout, MPLA includes procedures to parse the input file and manipulate the truth tables, and overhead functions. These functions are similar to those executed in the variables block of MCPLA.

MPLA generates layout by aligning a corner of a tile with the corner of another tile. In cases where overlap is needed, a special tile called a *space* tile is used for alignment. Figure 6.17 shows some typical lines from MPLA.



**Figure 6.16.** Tiles for MPLA. MCPLA uses fewer tiles since it allows mirroring and rotation.

```

...
if (gndrow)
  cur = paint_element(THGleft_and, THGleft_and, cur);
else if (even)
  cur = paint_element(Tleftd_and, Tleftd_and, cur);
else
  cur = paint_element(Tleftu_and, Tleftu_and, cur);
...
if (above)
  top = TPpaint_tile(Tul_and, Tpla, align(rUR(TPsub_rp(cur, Otop_and)),
    tLR(Tul_and)) );
if (below)
  bot = TPpaint_tile(Tll_and, Tpla, align(rLR(TPadd_rp(cur, Obot_and)),
    tUR(Tll_and)) );
...

```

**Figure 6.17.** Some example code from MPLA. The basic procedure is `TPpaint_tile`, which places a tile. Other procedures, such as `align` and `rUR`, align the corners of tiles to compute the location.

MPLA and MCPLA are two quite different programs, even though they accept the same options. MPLA's support system, MPACK[3], doesn't handle rotations. This results in more tiles being needed. MPACK also handles assembly differently — it aligns the corners of the bounding boxes of tiles, while Mocha Chip packs tiles according to their user-specified packing rectangles.

In order to eliminate these differences, I designed a PLA generator called LPLA. LPLA is a Lisp PLA generator created from MCPLA. It is formed by taking the Lisp code representing each of the diagrams and combining them with the utility code written for MCPLA. The generator performs exactly like MCPLA, but substitutes Lisp code for the diagrams. We can use the number of lines of code in LPLA as compared to MCPLA as one measure of the usefulness of the graphics.

| Comparison of PLA Generators |         |      |           |
|------------------------------|---------|------|-----------|
| Metric                       | MCPLA   | LPLA | MPLA/TPLA |
| Lines of code                | 195/353 | 493  | 856       |
| Number of diagrams           | 12      | 0    | 0         |
| Number of tiles              | 34      | 34   | 54        |
| Execution time               | 876     | 876  | 4         |

**Figure 6.18.** Lines of code are determined by removing comments and then counting the number of lines that contain an alphanumeric character. Two numbers are given for the number of lines of code in MCPLA. The first number counts only the code loaded in from a file, while the second number also counts the lines placed in the diagrams as parameterization. Execution times are for a small PLA with 3 inputs, 4 outputs, and 4 product terms. I expect that MCPLA can be made to run at least 10 times faster.

Figure 6.18 gives some data for the three PLA generators. MCPLA needs less code, although the main benefit is that the graphical representation of the layout is clearer than textual code.

## 6.5. DISCUSSION AND LIMITATIONS

MCPLA uses the tile-packing assembly operator only. The other operator, river-route-space, is not appropriate for this structure since it would compact each row of the PLA independently. If it were used, adjacent rows would not line up, requiring river routing for the connections. The net result would be a much less compact PLA. Adding pitch-matching to the operator would eliminate this problem, and provide an assembly operator that ensured design-rule correctness.

MCPLA is also substantially slower than MPLA. MPLA takes 4 seconds to generate a PLA with 3 inputs, 4 outputs, and 4 product terms. MCPLA takes 14.6 minutes, broken down as follows: 8.2 minutes for Lisp parameter evaluation, 6.1 minutes for traversing the Lisp structure and writing the command file, and 0.3

minutes for assembly of the layout. Since almost all of the time is spent during Lisp evaluation of the diagrams, I expect that execution times could be improved substantially by tuning and compiling the Lisp code before execution. The Lisp code only has to evaluate parameters and communicate the resulting structure to Mocha Assem, so it seems reasonable that a greater than ten times speedup could be had.

A benefit of Mocha Chip is the tile stretching mechanism. In Mocha Chip, tiles may be stretched along lines that have jogs in them. In MPACK, the lines must run straight across. The straight across lines result in wasted area. The PLAs generated by MCPLA are somewhat smaller due to the more flexible stretching mechanism. This is not of fundamental importance, however, because this feature could be added to MPACK also.

MCPLA requires fewer tiles than MPLA due to the use of the mirroring and rotation operator. This makes the module generator design easier.

The most dramatic improvement of MCPLA over MPLA is the representation of the overall topology of the design. In MCPLA, the topology is represented as a diagram; in MPLA it is a section of code. This diagrammatic representation is more visually intuitive and is easier to navigate. For example, a user wanting to modify MCPLA to select among four input drivers would have no trouble finding and modifying the cell responsible for that action, since the topology of the top-level diagram directly corresponds to the user's image of what a PLA looks like. In MPLA, the user would have to read and understand code that had no direct relationship to his visual image.



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## **7** **FUTURE WORK**

9

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### **7.1. INTRODUCTION**

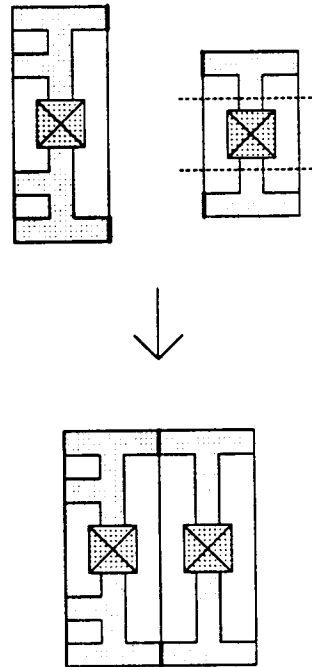
There are three directions for future work on Mocha Chip: usability improvements, improvements in the layout quality, and improvements in the language aspects. The system can be made more usable by allowing generators to be compiled for faster execution. Layout quality could be improved with pitch-matching and general routing techniques. The language aspects of Mocha Chip could be enhanced by more flexible parameter passing mechanisms and parameterized netlists for specifying routing.

## 7.2. GENERATOR COMPILATION

When Mocha Chip executes, most of the time is spent evaluating the Lisp code that forms a module generator. A significant speedup could be obtained by compiling this code. The disadvantage of compilation is that debugging information is lost, so compilation would only be useful for fully-debugged module generators. Implementing compilation would appear at first to be a simple process, since a Mocha Chip generator is just a Lisp program that produces a file of commands for Magic. However, Mocha Chip loads cells, or Lisp procedures, using a search path mechanism. This makes it difficult to determine in advance exactly which cells are part of the module generator. The solution to this problem is to compile a cell dynamically the first time it is used.

## 7.3. PITCH-MATCHING

Pitch-matching refers to the stretching of tiles in order to make their terminals line up more closely. Pitch-matching can save area as compared with river routing. PLAs are an example of this. A good pitch-matcher should be able to produce PLAs that are as compact as those produced with the tile packing operator, but with a guarantee of design rule correctness. Figure 7.1 shows an example of how pitch-matching can be used to connect tiles. Even though pitch-matching is not implemented in the current version of Mocha Chip, many of the details about how it would work have been considered. Chapter 8 discusses these thoughts on pitch-matching.



**Figure 7.1.** Pitch-matching stretches tiles in order to align their terminals. This often uses less area than river-routing, especially for highly regular structures. In this example, the tile on the right needs to be stretched to match the tile on the left. The dashed lines show two possible places for the stretching to occur.

#### 7.4. GENERAL ROUTING

For those structures with less regular wiring patterns, it would be useful to use general routing to connect tiles. Since Mocha Chip joins two tiles at a time, the routing regions form *channels*, which are rectangular regions with the terminals on two opposite sides. Routing of channels is a well-solved problem[1-5], although this situation presents an unusual difference: the interaction of pitch-matching and routing.

Pitch-matching stretches tiles based upon the surrounding tiles. If these surrounding tiles are routed together, the routing determines, in part, the amount of flexibility the pitch-matcher has, since different routings can be stretched in different ways. This means that certain routings could preclude certain forms of stretching. We could

handle this by either not using those routings, or by removing the stretch lines that are in conflict with the routing. Either of these two techniques could result in a loss of area. An alternative scheme would be to use a pitch-matching algorithm that decides on the stretch amounts for all tiles before any routing is done. Since when two pairs of tiles are joined by routing the location of the terminals is not known until the routing is completed, this pitch-matching algorithm would have to predict in advance the location of the terminals. If we use an upper bound on the area required by the routing, we can pitch-match as if exactly that amount of area was required. After this is done, the routing could be generated in the areas left open. Much of this routing would take less area than the maximum allowed, and a compaction step would be needed to remove this excess area.

A major problem with routing in Mocha Chip is the specification of the routing. This is difficult to do, since every cell in Mocha Chip can be parameterized and thus have a variable number of terminals. Parameterized netlists are a solution to this problem.

## 7.5. PARAMETERIZED NETLISTS

Since each Mocha Chip module can have the number of terminals vary according to parameters, netlists used for general routing must exhibit the same degree of flexibility. Noticing that Mocha Chip cells behave like programs leads to the idea that netlists should also behave like programs. One idea is to draw netlist as in a schematic editor, but provide programmability for each terminal of the net. This

programmability would allow the drawn net to represent several actual nets. The programmability would be provided by a piece of code that is executed in order to produce a list of terminals. This could contain operators that generate the list based upon the terminals that appear on the actual module. One list would be generated for each end of the net, and all such lists would be of the same length. The first line in each of the files specifies the first actual net represented by the drawn net, and subsequent lines determine their nets in the same fashion.

In the general case the complete programmability of a general-purpose programming language would be needed, although simple pattern-matching operators would suffice in most cases. For example, the "\*" character would be sufficient to create bus structures. Each end of the drawn net could contain code similar to **(pattern "bit\*")**, which matches in alphabetical order all terminals that begin with the prefix "bit". If the drawn net is a 32-bit bus between two points, the left end of bus would be connected to a module that would be expected to have terminals labeled "bit0" through "bit31", among other things. At the right end of the bus we would expect to find another module with terminals of the same names. The same structure would work if a 16-bit module was being generated; the "bit\*" pattern would just match half as many terminals. Additional functions could be provided for common operations such as reversing a list. In this case, it would allow the bits in the bus to be reversed, connecting "bit0" to the last bit. Such a construct might take the form **(reverse (pattern "bit\*"))**, and would be attached to one of the drawn netlist. General-purpose programmability would be provided by allowing user-defined functions. For example, the user

could write a function **my-func** that takes as input the list of all terminals on the side of the module and produces a new list containing the terminals that are to participate in this net. The code attached to an end of the drawn netlist would be **(my-func (pattern "\*"))**).

There may be better ways to parameterize netlists. Modern schematic editors have special constructs for conveniently dealing with busses; perhaps this case is frequent enough to warrant special attention. In any case, it appears that the full generality of a programming language must be available to handle complex specifications.

## 7.6. FLEXIBLE PARAMETER PASSING

Mocha Chip uses top-down parameter passing, but other methods might be better for some applications. A common situation is that one part of a module depends upon characteristics of another part, as in the case of a PLA driver that depends upon the number of rows in the AND plane. In Mocha Chip, the parameters for the driver are calculated in the parent cell of the driver from information that is available. If parameters could be passed up and down the hierarchy, it would be possible to generate the AND plane first, and then generate the drivers based upon a value provided by the AND plane. With this more general parameter passing-mechanism, it would be possible to incorporate information about the actual layout, such as the capacitance of a certain line, in order to influence later parts of the module.

The more general parameter-passing mechanisms could be had by using a language such as Prolog instead of Lisp. In Prolog, the system determines how

variables should be bound in order to satisfy the constraints specified by the program. The net effect is that parameters may be either passed into or out of functions, with the actual direction and the order of evaluation being automatically determined. Using Prolog in Mocha Chip would provide these more general mechanisms by passing Prolog's semantics through to Mocha Chip's diagrams. A potential problem with this approach is the interaction with the assembly process. If layout-dependent values, such as capacitance, are produced, they may change as pitch-matching or routing constraints change. I propose that estimates should provide enough preciseness and that actual values would not be needed in most cases.

## 7.7. SUMMARY

Three types of enhancements could be made to Mocha Chip: usability enhancements, improved layout operators, and more flexible parameter passing. Usability enhancements include compilation of module generators to improve performance and the detection of identical cells to improve storage use. Layout can be improved through the use of pitch-matching and more general routing techniques. Parameters could be passed in a non-top-down manner in order to allow one part of a module to be generated based upon the structure of another part. This could be implemented by using a different language for the diagrams and their parameters.



## 7.8. REFERENCES

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## PITCH MATCHING

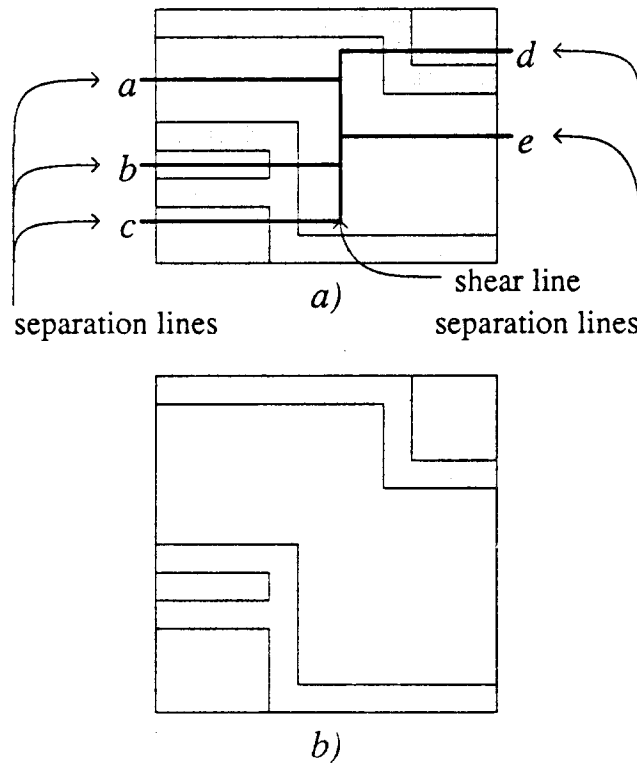
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### 8.1. INTRODUCTION

Pitch-matching refers to the stretching of tiles in order to make their terminals line up more closely. It provides another automatic interconnection operator like the river-route-space operator, and as such can guarantee that the resulting layout will obey geometrical design rules. For highly regular structures, pitch-matching may save area with respect to the river-route-space operator. A good pitch-matcher should be able to produce PLAs that are as compact as those produced with the tile-packing operator, but with a guarantee of design rule correctness. There are two aspects to any

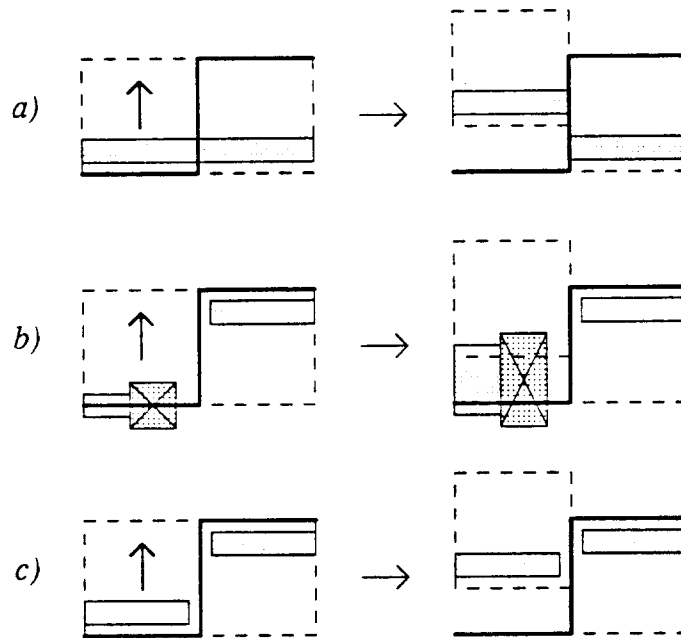
pitch-matching scheme: finding the legal stretch points, and determining how much to stretch.

## 8.2. STRETCH GRAPHS



**Figure 8.1.** The stretchability of a tile may be specified via a stretch graph. Part *a*) shows the vertical stretch graph for a simple tile. Part *b*) shows the result of stretching the tile along segment *a* by 1 unit, segment *c* by 2 units, segment *d* by 1 unit, and segment *e* by 2 units. The vertical line acts as a shear line, and the amount of stretch to the left of the line must equal the amount of stretch to the right.

One possible representation for legal stretch points is a stretch graph (Figure 8.1). The stretch graph for vertical stretching consists of horizontal lines, called *separation lines*, and vertical lines, called *shear lines*. Separation lines specify where a tile may be pulled apart in the vertical direction. Shear lines specify where material may slide.

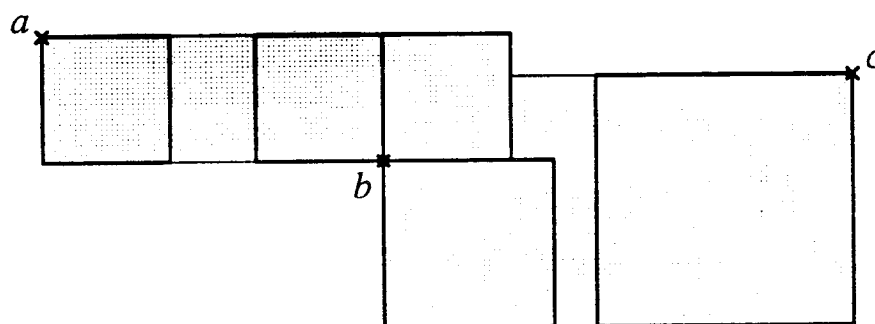


**Figure 8.2.** Improper stretching can change the connectivity of the circuit (part *a*), or modify the widths of wires and fixed-sized material such as contacts and transistors (part *b*). Improper stretching can also cause design rule violations (part *c*), since it may move material closer together. Stretch graphs must be carefully chosen to avoid these problems.

All the figures in this chapter show the upper piece moving upwards, although the only requirement is that material be pulled apart along the separation lines. The figures could equally well have been drawn with the lower piece of material moving downwards.

Without shear lines, stretch lines would have to cross the entire tile without jogging. This would be too restrictive a model, since two pieces of geometry in a tile may fit together along an uneven boundary, requiring a stretch line to jog. Shear lines may occur in either empty regions or within material. In the latter case, stretching along the line will vertically stretch the wire containing the line. The stretch graph model provides for a limited form of deformation: geometry can be stretched, but no new jogs can be introduced.

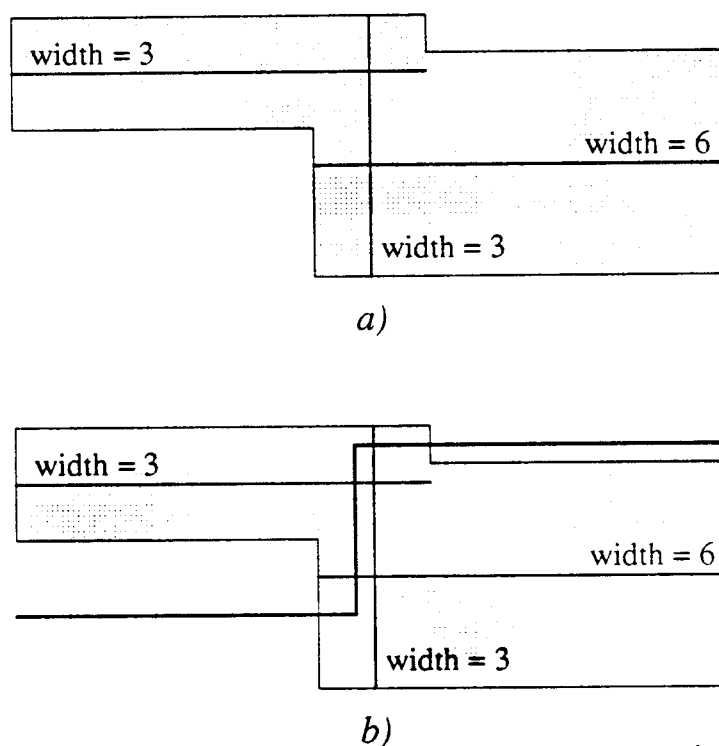
Three requirements are placed on the stretch graph (Figure 8.2). The first is that stretching must not change the connectivity of the circuit. This requirement can be easily maintained by ensuring that no shear lines touch the edge of a region of material. The second requirement is that stretching affect only the lengths of wires, and not the widths of wires or circuit elements such as transistors. Lastly, stretching must not cause geometrical design rule violations.



**Figure 8.3.** The corner-box is one method of determining the width of a piece of material. For each corner of the region, a square is found that is (1) as large as possible without extending outside of the region, and (2) has a corner that coincides with the region's corner. In the case of an interior corner, such as corner  $b$ , boxes may extend in up to 3 directions. This figure illustrates the corner boxes generated from corners  $a$ ,  $b$ , and  $c$ . Additional boxes are generated by the other corners of the region. The set of boxes now provide a notion of width at each corner. Deformations of the region are allowed as long as the set of corner boxes is the same for the new region.

Satisfying the second requirement is not as simple. With Magic's mask geometry it is easy to detect transistors, but it is unclear what the width of a wire is since arbitrarily shaped material may be present. Several schemes have been proposed, but it is hard to provide convincing arguments that any of them captures the intuitive notion of width. Figure 8.3 shows, as an example, one such scheme. The best approach seems to be a modification of Bill Lin's KAH LUA algorithm[1]. KAH LUA takes a region of

material of a single type and a set of terminals (connections to the region). It then finds a set of symbolic wires equivalent, in a sense, to the region (Figure 8.4a). The wires are found by routing within the region, trying to use the shortest and fattest wires that will fit within the boundary. The end result is a set of wires specified by their centerlines and their widths. In most cases the wires will exactly cover the region. In cases where some material is left uncovered, it can be argued that this is useless material and the wires still implement an electrically-equivalent region.

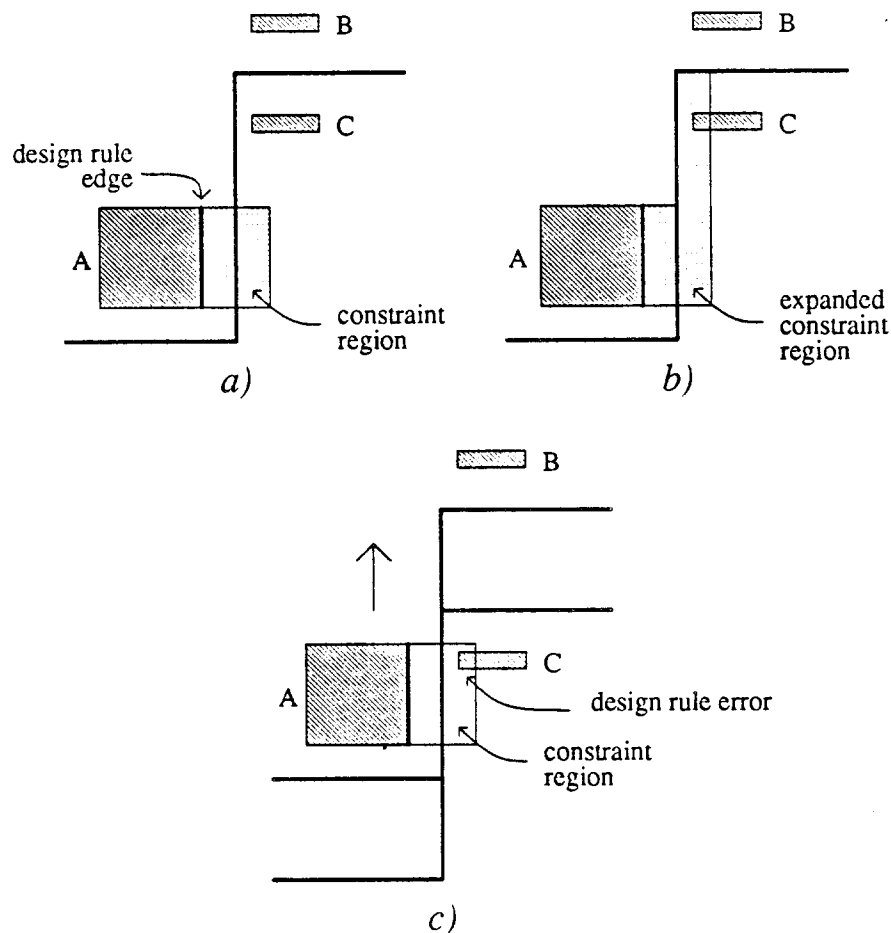


**Figure 8.4.** A region may be decomposed into wires using KAHLUA's[1] algorithm. Part *a* shows the centerlines of wires produced from this algorithm. I expect that rules can be developed that automatically create legal stretch graphs, such as in *b*, from the region's outline and the wires' centerlines.

Once the wires are found, we can consider what constitutes a legal stretch graph.

Figure 8.4b shows a stretch graph that is intuitively legal, since it satisfies our three

requirements stated earlier. In particular, stretching along it doesn't change the width of the wires. Additional work needs to be done to develop search procedures to discover legal graphs from the wires' centerlines.



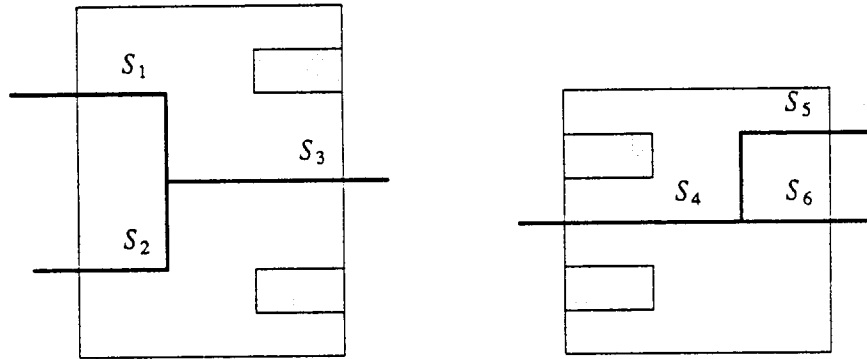
**Figure 8.5.** Magic's design rule checker finds edges of material and then checks rules by looking in a rectangular constraint region for illegal material. Part *a* shows the constraint region that is checked. We can check the same rules across all possible stretches by expanding the constraint region to include the new areas that would be covered by the original region if shear occurred, as shown in part *b*. In this example, material *A* can never get too close to material *B* since they move in lock step. It can, however, get too close to material *C* when it slides upwards as a result of shearing. Part *c* shows the result after stretching, and the new design rule violation with material *C*.

The last remaining requirement is the preservation of geometrical design rules. Figure 8.2 shows how shearing can violate minimum spacing rules. These violations can be avoided by checking in advance using a modified design rule checker. The checker takes a stretch graph and a layout and detects design rule violations that could occur if the layout was stretched along the lines in the graph. The checker is based upon Magic's design rule checker (Section 5.4) which checks constraint regions for the presence of illegal material (Figure 8.5a). We can modify the design rule checker to stretch the constraints so that they cover the region that the original region would pass over as it was stretched. Stretching up to the end of the shear line is sufficient, since material past the end of the shear line moves with the edge that generated the constraint region. It is also necessary to take into account the interactions between nearby shear lines, since one may shear while another one doesn't. I have not investigated this issue.

### 8.3. SOLVING THE GRAPHS

The second major problem to be solved in pitch-matching is to determine the stretch amounts needed to join tiles together (Figure 8.6). A stretch graph can be represented by a directed graph similar to that in Figure 8.7. Each arc corresponds to a separation line, and each node to a shear line. An integer value,  $S_i$ , is assigned to each arc  $i$ , indicating the amount of stretching to be done along that separation line. Each node  $j$  is assigned an integer value,  $A_j$ , which is always zero for the purposes of the immediate discussion. Any valid set of stretch amounts must have the same amount of





**Figure 8.6.** In order to align terminals, stretch amounts must be assigned to the separation lines in each tile's stretch graph. Each  $S_i$  in this figure corresponds to a stretch amount that must be computed.

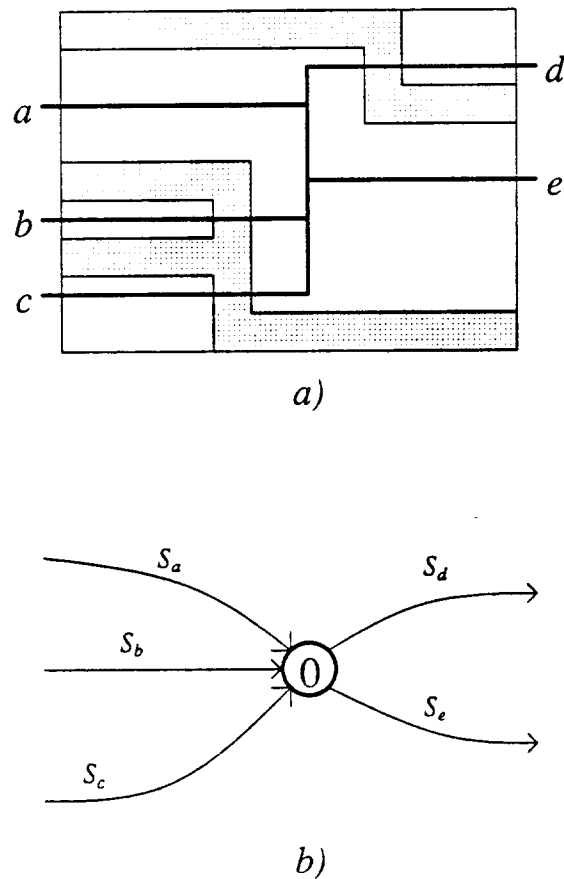
stretch to the left of a shear line as is to the right of the line. This is another way of saying that the following invariant must be maintained:

For each node  $n$ ,

$$\left\{ \sum_{i \in \text{in arcs}_n} S_i \right\} + A_n = \sum_{j \in \text{out arcs}_n} S_j$$

where  $\text{in arcs}_n$  is the set of arcs that point to node  $n$ , and  $\text{out arcs}_n$  is the set of arcs that point out of node  $n$ .

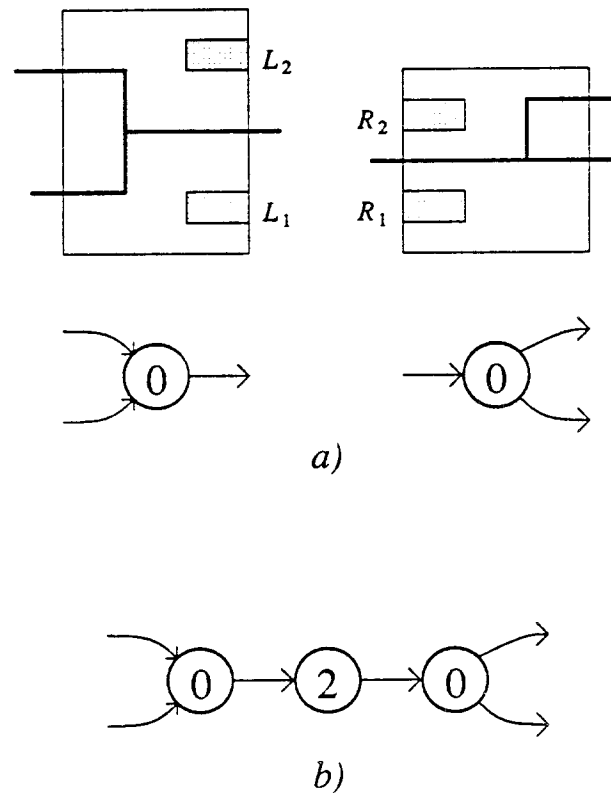
The value attached to each node is the amount of additional stretching needed by the geometry on the right side of a shear line in order to make it align with the geometry on the left side. For shear lines this is always zero. Other values will be used when joining the stretch graphs of two tiles together, as is shown in Figure 8.8. To accomplish a join, a node is inserted between adjacent pairs of matching terminals, all the stretch lines between the terminals are connected to the node, and the node's value is set so that the terminals will be forced to align. For example, in Figure 8.8, the distance between terminals  $L_1$  and  $L_2$  is 6, and the distance between terminals  $R_1$  and  $R_2$  is 4. The node would be assigned a value of 2, since the right side must be stretched by



**Figure 8.7.** A directed graph is used to represent a stretch graph. Each arc corresponds to a separation stretch line, and has a weight indicating how much it should be stretched. Each node corresponds to a shear line, and has a value of zero indicating that the amount of stretch to the left of the node must be equal to the amount of stretch to the right.

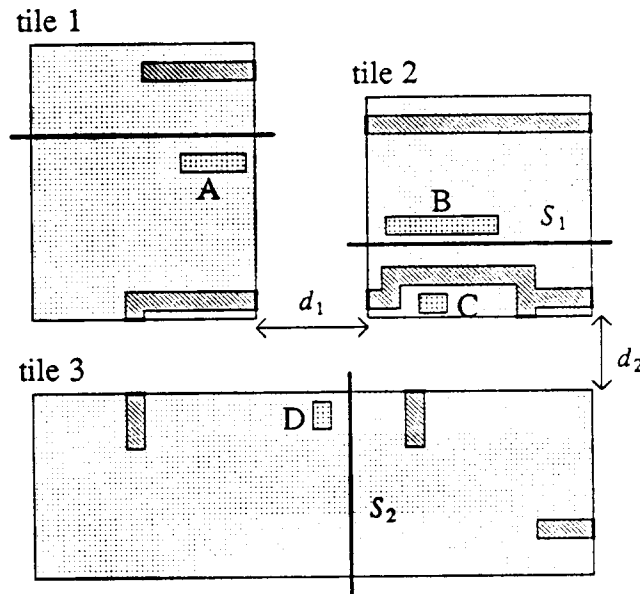
two more units than the left side if the terminals are to align properly.

The separation of two tiles of geometry depends, in part, on how they are stretched, due to design rule interactions (Figure 8.9). This presents difficulties, since the separation must be known in order to set up the stretch graph for alignment in the other direction. Because of this interaction, it is not possible to assemble the complete vertical and horizontal graphs for a module and then solve them independently.



**Figure 8.8.** Stretch graphs are joined together by intermediate nodes. These nodes have a value which states how much extra stretching should appear on the right side of the node in order to pitch-match the underlying geometries. Part *a* shows two tiles and their corresponding graphs. The terminals on the left tile have a separation that is two units greater than that of the terminals on the right tile. The intermediate node, shown in part *b*, has a value of 2 to force the terminals to align when the graph is solved.

Other approaches will work, however. One approach is to join two tiles together using the minimum separation allowed for the specific amount of stretch needed for the join, without regard for additional stretching that will be needed later on. New vertical and horizontal stretch graphs are then prepared for use in further joins. These graphs include a stretch line along the seam between the two tiles, so that they may be pulled apart to fit the needs of later joins. The result of this operation is a larger tile with a stretch graph that can be used in operations just like a primitive tile. In Figure



**Figure 8.9.** The vertical and horizontal stretch graphs are interdependent. As an example, tile 2 must be stretched to make its terminals align with those of tile 1. This stretching causes material *B* to move closer to material *A*, resulting in a greater spacing for distance  $d_1$ . Distance  $d_1$ , in turn, determines stretch  $S_2$ , thus part of the vertical stretch graph ( $S_1$ ) affects part of the horizontal stretch graph ( $S_2$ ). Distance  $d_1$  also determines how close material *C* is to material *D*, which then partially determines distance  $d_2$ . Distance  $d_2$  may affect the horizontal stretch when these tiles are joined to other tiles in the horizontal direction. Thus, the vertical and horizontal stretch graphs are interdependent and cannot be solved independently.

8.9, this amounts to joining tile 1 with tile 2 and fixing distance  $d_1$ , so that the pair can be joined with tile 3. A new stretch line is added between tiles 1 and 2, so that they may be pulled apart if  $S_2$  is stretched in some later join.

One problem with this approach is that it can waste area. It may be necessary to either (1) eliminate certain stretch lines, because use of them would require a larger separation in the future, or to (2) initially make the separation large enough to handle any future stretching. In the example, after fixing distance  $d_1$  it is no longer possible to increase the stretch along  $S_1$ , because that would move material *B* and require an

increase of distance  $d_1$ . Under plan (1), this would be solved by deleting  $S_1$  from the stretch graph after the join. This might waste area because that degree of freedom would no longer be available. Under plan (2), the separation  $d_1$  would be made large enough from the very beginning, so that additional movement of material  $B$  would never be a problem. This plan would also waste area, because  $d_1$  might be larger than needed. Another problem with this overall approach is that it stretches each tile many times, as much as once for each join in the entire module. This could lead to poor performance.

Another approach is to assemble the graphs for the entire module, and then solve them while leaving open the possibility of errors that will need to be corrected later. Each separation distance is assumed to be the minimum separation possible over the set of all possible stretches. With these assumptions, one graph, say the vertical stretch graph, is solved. This provides a set of stretch amounts for the vertical direction, and thus allows exact horizontal separations to be determined. These horizontal separations can be used to prepare and solve an exact stretch graph for the other direction. Solving this graph determines the vertical separation distances, and may or may not match the separation assumption made when solving the first graph. If the distances need to be increased, the new separations are used in the original graph and the process repeats, alternately solving vertical and horizontal graphs until it converges. The process is guaranteed to converge, since separation distances are only increased and the largest geometrical design rule serves as an upper bound for separation. However, this approach may be slow due to the iteration involved.

The most promising solution appears to be a modification of one of the plans discussed earlier. The approach is to assume the maximum separation for each join between tiles, over all possible stretches of those tiles. The vertical and horizontal graphs can be solved independently under this assumption, since it is not possible to later find that a separation is greater than the assumed separation. After solution, the size of the module may be decreased by removing excess space from some of the separations. This involves finding a path through the entire stretch graph where all the edges have stretch values greater than zero and each separation between tiles has excess space. It is likely that compressing a separation in one direction will preclude compression of other separations in the perpendicular direction. I suggest that in most modules one dimension is the most critical, so it makes sense to compress the maximum amount in that direction followed by compression in the other direction.

None of these approaches considers what happens when no solution is possible, as would be the case, for example, if two terminals were too close together and there were not any stretch lines between them. Geometrically, it is easy to river route pins that do not line up correctly, but it is unclear how to incorporate this capability into the algorithm that solves the stretch graphs.

#### 8.4. DISCUSSION

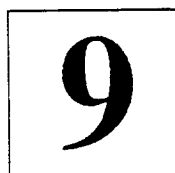
Several pitch-matching algorithms have been presented, but they need more study. There may be better approaches to solving the stretch graphs and handling the interactions between the horizontal and vertical graphs. A careful study of symbolic

layout compaction algorithms may reveal similarities to the pitch-matching problem. Perhaps some of the compaction work will provide new insights or solutions.

Adding pitch matching to Mocha Chip would allow it to guarantee design rule correctness for regular structures without the waste of area that the river-route-space operator produces for those structures. If this were done, structures such as PLAs could be built that use the same amount of area as those built with the tile-packing operator, but with a guarantee of design rule correctness.

## 8.5. REFERENCES

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## DISCUSSION

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### 9.1. DISCUSSION

There are two major problems with past approaches to building module generators: the specification of the structure of the module was obscured, and no guarantees of design rule correctness were made. Mocha Chip addresses each of these problems: graphical diagrams are used to represent the module's structure in a visually intuitive form, and pairwise assembly operators provide an assurance of design rule correctness.

Mocha Chip's module generators are graphical diagrams, with a simple geometrical correspondence between the diagrams and the layout that is to be produced. These



diagrams are closer to the two-dimensional image in the IC designer's mind, and thus are easier to comprehend.

The diagrams may be considered to be a graphical programming language for IC module generation. The language provides array and case cells which are analogs of loops and conditionals in a textual programming language. Pairwise assembly operators and tile stretching form the primitive computations in this language, and correspond to things like assignment and arithmetic operations in a programming language.

Using graphical diagrams solves a major problem with previous module generator systems: that they are textual. However, in addition to obscuring the overall structure of a module, textual languages have another problem: they are not an intuitive way to specify low-level geometry, leading to design-rule errors in cases that have not been heavily tested. Mocha Chip's diagrams, by themselves, don't solve the problem of interconnecting low-level geometry. Instead, Mocha Chip provides assembly operators that automate the interconnection process, providing a guarantee of design-rule correctness.

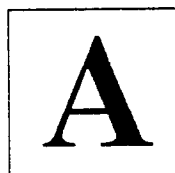
Several assembly operators are implemented or envisioned. The tile-packing operator is simple and produces space-efficient designs, but provides no assurance of design-rule correctness. The river-route-space operator guarantees that design rules are not violated, and ensures that pins are connected together even if they don't align exactly. Other more complex assembly operators, such as pitch-matching and general routing, can be implemented within Mocha Chip's framework to provide better layout.

The ability of some assembly operators to guarantee design rule correctness leads to more robust generators, and solves this long-standing problem with past module generation systems.

Mocha Chip's framework provides room for future expansion. I've already mentioned the ability to add new pairwise assembly operators, such as pitch-matching and routing. The graphical language can also be extended to provide parameterized netlists and to allow a more powerful parameter passing mechanism. Such a mechanism would provide non-top down parameter passing, and would allow one part of a module to be generated based upon the results of the generation of another part.

There are two main limitations to Mocha Chip as it now stands: the system runs more slowly than other systems, and pitch-matching appears to be required for most regular modules. In Chapter 7 I've suggested ways that Mocha Chip could be made faster, and in Chapter 8 I've detailed possible methods of adding pitch-matching.

Mocha Chip's graphical language is powerful enough to build module generators for structures like PLAs. As we consider more and more irregular modules, Mocha Chip looks less and less useful, requiring multiple diagrams and extensive use of the Case cell. Mocha Chip works well for structures of the complexity of PLAs, and would probably work well for slightly more complex structures such as ALUs and datapaths. It would likely not be appropriate for more random forms of control constructs. However, structures of the complexity of PLA abound; RAMs, ROMs, ALUs, and shifters are examples. Mocha Chip works well for these and provides a robust, intuitive, and easy-to-understand means of specifying these generators graphically.



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## A.1. ARRAY BUILT-IN CELL

### NAME

Array - Mocha Chip iteration cell

### SYNOPSIS

Array [Mocha Chip Cell]

### DESCRIPTION

**Array** is a standard Mocha Chip cell located in `~cad/lib/mochachip`. It performs a graphical form of two-dimensional iteration.

### PARAMETERS

#### x-dimension

The number of columns in the array. The columns will be numbered 1 through *x-dimension*. at 1.

#### y-dimension

Similar to **x-dimension**.

#### flip-columns

This parameter can take one of four values: **'none'**, **'even'**, **'odd'**, or **'all'**. The default is **'none'**. If the value is **'odd'**, then odd numbered columns of the array will be flipped sideways. **'even'** does a similar thing for even numbered columns. **'all'** flips all columns, while **'none'** flips nothing.

**flip-rows**

Similar to **flip-columns**

**subcell**

This parameter is the name of a subcell to invoke at each position in the array.

This subcell might access it's position, but this will be described later. For example: (subcell 'ram\_bit).

**VARIABLES**

Two variables are defined by the Array cell which may be useful to subcells:

**x-index**

Set to be the current column number in the array.

**y-index**

Set to be the current row number in the array.

**BUGS**

None known. Some tuning of this cell's code might speed it up a bit.

**AUTHOR**

Robert N. Mayo, University of California at Berkeley.

**SEE ALSO**

mochachip (1), mochachip (5), lisp (1), magic (1), Case (3MC)

## A.2. CASE BUILT-IN CELL

### NAME

Case - Mocha Chip conditional selection cell

### SYNOPSIS

Case [Mocha Chip Cell]

### DESCRIPTION

**Case** is a standard Mocha Chip cell located in `~cad/lib/mochachip`. It performs a graphical form of conditional selection.

### PARAMETERS

**case1 ... caseN**

This cell takes an arbitrary number of parameters of the form **caseN**, where *N* is a positive integer. The parameters contain the different cases to be evaluated, much in the same way as Lisp's **cond** expression or Pascal's **case** construct. The syntax of a single case is:

*(caseN '(expr cellname orientation parameters))*

where *N* is a positive integer, *expr* is a boolean-valued Lisp expression, *cellname* is the name of a subcell, and *orientation* is a list (or nil) that gives the orientation of the cell. The orientation list is a sequence of atoms from the set {0, 90, 180,

270, upsidedown, sideways}. The atoms name operations that are applied to the cell, starting with the leftmost named operation. The numerical atoms indicate rotation of a number of degrees, while the other two atoms indicate a mirroring functions. Parameters is a list of parameters and values for this cell.

The cases are evaluated in order, with the first true case being used. An error is reported if no case is true. An example case parameter might look like this:

```
(case1 '((equal x-pos 3) "decode_cell" '(90 sideways) nil)).
```

## BUGS

Some tuning of this cell's code might speed it up a bit.

## AUTHOR

Robert N. Mayo, University of California at Berkeley.

## SEE ALSO

mochachip (1), mochachip (5), lisp (1), magic (1), Array (3MC)

### A.3. MCPLA PLA GENERATOR

#### NAME

mcpla - Mocha Chip PLA generator

#### SYNOPSIS

mcpla [Mocha Chip Cell]

#### DESCRIPTION

**mcpla** is a Mocha Chip module generator for PLAs. It takes truth tables in the pla(5) format, and produces mask geometry in Magic format. The generator is invoked from the Mocha Chip system, which is built into the Magic layout editor.

#### PARAMETERS

##### truth-table-file

The filename of the truth table file.

##### clock-inputs

If non-nil, mcpla will provide clocks for the input buffers.

##### clock-outputs

If non-nil, mcpla will provide clocks for the output buffers.

##### input-labels

This parameter should contain a list of the names of the inputs to the PLA. If the list is not long enough, or is nil, mcpla generates names for the remaining inputs.



**output-labels**

This parameter should contain a list of the names of the outputs to the PLA. If the list is not long enough, or is nil, *mcpla* generates names for the remaining outputs.

**gnd-stretch**

The number of coordinates (usually lambda) to stretch tiles by. This is used to increase the width of ground lines to the PLA.

**gnd-spacing**

If *gnd-spacing* is set to *N*, every *Nth* row in the AND plane and every *Nth* row and column in the OR plane will contain an extra ground line, in order to assist distribution of power to the array.

**TILES**

The layout produced is controlled by a set of Magic cells called *tiles*. Tiles for *mcpla* may be found in the subdirectories of `~cad/lib/mcpla`. Currently the following sets of tiles exist:

*scmosA* sample set of tiles for the *scmos* technology. Both clocked input and output drivers are supported.

To use a set of tiles called *foo*, set up Mocha Chip's **MochaCellPath** parameter to access `~cad/lib/mcpla/foo`. For example: `(MochaCellPath '("." ~cad/lib/mcpla/foo"))`.

**AUTHOR**

Robert N. Mayo, University of California at Berkeley.

**SEE ALSO**

pla (5), eqntott (1), espresso (5), mochachip (1), magic (1), lisp (1)

## A.4. MOCHA CHIP

### NAME

mocha chip – module generation system for Magic

### SYNOPSIS

:specialopen mochachip

### DESCRIPTION

Mocha Chip is an interactive module generation system built into the Magic VLSI layout editor. Mocha Chip allows the user to create module generators by drawing a diagram of the desired layout and then parameterizing it so that it specifies many different, but similar, modules.

To get an idea of what a Mocha Chip generator looks like, open up a Mocha Chip window with the Magic command :specialopen mochachip. After this is done, point to the window and type :load mcpla. This will load in the mcpla PLA generator. Looking at this will give you a feel for the sort of things that Mocha Chip can do.

### COMMANDS

**box** [*dir* [*amount*]]

Same as Magic's **box** command.

**clockwise** [*degrees*]

Rotate the selected objects and the box clockwise in such a way that the lower-left corner of the selection remains unchanged. *Degrees* should be a positive

multiple of 90 degrees.

#### **create [magic|mochachip|onelevel]**

Create a module from the diagram underneath the cursor. The resulting magic cell will have the same name as the diagram underneath the cursor. The new module will overwrite any similarly named Magic or Mocha Chip cell. The module can be generated in one of three forms: **magic**, **mochachip**, or **onelevel**, with **magic** being the default. The **magic** form specifies that the module will be generated as a collection of Magic cells. As a side effect, Mocha Chip cells are produced as with the **mochachip** option. The **mochachip** form specifies that a collection of Mocha Chip diagrams is to be produced instead of actual layout. These diagrams are similar to the Mocha Chip diagrams that produced the module, except that the parameters, variables, and comments have all been evaluated (instantiated). The top-level Mocha Chip cell will have the same name as the module but with **-v0** added on the end. The **onelevel** form is similar to **mochachip**, except that only the topmost level of the module is generated. This is useful for debugging parameterization.

#### **decompose**

Recursively split the diagram under the cursor into pieces. Mocha Chip requires that diagrams be split up in this manner. If the automatic decomposition does not give the desired results, then the user can erase some of the decomposition lines and put in new ones with the **getdecompline** command. If the user does this, the **decompose** command should be run afterwards to tidy things up.

The decomposition is important since it specifies the manner in which the module is built. The lines show how to divide the module into smaller and smaller pieces. When assembling the module, the reverse process takes place: small pieces are paired up forming larger pieces until the complete module is generated.

**delete** The current selection is deleted from the diagram.

**destroy [cellname]**

The specified cell (if none, then the one under the cursor), is deleted. Even the file on disk is removed, so be careful when using this command. This command is usually used when you want Mocha Chip to use a Magic cell instead of the Mocha Chip cell by the same name.

**eval *expr***

Evaluate a Lisp expression. If the expression contains any blanks or special characters it will have to be surrounded by double quotes. The system will detect and report any errors encountered during the evaluation process.

**expand [toggle]**

Expand (show internals) of everything under the box or, if **toggle** is specified, toggle the expansion state of all selected objects in the diagram under the cursor.

**findbox [zoom]**

Same as Magic's **findbox** command.

**flush [cellname]**

Reload the specified Mocha Chip cell from disk or, if none was specified, the one under the cursor. Any changes made to the cell are discarded.

**getcell** *cellname*

Put a subcell into the diagram under the cursor.

**getdecompline**

Put in a new decomposition line. The box must have two sides coincident so that it forms a line rather than a rectangle or point.

**grid** [*xSpacing* [*ySpacing* [*xOrigin* *yOrigin*]]]**grid off**

Same as Magic's **grid** command.

**identify** *username*

Set the use name for the selected subcell.

**lisp** [*on/off*]

With no arguments, go into interactive Lisp mode. Otherwise, with the **on** option interactive Lisp mode is entered whenever Mocha Chip encounters an error. The **off** option disables this. Interactive Lisp mode may be terminated with the Lisp, (**bye**) command.

**load** *cellname*

Load the specified cell into the window, replacing the cell that is currently there. The replaced cell remains in Mocha Chip, and can be viewed with another **load** command.

**loglisp** [*filename*]

Start logging lisp interactions to **filename**. If the filename is omitted, then stop

logging. Text sent to Lisp is written to the file immediately, while text sent from Lisp to Mocha Chip is written to the file when Mocha Chip reads it.

**move** Move the currently selected objects so that their lower-left corner coincides with the lower-left corner of the box tool.

**path** *path*

Same as Magic's **path** command. The path set with this command is used for finding both Magic and Mocha Chip cells.

**save** [*filename*]

Save the current cell to disk. If *filename* is specified, the cell is save to that file and the cell's name is changed to match the filename.

**select** [*option*!help]

Select an object. Current options are:

**select** [more]

Put the object under the cursor into the list of selected objects. If **more** is not specified, then the selection is cleared first.

**select** [more] area

Put all objects that overlap the area of the box into the list of selected objects. If **more** is not specified, then the selection is cleared first.

**select** clear

Clear the list of selected objects.

**select help**

Print out a brief synopsis of these options.

**sideways**

Flip the selection and the box sideways, keeping it in the same position.

**size** Resize all selected objects so that they fit within the box exactly.

**syncclisp**

Bring Mocha Chip back in synchronization with the Lisp system. They should never get out of sync in the first case, so this command is only a sort of "insurance".

**textedit**

Invoke an editor on the contents of the selected object. The program run is called "mochaChipTextEditor". On a Sun, this program opens up a new window and runs the editor specified by the "EDITOR" environment variable. If the environment variable is not found, the program runs "/usr/ucb/vi" in the window. The user can place a program called "mochaChipTextEditor" in the current directory if some other action is desired.

Syntax errors in the text can make a cell unreadable after it is written out. If this happens, you should fix the syntax error using a text editor on the file.

**unexpand**

Unexpand all cells under the box.



**upsidedown**

Flip the selected objects and the box upsidedown. The objects remain in the same location.

**what**Print out information about what objects are selected.

**writeall [force]**

Write out all Mocha Chip cells that have changed. Unless **force** is specified, the user is asked for permission before each cell is written.

**SPECIAL FUNCTIONS & VARIABLES**

Various special functions and variables may be used which modify the behavior of Mocha Chip. The follow describes each of these.

**MochaCellPath**

Mocha Chip first searches through the path listed in **MochaCellPath** when looking for Mocha Chip or Magic cells during the generation of a module. If it can't find a cell that way, it then looks through the directories in Mocha Chip's search path (set via **:path**).

**MochaCellPath** is initially set to **nil**. If desired, a module generator may redefine this variable in the **Local Variables** or **Parameters** section to cause different directories to be searched. For example, a module generator that has some tiles in `~cad/lib/hap_gen` might look there for tiles after first checking the current directory. This could be done by placing the following line in the local variables section:

```
(MochaCellPath '("." "~cad/lib/hap_gen"))
```

Note that the path must be a list, not just a single directory. It is possible to include Mocha Chip's default search path as part of the **MochaCellPath** list. Mocha Chip's default search path is stored in the variable **MochaMagicPath**. For example:

```
(MochaCellPath (append1 MochaMagicPath '("." "~cad/lib/hap_gen")))
```

will cause Mocha Chip's search path to be searched before the two specified directories.

### **MochaFileDir**

If set to non-nil in a **Local Variables** or **Parameters** block, then all generated cells will be placed in the specified directory. This variable doesn't obey normal scoping rules -- it should be set once and then *all* cells for this module will be placed in that directory. Example:

```
(MochaFileDir "decode_pla")
```

will cause all files for this module to be placed in the directory **decode\_pla**. If this is done, it is handy to set Magic's path so that the files can be accessed later! See the **:path** command of **magic(1)** for more details.

### **MochaMagicPath**

This is Mocha Chip's search path, which is searched after **MochaCellPath**. See the description of that variable for more information.

**BUGS**

No doubt there are many bugs. Please report them to "mayo@ucbarpa.berkeley.edu".

Mocha Chip requires at least 8 megabytes of real memory, or it will thrash and run very s-l-o-w-l-y.

**AUTHOR**

Robert N. Mayo, University of California at Berkeley.

**SEE ALSO**

magic (1), mochachip (5), lisp (1)



## TUTORIALS

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## **B.1. USING A MOCHA CHIP MODULE GENERATOR**

### **Mocha Chip Tutorial #1:**

#### **Using a Mocha Chip Module Generator**

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#### **B.1.1. INTRODUCTION**

Mocha Chip is a system for building semi-regular modules such as PLAs, barrel shifters, and decoders. This tutorial tells you how to start up Mocha Chip and use module generators that have already been designed. However, you will probably want to develop some of your own specialized module generators. Mocha Chip tries to

make this especially easy, and you are encouraged to read “Mocha Chip Tutorial #2” which tells you how to build module generators.

### **B.1.2. HOW TO GET HELP AND REPORT PROBLEMS**

Mocha Chip is built into the Magic layout editor, but is being built by only one member of the Magic team: myself. For this reason, please send bug reports, suggestions, and complaints directly to me at [mayo@ucbarpa.berkeley.edu](mailto:mayo@ucbarpa.berkeley.edu). If you are reporting a bug, please give me enough information so that I can repeat the problem. In some cases this may involve sending me the cells that you were using and the sequence of commands that lead up to the error.

Mocha Chip is currently (November, 1987) a young system. I welcome your comments so that I can improve the system. By reporting problems, you will make life much easier for those that follow in your footsteps.

Magic bug reports and comments that are not specific to Mocha Chip should be sent to [magic@ucbarpa.berkeley.edu](mailto:magic@ucbarpa.berkeley.edu), as always.

### **B.1.3. STARTING UP MOCHA CHIP**

I’m going to assume that you are already familiar with Magic and that you have Magic running with the cmos technology. If this is not the case, you should start up Magic, referring to **Magic Tutorial #1: Getting Started** as needed.

The first thing that needs to be done is to open up a Mocha Chip window. Type:

**:specialopen mochachip**

and you will see a new window appear. The caption of this window indicates that it contains a Mocha Chip cell -- in this case the unnamed one.

Notice that the cell isn't completely empty. You will see three objects in the cell: a *Parameters* block, a *Local Variables* block, and a *Comments* block. The second tutorial will show how these are used to provide programmability and parameterization when building a module generator. We won't concern ourselves with these blocks now, because we are just going to use an existing module generator rather than design a new one.

#### B.1.4. A PLA EXAMPLE

Let's create a PLA as an example. Assume that we want the PLA to be called **decode\_pla**. Our first step is to load in a new Mocha Chip cell by that name. This can be done by pointing to the Mocha Chip window and typing:

**:load decode\_pla**

Mocha Chip won't be able to find this cell (unless you made it before), so it will tell you that and create a new cell.

We'll use the **mcpla** module generator to create the PLA for us. The first thing that needs to be done is to put the generator into our search path. Type **:addpath ~cad/lib/mcpla**. You will probably want to put this command (without the ':') into your **.magic** file so that you won't have to type it each time. The curious among you

might want to see what the **mcpla** generator looks like internally. To do this, open up another Mocha Chip window and type **:load mcpla**. The generator is just another diagram, but with text in the cells to provide parameterization.

Now we will put **mcpla** to use. Move the box into the lower part of the window containing the **decode\_pla** Mocha Chip cell. Make the box a comfortable size, and type **:getcell mcpla**. This tells the system that we are going to use the **mcpla** generator to create the contents of **decode\_pla**. Now type **:expand** or the macro 'x' to expand the cell. At this point, we need to supply a truth table and other parameters to **mcpla**.

**mcpla** takes a single parameter, **truth-table-file**. This can be determined by looking at the manual page for **mcpla** or, better yet, looking at **mcpla** directly. I've created a sample truth table file for you, and it's name is **decode\_pla.tt** and can be found in the same directory as **mcpla** (**~cad/lib/mcpla**). We need to pass this filename in as a parameter to **mcpla**. Point to the **mcpla** subcell and type **:select**. Now type **:textedit**. A text editor should pop up. Insert the following line into the file:

```
(truth-table-file "~cad/lib/mcpla/decode_pla.tt")
```

This tells the system that the parameter **truth-table-file** is to be set to the value **~cad/lib/mcpla/decode\_pla.tt**. The quote marks specify that the value is a constant, rather than an expression that is computed. This syntax is the same as Lisp, and in fact the value can be any arbitrary Lisp expression.

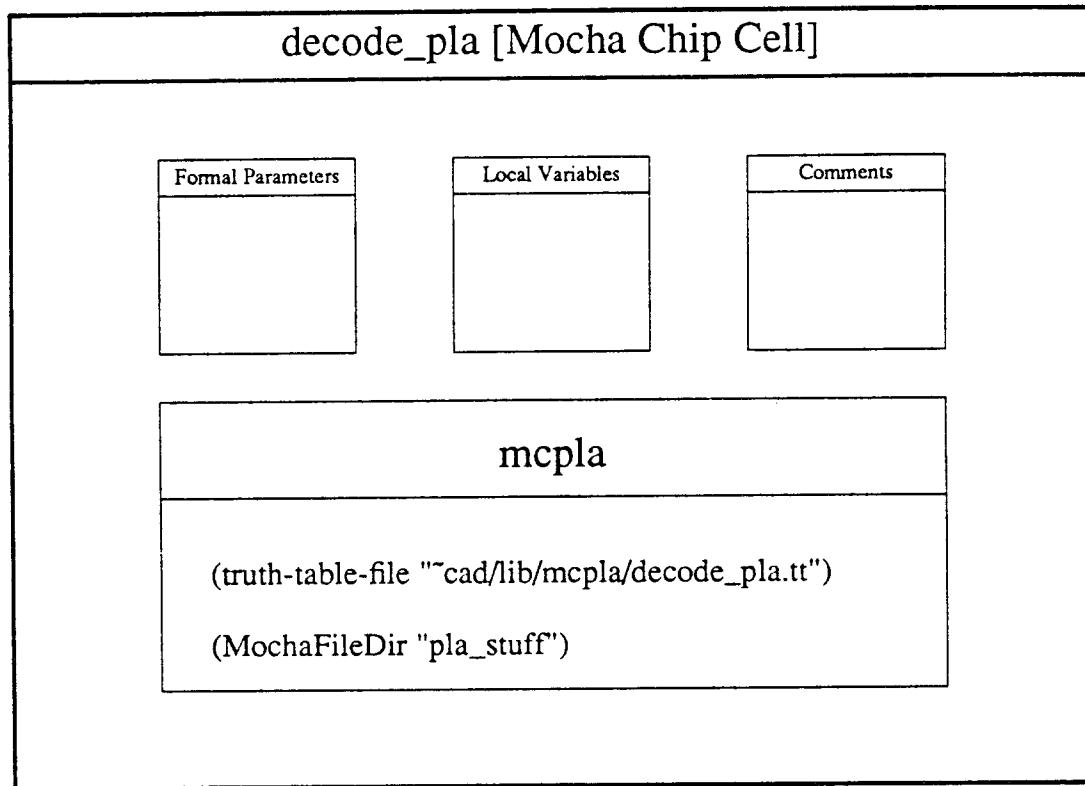


There is another parameter that we might want to define. The parameter **MochaFileDir** specifies the directory into which to put files. Some module generators can create lots of files, so it is often convenient to put them into a single directory. Let's say that we want the files to go into the directory called **pla\_stuff**. We can do this by adding the line:

```
(MochaFileDir "pla_stuff")
```

to the file that we are editing. Now we can save the file (using **:wq** for the vi editor), and you will see that Mocha Chip has put the text into the selected cell.

We must prepare for the new files that will be created. To do this, suspend Magic with a **^Z** and type **mkdir pla\_stuff** to create a directory for the files. Now continue Magic with **fg**, and type **:addpath pla\_stuff** to put the new directory into the search path.



**Figure 1.** Use of the PLA generator `mcpla`. This diagram shows how parameters are passed into an existing generator to create a pla called `decode_pla`.

Everything is now set up. Your Mocha Chip window should look something like Figure 1. Point to that window and type:

`:create`

Mocha Chip will now start up `mcpla`, which will create the PLA. `mcpla` prints out several messages as it goes. After it is finished, you can point to the layout window and type `:load decode_pla`. The layout that you see is the PLA produced by `mcpla`. If you want to save your Mocha Chip files, you should point to that window and type `:writeall`. If you want to save the generated Magic files, you should point to a layout window and execute the `:writeall` command there.

### B.1.5. CONCLUDING REMARKS

This concludes the use of Mocha Chip module generators. The parameterization required for each generator is documented in the generator's manual page. Certain parameters, such as the **MochaFileDir** parameter, are system wide and are documented in the Mocha Chip manual page.

I hope that you had a chance to look at the internals of the **mcpla** generator by typing **:load mcpla**. One of the reasons for building Mocha Chip was to make designing module generators easier. It is hoped that the ability to draw portions of the module generator rather than write code will encourage designers to create their own module generators.

## B.2. DESIGNING MODULE GENERATORS WITH MOCHA CHIP

### Mocha Chip Tutorial #2:

#### Designing Module Generators with Mocha Chip

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##### B.2.1. INTRODUCTION

In the first tutorial you saw how to use an existing Mocha Chip module generator. In this tutorial I'll show you how to design your own module generator. Unlike most module generator systems, Mocha Chip allows you to draw a *diagram* of the overall structure of the class of modules that you want to generate. You can then parameterize

this diagram to tell Mocha Chip how different modules differ. You can think of Mocha Chip as a sort of graphical programming language tailored specifically to the generation of IC layouts.

Mocha Chip also gives you some powerful interconnection operations to use. The tiles (or basic subcells) of your module can be connected together using *abutment*, *pitch-matching* or *river routing*. (NOTE: No pitch-matching exists in the current release.) *Abutment* aligns user-specified packing rectangles so that they are adjacent. Overlap of cells is possible by making the user-specified packing rectangles smaller than the cell itself. *Pitch-matching* stretches cells so their ports line up more closely, while *river-routing* is a simple form of routing that can be used where wires don't need to change layers or jump over each other. In the future I might add more general routing capabilities.

### B.2.2. AN EXAMPLE DIAGRAM

I assume that you have read the first Mocha Chip tutorial, and that you have Magic running on your workstation with the cmos technology. Let's start by opening up a Mocha Chip window and loading in the **tut2a** cell.

You will see on the screen a Mocha Chip diagram that contains two subcells: **mochatut2** and **mochatut1**. The two subcells contain Magic layout. You can use one of Magic's layout windows to look at them. Do this, and you will see that **mochatut1** contains a contact and some **metall1** and **poly**. **Mochatut2**, on the other hand, contains a length of **metall1** with a few diffusion wires crossing it.

Notice the small arrows on the subcells in the Mocha Chip window. The arrows indicate the orientation of the subcell. Mochatut2's arrow is pointing north, with the little flag on the right. This indicates the normal orientation of the cell. Mochatut1, on the other hand, has the arrow pointing right. This is because the subcell was rotated clockwise by 90 degrees and then flipped upside down.

The thick bar is called a decomposition line. This line tells Mocha Chip to take the cell(s) on one side of it and join them to the cell(s) on the other side. Point at the decomposition line and type `:select`. Now, type `:what`. Mocha Chip will tell you that you have selected a decomposition line of type **pack**. This means that the cell(s) on the right (in this case, only the cell `mochatut1`) will be joined to the cell(s) to the left by abutting their packing rectangles. In the future, there will be other types of lines such as pitch-matching lines and river-routing lines, but for now the only type is **pack**.

Now you know all there is to know about the Mocha Chip cell `tut2a`; let's generate some layout. Point to the Mocha Chip window and type

**`:create`**

This command tells Mocha Chip to generate layout for the module. Mocha Chip will print out some messages while it is assembling the module. The most interesting of these messages are the ones that describe the phases that Mocha Chip goes through in producing a module. The first phase is the *instantiate* phase. In this phase, Mocha Chip evaluates the parameters in the diagram and creates a Lisp data structure that indicates what Magic cells need to be put together. After the instantiation phase, Mocha Chip enters the *describe* phase, in which the Lisp system tells Magic about the

structure that it created. Magic takes this structure and, in the *assemble* phase, turns the abstract structure into actual layout.

Now that we have generated a module, let's load it into a Magic window. Point to a Magic window and load in the newly created cell **tut2a**. You will see that it contains two subcells, just like the Mocha Chip diagram. Furthermore, they have been oriented according to the arrows on the subcells in the Mocha Chip diagram, and they have been placed in the same relative positions. Notice that the size of the cells in the Mocha Chip diagram need not bear any direct correspondence to the size of the actual cells. You can think of the Mocha Chip diagram as being a sketch of how the cells are to be assembled.

The **pack** decomposition line actually is a bit more powerful than I've described so far. The packing rectangles for a cell can be specified by the user. To do this, edit one of the Magic cells and place down a rectangular label called "mc-pack". The area of this label will be used as the packing rectangle of the cell instead of its bounding box.

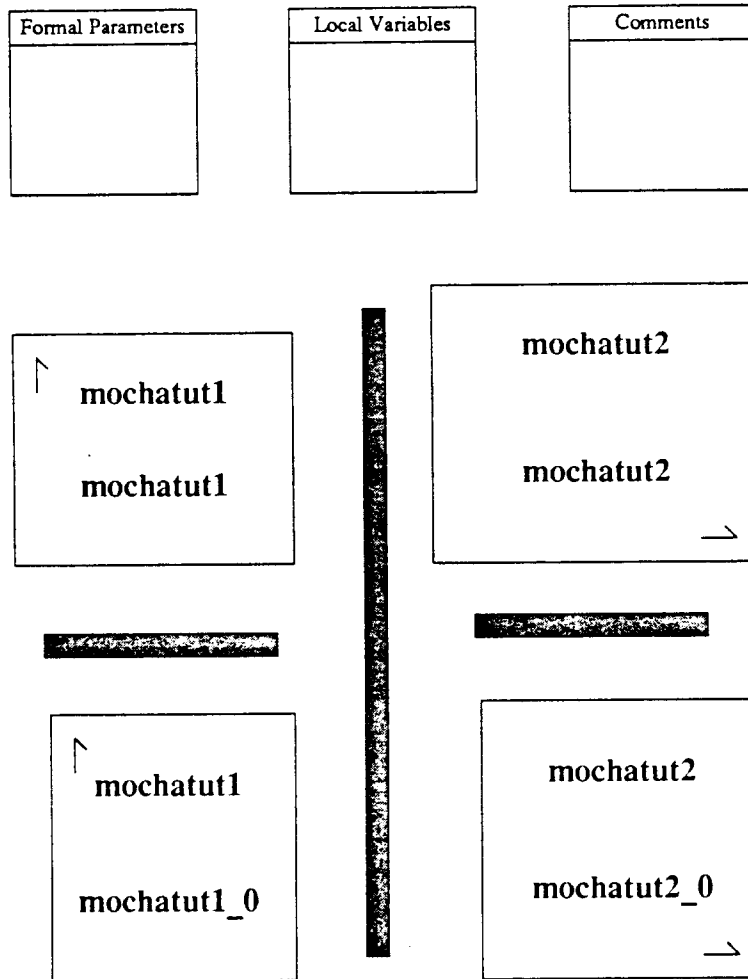
Now is a good time to experiment with the features presented so far. You can modify the packing rectangles of the Magic cells to produce different amounts of overlap. Notice an error is reported if the packing rectangle of a cell doesn't line up exactly with the packing rectangle of another cell. You can also try rotating and flipping cells in the Mocha Chip diagram using **:clockwise**, **:sideways**, and **:upside-down**.

### B.2.3. CREATING MOCHA CHIP DIAGRAMS

Now that you've seen how to invoke Mocha Chip, I'll introduce the more advanced concepts. First, I'll show you how to add subcells and decomposition lines to a diagram. Next, I'll show how to parameterize diagrams and create trees of diagrams (rather than just a single-level diagram). I'll also introduce two very special cells: the *Array* cell and the *Case* cell. These cells allow a form of iteration and conditional selection to be represented graphically -- we'll see exactly how this works later.

Let's create a Mocha Chip diagram with four subcells, just like Figure 1. Point at a Mocha Chip window and type **:load play** to create a new, empty, cell called play. The 'z' and 'Z' macros will allow you to zoom and pan just like in a layout window. The box can be moved around using the mouse buttons, also like the layout windows. Move the box so that it is below the box labeled "Formal Parameters" and type:





**Figure 1.** This figure shows a diagram of a Mocha Chip cell that contains four subcells. The thick lines between the cells are called *decomposition lines*. Each line indicates that the cells on either side should be joined together. Lines can have different types, indicating which operation (abutment, pitch-matching, routing, etc.) should be used to connect them together.

**:getcell mochatut1**

This places down a new subcell. Now move the box down below this new cell and type the command again to create another subcell. Now, using the similar commands, place down two copies of the cell mochatut2 to the right of the existing mochatut1 cells. Rotate and flip the two copies of mochatut2 by pointing to each in turn and

typing **:select** followed by **:clockwise 90** and **:upsidedown**.

Now we need to put in decomposition lines. These lines tell Mocha Chip how to assemble the module. Each line causes the things on each side to be put together using an interconnection method. Currently the only interconnection method is the **pack** method, which combines cells by abutting their user-specified packing rectangles.

The decomposition lines may be put in by hand using **:getdecompline**, it is usually easier to have Mocha Chip insert them automatically. To do this, type:

**:decompose**

Your diagram should now look something like Figure 1. You will see some thick lines between the cells -- these are the decomposition lines. Mocha Chip will move your cells around to make room for the lines if your cells overlap or if there isn't enough space for the lines. Right now all decomposition lines are of type **pack**, as can be seen with the **what** command. In the future I'll provide other types of decomposition lines, such as ones that use river-routing and pitch-matching to connect cells.

If you want, take some time to play with this diagram. You can experiment with generating layout via the **:create** command, and you can try rotating and flipping the cells. You might also try creating diagrams with more cells or with decomposition lines drawn by you. If you add decomposition lines yourself, first erase some with the **:erase** command. After you are done added decomposition lines, it is helpful to run the **:decompose** command to tidy things up and to make sure there are no errors.

#### B.2.4. THE ARRAY AND CASE CELLS

The diagram that we have constructed can only do one thing: put down four cells of the specified type in the specified orientation. We'd like diagrams to be more flexible, and that is what the **Array** and **Case** cells are for.

I'll introduce the cells by way of an example. Load in the new cell **play2**. Now put down an instance of the cell **Array** via the **:getcell Array** command. The **Array** cell is a predefined cell located in the Mocha Chip library area (`~cad/lib/mochachip`). It takes parameters, just like the PLA generator that you saw in tutorial #1.

Two of the parameters set the dimensions of the array. Pop up an editor window, using **:select**, **:expand**, and **:textedit** on the **Array** cell. We'll create a 2 X 2 array, so enter the following parameter lines:

(x-dimension 2)

(y-dimension 2)

The first line says that the columns will be numbered from 1 to 2, and the second line does a similar thing for the rows. We'll need to tell **Array** what subcell to use at each position. Add the following line to the parameters:

(subcell 'play\_sub)

That's all the parameters, so write them out and leave the editor (using **:wq** for vi).

Now we need to design the subcell **play\_sub**. Create a Magic cell called **play\_sub** and put down some material, such as metal and poly. Go back to the Mocha Chip window containing **play2**, and type **:create**. This will produce a layout

containing 4 cells, which may be viewed by loading **play2** into a layout window.

What if we don't want to put the same cell at each position in the array? We can create a diagram that uses the **Case** cell. Mocha Chip cells can look at variables and parameters of all their parents in the hierarchy, and the Array cell defines two useful ones: **x-pos** and **y-pos**.

Create a new Mocha Chip cell called **play\_sub**. Mocha Chip cells are always used in preference to Magic cells, so this new one will override the Magic cell designed earlier. Put down a **Case** cell, and pop up an editor on it's parameters. As an example, let's use the **contact** cell along the diagonal of the array, and the **cross** cell elsewhere. We can do this with the following parameters to Case:

```
(case1 '((equal x-pos y-pos) contact nil nil))
(case2 '(t cross nil nil))
```

Case takes parameters of the form **caseXX** where **XX** is a positive integer. In this case (no pun intended), we supply two options. Case looks at each option in order, until it finds one whose first expression evaluates to true. Then it uses the second part as the name of the cell to use. The third part is a list of parameters to the cell. This is usually unused, because cells can inherit parameters from the parents. To do this, just define additional parameters in the case cell, or any other cell above it in the hierarchy. Cells will ignore parameters that they don't know about, and cells deeper in the hierarchy that do recognize the parameters will use them.

**case1** looks at the inherited variables **x-pos** and **y-pos** to see if they are equal. These two variables are defined by the Array cell. If the two are equal, then the **contact** cell is used. **case2** has **t** as its expression, which Lisp always evaluates to true. This means that the second case will catch anything that passed by the first case. If Mocha Chip can't find any case that is true, it will give you an error message.

Now we need to create the cells **contact** and **cross**. They could be Mocha Chip diagrams, but we'll make it simple by making them Magic cells. Go over to a layout window and create the two cells. I'd suggest putting down a vertical metal1 wire and a horizontal poly wire in each cell. In the **contact** cell, connect the two wires with a polycontact, and leave them unconnected in the **cross** cell. You'll probably want to make the cells the same size so that they pack together nicely.

We are ready to generate layout. Load the top cell (**play2**) into the Mocha Chip window and type **:create**. The Magic cell **play2** will now contain four cells, with the contact cell along the diagonal.

### B.2.5. ADDING PARAMETERIZATION

The diagram that we produced still doesn't act like a module generator -- it only produces one thing. We'd like to have it be able to produce a whole bunch of modules, each different according to some parameter. For this example, we'll make the size of the array a parameter. Load the **play2** cell into Mocha Chip and select the parameter's block. Type **:textedit**, and add the following line:

(size 3)

This specifies that `play2` takes one parameter, `size`, and it has a default value of 3. The default value may be omitted, if desired. Save the file, and pop up a text editor on the Array cell. Change the following lines:

(x-dimension 2)

(y-dimension 2)

so that they read like:

(x-dimension size)

(y-dimension size)

`list` is Lisp's way of creating a list from separate values. In the previous example we could just use the constant list `'(1 2)`, but in the current example the list changes depending upon the parameters, so we have to compute the list each time. As you might have guessed, an arbitrary Lisp expression can be used for this value -- or for any other Mocha Chip parameter or variable expression.

`play2` is now a module generator. We can use it in the same way that we used `mcpla` in Mocha Chip tutorial #1. Let's create a new Mocha Chip cell called `use_play2` via `:load use_play2`. Put down a subcell called `play2`, and used `:textedit` to define the parameter `size` as shown here:

(size 3)

Now we can use `:create` to create a Magic cell with a 3 x 3 matrix of subcells, with contacts along the diagonal. We can change the `size` parameter to something else, say

8, to produce a new module. We have produced a very simple generator. More complicated generators may have more parameters, and may do more complex computations.

The “Local Variables” section is useful for doing computations. A line such as:

```
(foobar (big-function paramx))
```

invokes the Lisp function **big-function** on the parameter or variable **paramx**. **big-function** could be a large Lisp function that you write to produce a new Lisp data structure, which gets stored in **foobar**. It can be stored in a separate file, and loaded into Lisp as needed. See the `mochachip(1)` manual page for details. The lines in the “Local Variables” section are evaluated sequentially, so an expression may use variables computed in earlier lines.

### B.2.6. SUMMARY

As we have seen, Mocha Chip allows you to design module generators by drawing diagrams. The subcells in these diagrams may be parameterized, and may invoke either Magic cells or other Mocha Chip diagrams. The parameterization may contain arbitrary Lisp parameterization. Special forms of iteration and conditional selection are represented graphically via the Array and Case cells.

I hope that the simple examples in this tutorial give you a feel for the system. More complicated collections of diagrams may be created, and more complicated Lisp functions may be written. You are welcome to look that the **mcpla** Mocha Chip generator as an example -- it is in the directory `~cad/lib/mcpla`. The Mocha Chip manual

page also describes some useful functions and variables that were not covered in the tutorial.